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## AMENDMENT HISTORY

Version	Date	Description
V1.0	Dec, 2006	New release
V1.1	Mar, 2011	<ol> <li>Modify TMR2 to TMR1.</li> <li>Add system clock diagram.</li> </ol>
V1.2	Dec, 2011	Add Ordering Information table
V1.3	Dec, 2016	Modify Segment Driver Output Characteristics Voh1d, Voh1e Value

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## **General Description**

#### 1.1 GENERAL DESCRIPTION

The TM8725 is an embedded high-performance 4-bit microcomputer with LCD driver. It contains all the necessary functions, such as 4-bit parallel processing ALU, ROM, RAM, I/O ports, timer, clock generator, dual clock operation, Resistance to Frequency Converter (RFC), EL panel driver, LCD driver, look-up table, watchdog timer and key matrix scanning circuitry in a single chip.

#### 1.2 FEATURE

- 1. Low power dissipation
- **2.** Powerful instruction set (178 instructions).
  - Binary addition, subtraction, BCD adjusts, logical operation in direct and index addressing mode.
  - Single-bit manipulation (set, reset, decision for branch).
  - Various conditional branches.
  - 16 working registers and manipulation.
  - Table look-up.
  - LCD driver data transfer.
- 3. Memory capacity
  - ROM capacity 3072 x 16 bits.
  - RAM capacity 384 x 4 bits.
- **4.** LCD driver output
  - 6 common outputs and 40 segment outputs (up to drive 240 LCD segments).
  - 1/2 Duty, 1/3 Duty, 1/4 Duty, 1/5 Duty or 1/6Duty is selected by MASK option.
  - 1/2 Bias or 1/3 Bias is selected by MASK option.
  - Single instruction to turn off all segments.
  - COM5~6, SEG1~40 could be defined as CMOS or P\_open drain type output by mask option.
- 5. Input/output ports
  - Port IOA 4 pins (with internal pull-low), muxed with SEG24~SEG27.
  - Port IOB 4 pins (with internal pull-low), muxed with SEG28~SEG31.
  - Port IOC 4 pins (with internal pull-low, low-level-hold), muxed with SEG32 ~ SEG35. IOC port has built in the input signal chattering prevention circuitry.
  - Port IOD 4 pins (with internal pull-low), muxed with SEG36 ~ SEG39. IOD port has built in the input signal chattering prevention circuitry.
- **6.** 8-level subroutine nesting.



- 7. Interrupt function.
  - External factors 4 (INT pin, Port IOC, IOD & KI input).
  - Internal factors 4 (Pre-Divider, Timer1, Timer2 & RFC).
- 8. Built-in EL-light driver
  - ELC, ELP (Muxed with SEG28, SEG29).
- 9. Built-in Alarm, clock or single tone melody generator
  - BZB, BZ (Muxed with SEG30, SEG31).
- 10. Built-in resistance to frequency converter
  - CX, RR, RT, RH (Muxed with SEG24 ~ SEG27)
- 11. Built-in key matrix scanning function
  - K1~K16 (Shared with SEG1~SEG16).
- **12.** KI1~KI4 (Muxed with SEG32 ~ SEG35)
- **13.** Two 6-bit programmable timers with programmable clock source.
- 14. Watch dog timer.
- 15. Built-in Voltage doubler, halver, tripler charge pump circuit.
- **16.** Dual clock operation
  - Slow clock oscillation can be defined as X'tal or external RC type oscillator by mask option.
  - Fast clock oscillation can be defined as 3.58 MHz ceramic resonator, internal R or external R type oscillator by mask option.
- 17. HALT function.
- 18. STOP function.

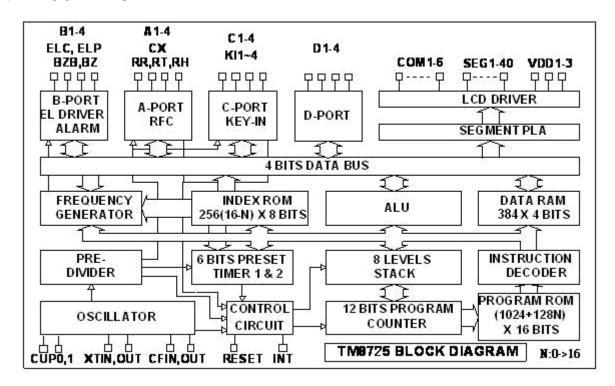
#### 1.3 APPLICATION

■ Timer/Calendar/Calculator/Thermometer

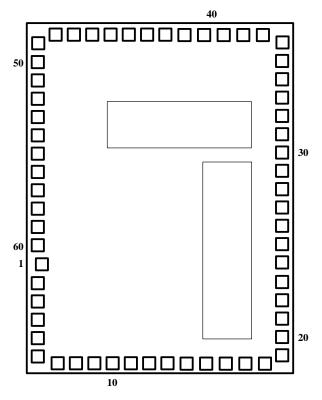
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#### 1.4 BLOCK DIAGRAM



#### 1.5 PAD DIAGRAM



The substrate of chip should be connected to GND.

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## 1.6 PAD COORDINATE

No	Name	X	Y	No	Name	X	Y
1	BAK	99.35	717.50	31	SEG14(K14)	1627.50	1522.50
2	XIN	72.50	602.50	32	SEG15(K15)	1627.50	1637.50
3	XOUT	72.50	487.50	33	SEG16(K16)	1627.50	1752.50
4	CFIN	72.50	372.50	34	SEG17	1627.50	1867.50
5	CFOUT	72.50	247.50	35	SEG18	1627.50	1992.50
6	GND	72.50	122.50	36	SEG19	1627.50	2117.50
7	VDD1	197.50	72.50	37	SEG20	1502.50	2167.50
8	VDD2	322.50	72.50	38	SEG21	1377.50	2167.50
9	VDD3	447.50	72.50	39	SEG22	1252.50	2167.50
10	CUP1	562.50	72.50	40	SEG23	1137.50	2167.50
11	CUP2	677.50	72.50	41	SEG24/IOA1/CX	1022.50	2167.50
12	COM1	792.50	72.50	42	SEG25/IOA2/RR	907.50	2167.50
13	COM2	907.50	72.50	43	SEG26/IOA3/RT	792.50	2167.50
14	COM3	1022.50	72.50	44	SEG27/IOA4/RH	677.50	2167.50
15	COM4	1137.50	72.50	45	SEG28/IOB1/ELC	562.50	2167.50
16	COM5	1252.50	72.50	46	SEG29/IOB2/ELP	447.50	2167.50
17	COM6	1377.50	72.50	47	SEG30/IOB3/BZB	322.50	2167.50
18	SEG1(K1)	1502.50	72.50	48	SEG31/IOB4/BZ	197.50	2167.50
19	SEG2(K2)	1627.50	122.50	49	SEG32/IOC1/KI1	72.50	2117.50
20	SEG3(K3)	1627.50	247.50	50	SEG33/IOC2/KI2	72.50	1992.50
21	SEG4(K4)	1627.50	372.50	51	SEG34/IOC3/KI3	72.50	1867.50
22	SEG5(K5)	1627.50	487.50	52	SEG35/IOC4/KI4	72.50	1752.50
23	SEG6(K6)	1627.50	602.50	53	SEG36/IOD1	72.50	1637.50
24	SEG7(K7)	1627.50	717.50	54	SEG37/IOD2	72.50	1522.50
25	SEG8(K8)	1627.50	832.50	55	SEG38/IOD3	72.50	1407.50
26	SEG9(K9)	1627.50	947.50	56	SEG39/IOD4	72.50	1292.50
27	SEG10(K10)	1627.50	1062.50	57	SEG40	72.50	1177.50
28	SEG11(K11)	1627.50	1177.50	58	RESET	72.50	1062.50
29	SEG12(K12)	1627.50	1292.50	59	INT	72.50	947.50
30	SEG13(K13)	1627.50	1407.50	60	TEST	72.50	832.50



## 1.7 PIN DESCRIPTION

Name	I/O	Description					
BAK	Р	Positive Back-up voltage.					
<i>B</i> 7111	•	At Li power mode, connect a 0.1u capacitor to GND.					
VDD1 2 2	D	LCD supply voltage, and positive supply voltage.					
VDD1,2,3 P		In Ag Mode, connect positive power to VDD1. In Li or ExtV power mode, connect positive power to VDD2.					
RESET	I	Input pin for external reset request signal, built-in internal pull-down resistor.					
		Input pin for external INT request signal.					
INT	I	Falling edge or rising edge triggered is defined by mask option.					
		Internal pull-down or pull-up resistor is defined by mask option.					
TEST		Test signal input pin.					
		Switching pins for supply the LCD driving voltage to the VDD1, 2, 3 pins.					
CUP1,2	О	Connect the CUP1 and CUP2 pins with non-polarized electrolytic capacitors when chip operated in 1/2 or 1/3 bias mode.					
		In no BIAS mode application, leave these pins opened.					
		Time based counter frequency (clock specified, LCD alternating frequency, Alarm signal					
XIN	O	frequency) or system clock oscillation.					
XOUT		The usage of 32 KHz Crystal oscillator or external RC oscillator is defined by mask					
		option.					
CFIN	I	System clock oscillation for FAST clock only or DUAL clock operation.					
CFOUT	О	The usage of 3.58 MHz ceramic/resonator oscillator or external R type oscillator is defined by mask option.					
		Output pins for driving the common pins of the LCD panel.					
COM1~6	О	COM5~6 could be defined as COMS or Open Drain type output.					
SEG1-40	0	Output pins for driving the LCD panel segment.					
IOA1-4	I/O	Input/Output port A (muxed with SEG24~27).					
IOB1-4	I/O	Input/Output port B (muxed with SEG28~31).					
IOC1-4	I/O	Input/Output port C (muxed with SEG32~35).					
IOD1~4	I/O	Input/Output port D (muxed with SEG36~39).					
CX	I	1 input pin and 3 output pins for RFC application (muxed with SEG24~27).					
RR/RT/RH	О						
ELC/ELP	О	Output port for El panel driver (muxed with SEG28~29)					
BZB/BZ	0	Output port for alarm, clock or single tone melody generator (muxed with SEG30~31).					
K1~16	О	Output port for key matrix scanning (shared with SEG1~SEG16).					
KI1~4	I	Input port for key matrix scanning (muxed with SEG32~SEG35).					
GND	P	Negative supply voltage.					



## 1.8 CHARACTERISTICS

## ABSOLUTE MAXIMUM RATINGS

GND=0V

Name	Symbol	Range	Unit	
	VDD1	-0.3 to 5.5		
Maximum Supply Voltage	VDD2	-0.3 to 5.5		
	VDD3	-0.3 to 8.5	***	
Maximum Input Voltage	Vin	-0.3 to VDD1/2+0.3	V	
Mariana Orana Walkana	Vout1	-0.3 to VDD1/2+0.3		
Maximum Output Voltage	Vout2	-0.3 to VDD3+0.3		
Maximum Operating Temperature	Topg	-40 to +80	0.0	
Maximum Storage Temperature	Tstg	-50 to +125	°C	

## POWER CONSUMPTION

At Ta= -20°C to 70°C, GND=0V

Name	Sym.	Condition	Min.	Тур.	Max.	Unit
		Only 32.768 KHz Crystal oscillator operating,				
	IHALT1	without loading.		2		
IIAI T a da		Ag mode, VDD1=1.5V, BCF=0				
HALT mode	IHALT2	Only 32.768 KHz Crystal oscillator operating,				uA
		without loading.		2		
		Li mode, VDD2=3.0V, BCF=0				
STOP mode	ISTOP				1	

<u>Note:</u> When RC oscillator function is operating, the current consumption will depend on the frequency of oscillation.

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## ALLOWABLE OPERATING CONDITIONS

At Ta= -20°C to 70°C, GND=0V

Name	Symb.	Condition	Min.	Max.	Unit
	VDD1		1.2	5.25	
Supply Voltage	VDD2		2.4	5.25	
	VDD3		2.4	8.0	
Oscillator Start-Up Voltage	VDDB	Contain Maria	1.3		
Oscillator Sustain Voltage	VDDB	Crystal Mode	1.2		
Supply Voltage	VDD1	Ag Mode	1.2	1.8	
Supply Voltage	VDD2	EXT-V, Li Mode	2.4	5.25	
Input "H" Voltage	Vih1	A = D attaura M a da	VDD1-0.7	VDD1+0.7	
Input "L" Voltage	Vil1	Ag Battery Mode	-0.7	0.7	
Input "H" Voltage	Vih2	Li Dottom: Modo	VDD2-0.7	VDD2+0.7	V
Input "L" Voltage	Vil2	Li Battery Mode	-0.7	0.7	
Input "H" Voltage	Vih3	OSCIN at Ag Battery	0.8xVDD1	VDD1	
Input "L" Voltage	Vil3	Mode	0	0.2xVDD1	
Input "H" Voltage	Vih4	OSCIN at Li Battery	0.8xVDD2	VDD2	
Input "L" Voltage	Vil4	Mode	0	0.2xVDD2	
Input "H" Voltage	Vih5	CFIN at Li Battery or	0.8xVDD2	VDD2	
Input "L" Voltage	Vil5	EXT-V Mode	0	0.2xVDD2	
Input "H" Voltage	Vih6	RC Mode	0.8xVDDO	VDDO	
Input "L" Voltage	Vil6	KC Mode	0	0.2xVDDO	
	Fopg1	Crystal Mode	32		
Operating Freq	Fopg2	RC Mode	10	1000	KHz
	Fopg3	CF Mode	1000	3580	

## INTERNAL RC FREQUENCY RANGE

<b>Option Mode</b>	BAK	Min.	Typ.	Max.
250 KHz	1.5V	300 KHz	350 KHz	400 KHz
	3.0V	200 KHz	250 KHz	300 KHz
500 KHz	1.5V	500 KHz	600 KHz	700 KHz
	3.0V	400 KHz	500 KHz	600 KHz

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## **ELECTRICAL CHARACTERISTICS**

at#1: VDD1=1.2V (Ag);

at#2: VDD2=2.4V (Li):

at#3: VDD2=4V (Ext-V);

## Input Resistance

Name	Symb.	Condition	Min.	Тур.	Max.	Unit
	Rllh1	Vi=0.2VDD1,#1	10	40	100	
"L" Level Hold Tr(IOC)	Rllh2	Vi=0.2VDD2,#2	10	40	100	
	Rllh3	Vi=0.2VDD2,#3	5	20	50	
	Rmad1	Vi=VDD1,#1	200	500	1000	
IOC Pull-Down Tr	Rmad2	Vi=VDD2,#2	200	500	1000	
	Rmad3	Vi=VDD2,#3	100	250	500	
	Rintu1	Vi=VDD1,#1	200	500	1000	
INT Pull-up Tr	Rintu2	Vi=VDD2,#2	200	500	1000	ΚΩ
	Rintu3	Vi=VDD2,#3	100	250	500	
	Rintd1	Vi=GND,#1	200	500	1000	
INT Pull-Down Tr	Rintd2	Vi=GND,#2	200	500	1000	
	Rintd3	Vi=GND,#3	100	250	500	
	Rres1	Vi=GND or VDD1,#1	10	50	100	
RES Pull-Down R	Rres2	Vi=GND or VDD2,#2	10	50	100	
	Rres3	Vi=GND or VDD2,#3	10	50	100	

## **DC Output Characteristics**

Name	Symb.	Condition	Port	Min.	Тур.	Max.	Unit
	Voh1c	Ioh=-200 uA,#1		0.8	0.9	1.0	
Output "H" Voltage	Voh2c	Ioh=-1 mA,#2		1.5	1.8	2.1	
	Voh3c	Ioh=-3 mA,#3	COM5~6	2.5	3.0	3.5	<b>3</b> 7
	Vol1c	Iol=400 uA,#1	SEG1~40	0.2	0.3	0.4	V
Output "L" Voltage	Vol2c	Iol=2 mA,#2		0.3	0.6	0.9	
	Vol3c	Iol=6 mA,#3		0.5	1.0	1.5	

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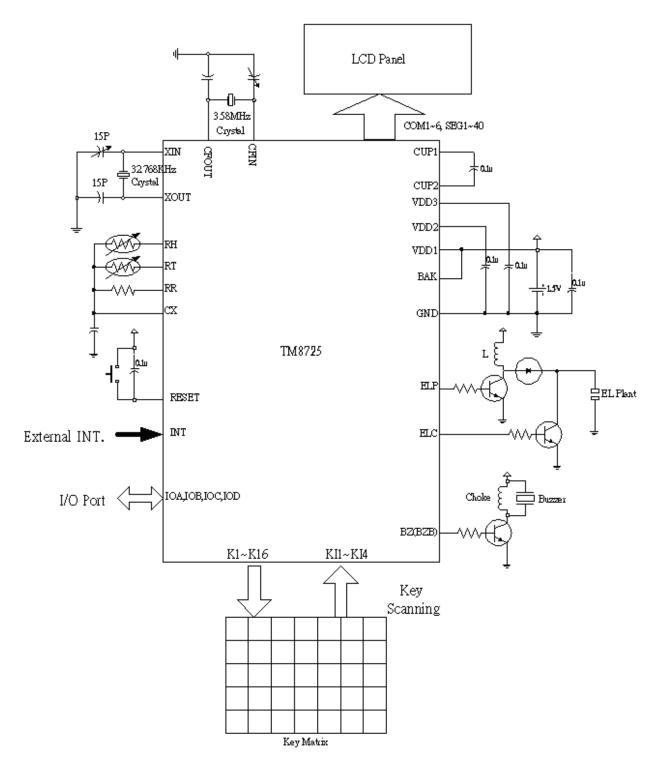
## **Segment Driver Output Characteristics**

Name	Symb.	Condition	For	Min.	Тур.	Max.	Unit.
	Static Display Mo		de				
	Voh1d Ioh=-1 uA,#1		2.2				
Output "H" Voltage	Voh2d	Ioh=-1 uA,#2		2.2			
	Voh3d	Ioh=-1 uA,#3	ana	3.8			
	Vol1d	Iol=1 uA,#1	SEG-n			0.2	
Output "L" Voltage	Vol2d	Iol=1 uA,#2				0.2	
	Vol3d	Iol=1 uA,#3				0.2	1
	Voh1e	Ioh=-10 uA,#1		2.2			V
Output "H" Voltage	Voh2e	Ioh=-10 uA,#2		2.2			
	Voh3e	Ioh=-10 uA,#3	COM	3.8			
	Vol1e	Iol=10 uA,#1	COM-n			0.2	
Output "L" Voltage	Vol2e	Iol=10 uA,#2				0.2	
	Vol3e	Iol=10 uA,#3				0.2	
		1/2 Bias Display M	ode				
0	Voh12f	Ioh=-1 uA,#1,#2		2.2			
Output "H" Voltage	Voh3f	Ioh= -1 uA,#3	ana	3.8			
0	Vol12f	Iol=1 uA,#1,#2	SEG-n			0.2	
Output "L" Voltage	Vol3f	Iol=1 uA,#3				0.2	
O ((III) II . 1.	Voh12g	Ioh=-10 uA,#1,#2		2.2			V
Output "H" Voltage	Voh3g	Ioh= -10 uA,#3	COM	3.8			
0 (0 8231.1)	Vom12g	Iol/h= +/-10 uA,#1,#2	COM-n	1.0		1.4	
Output "M" Voltage Vom3g		Io1/h= +/-10 uA,#3		1.8		2.2	
1/3 Bias display Mode							
O ((TIP) II. I.	Voh12h	Ioh= -1 uA,#1,#2		3.4			
Output "H" Voltage	Voh3h	Ioh= -1 uA,#3		5.8			
0	Vom1h	Iol/h= +/-10 uA,#1,#2		1.0		1.4	
Output "M1" Voltage	Vom13h	Iol/h= +/-10 uA,#3	arc.	1.8		2.2	
0 4 49 402 37 14	Vom22h	Iol/h= +/-10 uA,#1,#2	SEG-n	2.2		2.6	
Output "M2" Voltage	Vom23h	Iol/h= +/-10 uA,#3		3.8		4.2	
Vol12h		Iol=1 uA,#1,#2				0.2	
Output "L" Voltage	Vol3h	Iol=1 uA,#3				0.2	
O ((III) II . 1.	Voh12i	Ioh=-10 uA,#1,#2		3.4			V
Output "H" Voltage	Voh3i	Ioh= -10 uA,#3		5.8			
0	Vom12i	Iol/h= +/-10 uA,#1,#2		1.0		1.4	
Output "M1" Voltage Vom13i		Iol/h= +/-10 uA,#3	COM	1.8		2.2	
0 4 40 100 11	Vom22i	Iol/h= +/-10 uA,#1,#2	COM-n	2.2		2.6	
Output "M2" Voltage	Output "M2" Voltage Voll221			3.8		4.2	]
0 ( ((1,0))	Vol12i	Iol=10 uA,#1,#2				0.2	
Output "L" Voltage	Vol3i	Iol=10 uA,#3	1			0.2	



## 1.9 TYPICAL APPLICATION CIRCUIT

This application circuit is simply an example, and is not guaranteed to work.



Ag power mode, 1/3 Bias, 1/6 Duty

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## 2. TM8725 Internal System Architecture

#### 2.1 POWER SUPPLY

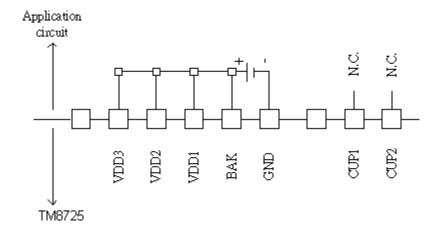
TM8725 can operate at Ag, Li, and EXTV 3 types supply voltage, all of these operating types are defined by mask option. The power supply circuitry also generates the necessary voltage level to drive the LCD panel with different bias. Shown below are the connection diagrams for 1/2 bias, 1/3 bias and no bias application.

## 2.1.1 Ag BATTERY POWER SUPPLY

Operating voltage range: 1.2V ~ 1.8V.

For different LCD bias application, the connection diagrams are shown below:

## 2.1.1.1 NO LCD BIAS NEED AT Ag BATTERY POWER SUPPLY



#### MASK OPTION table:

Mask Option name	Selected item
POWER SOURCE	(3) 1.5V BATTERY
BIAS	(1) NO BIAS

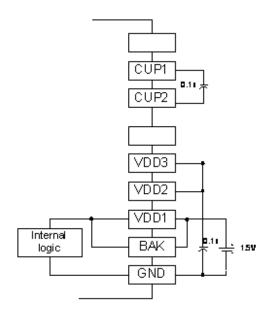
Note 1: The input/output ports operate between GND and VDD1.

Note 2: At the initial clear mode the backup flag (BCF) is set. When the backup flag is set, the oscillator circuit becomes large in inverter size and the oscillation conditions are improved, but the operating current is also increased. Therefore, the backup flag must be reset unless otherwise required. For the backup flag, refer to 3-5.

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## 2.1.1.2 1/2 BIAS & STATIC AT AG BATTERY POWER SUPPLY



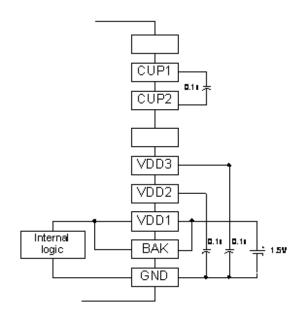
#### MASK OPTION table:

Mask Option name	Selected item	
POWER SOURCE	(3) 1.5V BATTERY	
BIAS	(2) 1/2 BIAS	

Note 1: The input/output ports operate between GND and VDD1.

Note 2: At the initial clear mode the backup flag (BCF) is set. When the backup flag is set, the oscillator circuit becomes large in inverter size and the oscillation conditions are improved, but the operating current is also increased. Therefore, the backup flag must be reset unless otherwise required. For the backup flag, refer to 3-5.

## 2.1.1.3 1/3 BIAS AT AG BATTERY POWER SUPPLY



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Mask Option name	Selected item	
POWER SOURCE	(3) 1.5V BATTERY	
BIAS	(3) 1/3 BIAS	

Note 1: The input/output ports operate between GND and VDD1.

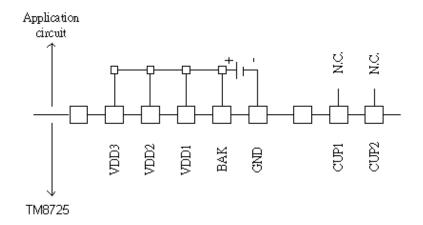
Note 2: At the initial clear mode the backup flag (BCF) is set. When the backup flag is set, the oscillator circuit becomes large in inverter size and the oscillation conditions are improved, but the operating current is also increased. Therefore, the backup flag must be reset unless otherwise required. For the backup flag, refer to 3-5.

#### 2.1.2 LI BATTERY POWER SUPPLY

Operating voltage range: 2.4V ~ 3.6V.

For different LCD bias application, the connection diagrams are shown below:

#### 2.1.2.1 NO BIAS AT LI BATTERY POWER SUPPLY



#### MASK OPTION table:

Mask Option name	Selected item
POWER SOURCE	(2) 3V BATTERY OR HIGHER
BIAS	(1) NO BIAS

Note: The input/output ports operate between GND and VDD2.

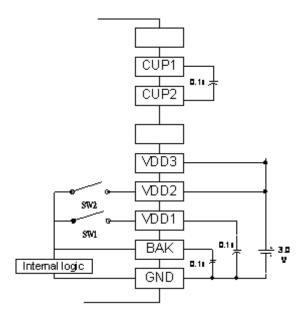
### 2.1.2.2 1/2 BIAS AT LI BATTERY POWER SUPPLY

The backup flag (BCF) must be reset after the operation of the halver circuit is fully stabilized and a voltage of approximately 1/2 \* VDD2 appears on the VDD1 pin.

Backup flag(BCF)	SW1	SW2
BCF=0	ON	OFF
BCF=1	OFF	ON

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Mask Option name	Selected item
POWER SOURCE	(2) 3V BATTERY OR HIGHER
BIAS	(2) 1/2 BIAS

Note 1: The input/output ports operate between GND and VDD2.

Note 2: At the initial clear mode, the backup flag (BCF) is set. When the backup flag is set, the internal logic operated on VDD2 and the oscillator circuit becomes large in driver size.

At the backup flag set mode, the operating current is increased. Therefore, the backup flag must be reset unless otherwise required. For the backup flag, refer to 3-5.

Note 3: The VDD1 level (≈1/2 \* VDD2) at the off-state of SW1 is used as an intermediate voltage level for the LCD driver.

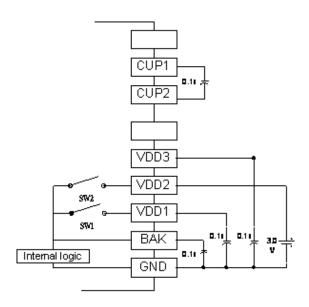
#### 2.1.2.3 1/3 BIAS AT LI BATTERY POWER SUPPLY

The backup flag (BCF) must be reset after the operation of the halver circuit is fully stabilized and a voltage of approximately 1/2 \* VDD2 appears on the VDD1 pin.

Backup flag(BCF)	SW1	SW2
BCF=0	ON	OFF
BCF=1	OFF	ON

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Mask Option name	Selected item
POWER SOURCE	(2) 3V BATTERY OR HIGHER
BIAS	(3) 1/3 BIAS

Note 1: The input/output ports operate between GND and VDD2.

Note 2: At the initial clear mode the backup flag (BCF) is set. When the backup flag is set, the internal logic operated on VDD2 and the oscillator circuit becomes large in inverter size. At the backup flag set mode the operating current is increased. Therefore, the backup flag must be reset unless otherwise required. For the backup flag, refer to 3-5.

Note 3: The VDD1 level (≈□ 1/2 \* VDD) at the offstate of SW1 is used as an intermediate voltage level for LCD driver.

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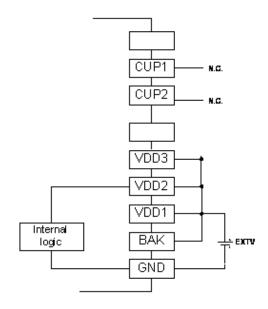


## 2.1.3 EXTV POWER SUPPLY

Operating voltage range: 3.6V ~ 5.25V.

For different LCD bias application, the connection diagrams are shown below:

## 2.1.3.1 NO BIAS AT EXT-V BATTERY POWER SUPPLY



### MASK OPTION table:

Mask Option name	Selected item
POWER SOURCE	(1) EXT-V
BIAS	(1) NO BIAS

Note 1: The input/output ports operate between GND and VDD2.

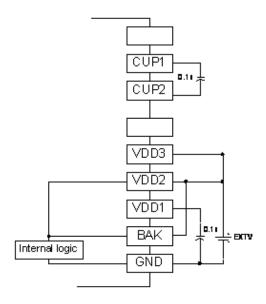
Note 2: At the initial clear mode the backup flag (BCF) is reset.

Note 3: At the backup flag set mode the operating current is increased.

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## 2.1.3.2 1/2 BIAS AT EXT-V POWER SUPPLY



## MASK OPTION table:

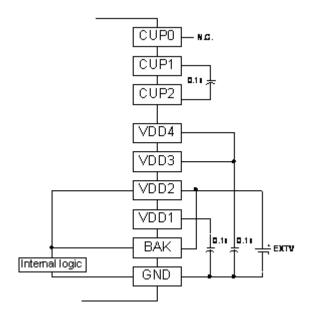
Mask Option name	Selected item
POWER SOURCE	(1) EXT-V
BIAS	(2) 1/2 BIAS

Note 1: The input/output ports operate between GND and VDD2.

Note 2: At the initial clear mode the backup flag (BCF) is reset.

Note 3: At the backup flag set mode the operating current is increased. Therefore, the backup flag must be reset unless otherwise required.

## 2.1.3.3 1/3 BIAS AT EXT-V POWER SUPPLY



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Mask Option name	Selected item
POWER SOURCE	(1) EXT-V
BIAS	(3) 1/3 BIAS

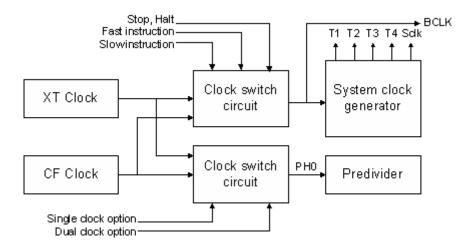
Note 1: The input/output ports operate between GND and VDD2.

Note 2: At the initial clear mode the backup flag (BCF) is reset.

<u>Note 3:</u> At the backup flag set mode the operating current is increased. Therefore, the backup flag must be reset unless otherwise required.

#### 2.2 SYSTEM CLOCK

XT clock (slow clock oscillator) and CF clock (fast clock oscillator) compose the clock oscillation circuitry and the block diagram is shown below.



The system clock generator provided the necessary clocks for execution of instruction. The pre-divider generated several clocks with different frequencies for the usage of LCD driver, frequency generator, etc....

The following table shows the clock sources of system clock generator and pre-divider in different conditions.

	PH0	BCLK
Slow clock only option	XT clock	XT clock
fast clock only option	CF clock	CF clock
Initial state (dual clock option)	XT clock	XT clock
Halt mode (dual clock option)	XT clock	XT clock
Slow mode (dual clock option)	XT clock	XT clock
Fast mode (dual clock option)	XT clock	CF clock

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### 2.2.1 CONNECTION DIAGRAM OF SLOW CLOCK OSCILLATOR (XT CLOCK)

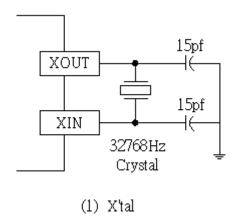
This clock oscillation circuitry provides the lower speed clock to the system clock generator, pre-divider, timer, chattering prevention of IO port and LCD circuitry. This oscillator will be disabled when the fast clock only option is selected by mask option, or it will be activated all the time after the initial reset. In stop mode, the oscillator will be stopped.

There are 2 type oscillators can be used in slow clock oscillator, selected by mask option:

### 2.2.1.1 External 32.768 KHz Crystal oscillator

MASK OPTION table:

Mask Option name	Selected item
SLOW CLOCK TYPE FOR SLOW ONLY OR DUAL	(1) X'tal



When backup flag (BCF) is set to 1, the oscillator operates with an extra buffer in parallel in order to shorten the oscillator start-up time but this will increase the power consumption. Therefore, the backup flag should be reset unless required otherwise.

The following table shows the power consumption of Crystal oscillator in different condition:

	Ag power option	Li power option	EXT-V option
BCF=1	Increased	Increased	Increased
BCF=0	Normal	Normal	Increased
Initial reset	Increased	Increased	Increased
After reset	Normal	Normal	Increased

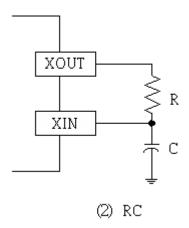
### 2.2.1.2 External RC oscillator

MASK OPTION table:

Mask Option name	Selected item
SLOW CLOCK TYPE FOR SLOW ONLY OR DUAL	(2) RC

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#### 2.2.2 CONNECTION DIAGRAM OF FAST CLOCK OSCILLATOR (CF CLOCK)

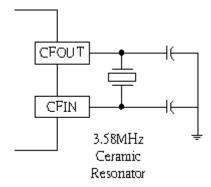
The CF clock is a multiple type oscillator (mask option) which provides a faster clock source to system. In single clock operation (fast only), this oscillator will provide the clock to the system clock generator, pre-divider, timer, I/O port chattering prevention clock and LCD circuitry. In dual clock operation, CF clock provides the clock to system clock generator only. When the dual clock option is selected by mask option, this oscillator will be inactive most of the time except when the FAST instruction is executed. After the FAST instruction is executed, the clock source (BCLK) of the system clock generator will be switched to CF clock and the clock source for other functions will still come from XT clock. Halt mode, stop mode or SLOW instruction execution will stop this oscillator and the system clock (BCLK) will be switched to XT clock.

There are 3 type oscillators can be used in slow clock oscillator, selected by mask option:

#### 2.2.2.1 External 3.58 MHz Ceramic Resonator oscillator

MASK OPTION table:

Mask Option name	Selected item
FAST CLOCK TYPE FOR FAST ONLY OR DUAL	(4) 3.58MHz Ceramic Resonator



Note 1: Don't use 3.58 MHz Ceramic Resonator as the oscillator when Ag battery option is used.

Note 2: When the program has to reset the BCF flag to 0 in Li battery power mode, don't use 3.58 MHz Ceramic Resonator as the oscillator.

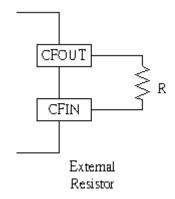
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## 2.2.2.2 RC oscillator with External Resistor, connection diagram is shown below:

### MASK OPTION table:

Mask Option name	Selected item
FAST CLOCK TYPE FOR FAST ONLY OR DUAL	(3) EXTERNAL RESISTOR



## 2.2.2.3 nternal RC Oscillator

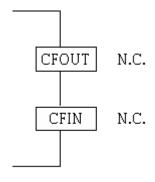
MASK OPTION table:

For 250 KHz output frequency:

Mask Option name	Selected item
FAST CLOCK TYPE FOR FAST ONLY OR DUAL	(1) INTERNAL RESISTOR FOR 250 KHz

## For 250 KHz output frequency:

Mask Option name	Selected item
FAST CLOCK TYPE FOR FAST ONLY OR DUAL	(2) INTERNAL RESISTOR FOR 500 KHz



Internal RC

## FREQUENCY RANGE OF INTERNAL RC OSCILLATOR

Option Mode	BAK	Min.	Тур.	Max.
250 VII-	1.2V~1.5V	300 KHz	350 KHz	400 KHz
250 KHz	2.4V~5.0V	200 KHz	250 KHz	300 KHz
500 VII-	1.2V~1.5V	500 KHz	600 KHz	700 KHz
500 KHz	2.4V~5.0V	400 KHz	500 KHz	600 KHz

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#### 2.2.3 COMBINATION OF THE CLOCK SOURCES

There are three types of combination of the clock sources that can be selected by mask option:

#### **2.2.3.1 Dual Clock**

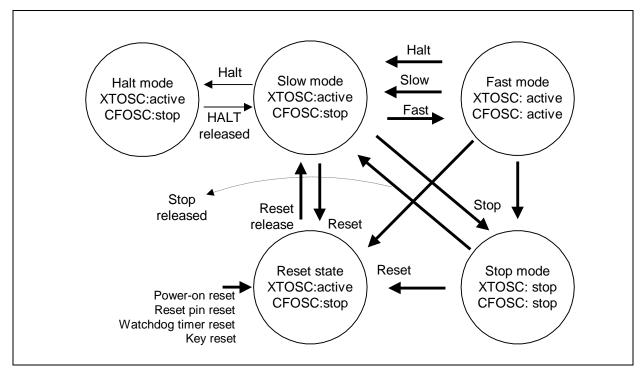
MASK OPTION table:

Mask Option name	Selected item
CLOCK SOURCE	(3) DUAL

The operation of the dual clock option is shown in the following figure.

When this option is selected by mask option, the clock source (BCLK) of system clock generator will switch between XT clock and CF clock according to the user's program. When the halt and stop instructions are executed, the clock source (BCLK) will switch to XT clock automatically.

The XT clock provides the clock to the pre-divider, timer, I/O port chattering prevention and LCD circuitry in this option.

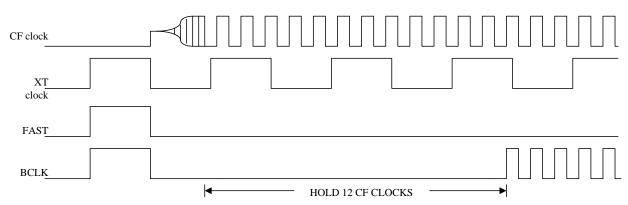


State Diagram of Dual Clock Option was shown on above figure.

After executing FAST instruction, the system clock generator will hold 12 CF clocks after the CF clock oscillator starts up and then switches CF clock to BCLK. This will prevent the incorrect clock from delivering to the system clock in the start-up duration of the fast clock oscillator.

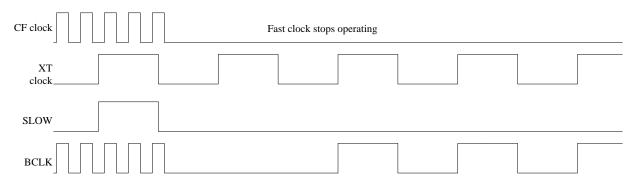
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This figure shows the System Clock Switches from Slow to Fast

After executing SLOW instruction, the system clock generator will hold 2 XT clocks and then switches XT clock to BCLK.



This figure shows the System Clock Switches from Fast to Slow

## 2.2.3.2 Single Clock

MASK OPTION table:

For Fast clock oscillator only

Mask Option name	Selected item
CLOCK SOURCE	(1) FAST ONLY

For slow clock oscillator only

Mask Option name	Selected item
CLOCK SOURCE	(2) SLOW ONLY

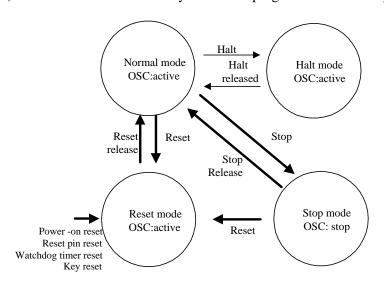
The operation of the single clock option is shown in the following figure.

Either XT or CF clock may be selected by mask option in this mode. The FAST and SLOW instructions will perform as the NOP instruction in this option.

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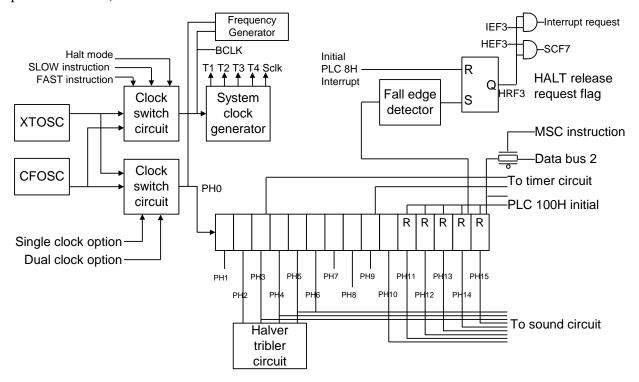
The backup flag (BCF) will be set to 1 automatically before the program enters the stop mode.



This figure shows the State Diagram of Single Clock Option

#### 2.2.4 PREDIVIDER

The pre-divider is a 15-stage counter that receives the clock from the output of clock switch circuitry (PH0) as input. When PH0 changes from "H" level to "L" level, the content of this counter changes. The PH11 to PH15 of the pre-divider are reset to "0" when the PLC 100H instruction is executed or at the initial reset mode. The pre-divider delivers the signal to the halver/tripler circuit, alternating frequency for LCD display, system clock, sound generator and halt release request signal (I/O port chattering prevention clock).



This figure shows the Pre-divider and its Peripherals

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The PH14 delivers the halt mode release request signal, setting the halt mode release request flag (HRF3). In this case, if the pre-divider interrupt enable mode (IEF3) is provided, the interrupt is accepted; and if the halt release enable mode (HEF3) is provided, the halt release request signal is delivered, setting the start condition flag 7 (SCF7) in status register 3 (STS3).

The clock source of pre-divider is PH0, and 4 kinds of frequency of PH0 could be selected by mask option:

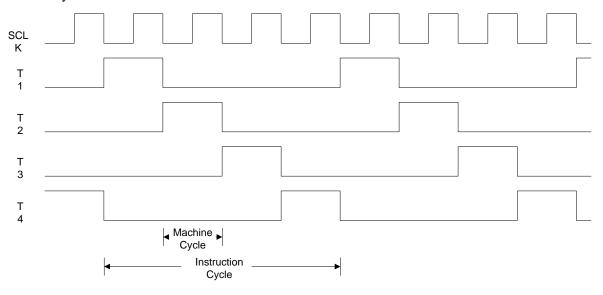
#### MASK OPTION table:

Mask Option name	Selected item
PH0 <-> BCLK FOR FAST ONLY	(1) PH0 = BCLK
PH0 <-> BCLK FOR FAST ONLY	(2) PH0 = BCLK/4
PH0 <-> BCLK FOR FAST ONLY	(3) PH0 = BCLK/8
PH0 <-> BCLK FOR FAST ONLY	(4) $PH0 = BCLK/16$

### 2.2.5 System Clock Generator

For the system clock, the clock switch circuit permits the different clocks input from XTOSC and CFOSC to be selected. The FAST and SLOW instructions can switch the clock input of the system clock generator (SGC).

The basic system clock is shown below:



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#### 2.3 PROGRAM COUNTER (PC)

This is a 12-bit counter, which addresses the program memory (ROM) up to 3072 addresses. The MSB of program counter (PC11) is a page register. Only CALL and JMP instructions could address to the whole address range (000h  $\sim$  BFFh), the rest jump relative instructions could address to either page 0 (000h  $\sim$  7ffh) or page 1 (800h  $\sim$  BFFh).

• The program counter (PC) is normally increased by one (+1) with every instruction execution.

- When executing JMP instruction, subroutine call instruction (CALL), interrupt service routine or reset occurs, the program counter (PC) loads the specified address corresponding to table 2-3-1.
  - PC ← specified address shows in table 2-3-1.
- When executing a jump instruction except JMP and CALL, the program counter (PC) loads the specified address in the operand of instruction. All of these jump relative instructions could only address to current page. That means when the current page is in page 0 (PC11=0), only the range 000h ~ 7FFh is reachable; when the current page is in page 1 (PC11=1), only the range 800h ~ FFFh is reachable.
  - PC ← current page (PC11) + specified address in operand
- Return instruction (RTS)
  - PC **\( \)** content of stack specified by the stack pointer

Stack pointer ← stack pointer - 1

Table 2-3-1

	PC11	PC10	PC9	PC8	PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0
Initial reset	0	0	0	0	0	0	0	0	0	0	0	0
Interrupt 2 (INT pin)	0	0	0	0	0	0	0	1	0	0	0	0
Interrupt 0 (input port C or D)	0	0	0	0	0	0	0	1	0	1	0	0
Interrupt 1 (timer 1 interrupt)	0	0	0	0	0	0	0	1	1	0	0	0
Interrupt 3 (pre-divider interrupt)	0	0	0	0	0	0	0	1	1	1	0	0
Interrupt 4 (timer 2 interrupt)	0	0	0	0	0	0	1	0	0	0	0	0
Interrupt 5 (Key Scanning interrupt)	0	0	0	0	0	0	1	0	0	1	0	0
Interrupt 6 (RFC counter interrupt)	0	0	0	0	0	0	1	0	1	0	0	0
Jump instruction	P11	P10	P9	P8	P7	P6	P5	P4	P3	P2	P1	P0
Subroutine call	P11	P10	P9	P8	P7	P6	P5	P4	P3	P2	P1	P0

P10 to P0: Low-order 11 bits of instruction operand.

P11: page register

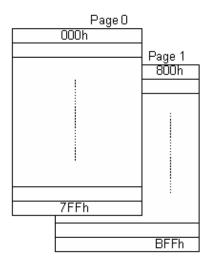
When executing the subroutine call instruction or interrupt service routine, the contents of the program counter (PC) are automatically saved to the stack register (STACK).

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#### 2.4 PROGRAM/TABLE MEMORY

The built-in mask ROM is organized with 3072 x 16 bits. There are 2 pages memory space in this mask ROM. Page 0 covers the address range from 000h to 7FFh and page 1 covers 800h to BFFh.



Both instruction ROM (PROM) and table ROM (TROM) shares this memory space together. The partition formula for PROM and TROM is shown below:

Instruction ROM memory space = 1024 + (128 \* N) words,

Table ROM memory space = 256(16 - N) bytes (N =  $0 \sim 16$ ).

Note: The data width of table ROM is 8-bit

The partition of memory space is defined by mask option, the table is shown below:

### MASK OPTION table:

		Instruction ROM	Table ROM
Mask Option name	Selected item	memory space	memory space
		(Words)	(Bytes)
INSTRUCTION ROM <-> TABLE ROM	1 (N=0)	1024	4096
INSTRUCTION ROM <-> TABLE ROM	2 (N=1)	1152	3840
INSTRUCTION ROM <-> TABLE ROM	3 (N=2)	1280	3584
INSTRUCTION ROM <-> TABLE ROM	4 (N=3)	1408	3328
INSTRUCTION ROM <-> TABLE ROM	5 (N=4)	1536	3072
INSTRUCTION ROM <-> TABLE ROM	6 (N=5)	1664	2816
INSTRUCTION ROM <-> TABLE ROM	7 (N=6)	1792	2560
INSTRUCTION ROM <-> TABLE ROM	8 (N=7)	1920	2304
INSTRUCTION ROM <-> TABLE ROM	9 (N=8)	2048	2048
INSTRUCTION ROM <-> TABLE ROM	A (N=9)	2176	1792
INSTRUCTION ROM <-> TABLE ROM	B (N=10)	2304	1536
INSTRUCTION ROM <-> TABLE ROM	C (N=11)	2432	1280
INSTRUCTION ROM <-> TABLE ROM	D (N=12)	2560	1024
INSTRUCTION ROM <-> TABLE ROM	E (N=13)	2688	768
INSTRUCTION ROM <-> TABLE ROM	F (N=14)	2816	512
INSTRUCTION ROM <-> TABLE ROM	G (N=15)	2944	256

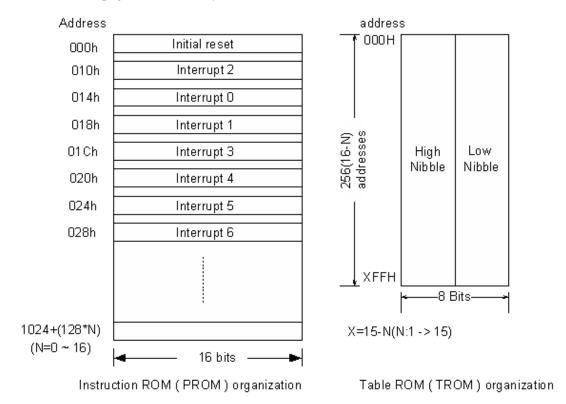
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### 2.4.1 INSTRUCTION ROM (PROM)

There are some special locations that serve as the interrupt service routines, such as reset address (000H), interrupt 0 address (014H), interrupt 1 address (018H), interrupt 2 address (010H), interrupt 3 address (01CH), interrupt 4 address (020H), interrupt 5 address (024H), and interrupt 6 address (028H) in the program memory.

When the useful address range of PROM exceeds 2048 addresses (800h), the memory space of PROM will be defined as 2 pages automatically. *Refer to section 2-3*.



This figure shows the Organization of ROM

#### 2.4.2 TABLE ROM (TROM)

The table ROM is organized with 256 (16-N) x 8 bits that shares the memory space with instruction ROM, as shown in the figure above. This memory space stores the constant data or look up table for the usage of main program. All of the table ROM addresses are specified by the index address register (@HL). The data width could be 8 bits (256 (16-N) x 8 bits) or 4 bits (512 (16-N) x 4 bits) which depends on the different usage. *Refer to the explanation of instruction chapter*.

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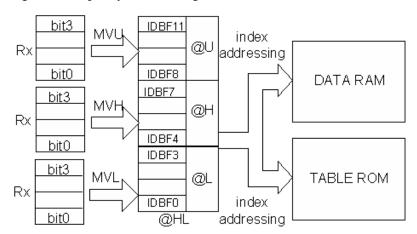


#### 2.5 INDEX ADDRESS REGISTER (@HL)

This is a versatile address pointer for the data memory (RAM) and table ROM (TROM). The index address register (@HL) is a 12-bit register, and the contents of the register can be modified by executing MVH, MVL and MVU instructions. Executed MVL instruction will load the content of specified data memory to the lower nibble of the index register (@L). In the same manner, executed MVH and MVU instructions may load the content of the data RAM (Rx) to the higher nibble of the register @H, @U respectively.

@U register				@H register				@L register			
Bit3	Bit2	Bit1	Bit0	Bit3	Bit2	Bit1	Bit0	Bit3	Bit2	Bit1	Bit0
IDBF11	IDBF10	IDBF9	IDBF8	IDBF7	IDBF6	IDBF5	IDBF4	IDBF3	IDBF2	IDBF1	IDBF0

The index address register can specify the full range addresses of the table ROM and data memory.



This figure shows the diagram of the index address register

The index address register is a write-only register, CPHL X instruction can specify an 8-bit immediate data to compare the content of @H and @L. When the result of comparison is equivalent, the instruction behind CPHL X will be skipped (NOP); if not, the instruction behind CPHL X will be executed normally.

<u>Note:</u> In the duration of comparison the index address, all the interrupt enable flags (IEF) has to be cleared to avoid malfunction.

The comparison bit pattern is shown below:

I	CPHL X	X7	X6	X5	X4	X3	X2	X1	X0
I	@HL	IDBF7	IDBF6	IDBF5	IDBF4	IDBF3	IDBF2	IDBF1	IDBF0

#### **Example:**

; @HL = 30h

CPHL 30h

SIE\* 0h ; disable IEF

JMP lable1 ; this instruction will be force as NOP

JMP lable2 ; this instruction will be executed and than jump to lable2

lable1:

lable2:



## 2.6 STACK REGISTER (STACK)

Stack is a special design register following the first-in-last-out rule. It is used to save the contents of the program counter sequentially during subroutine call or execution of the interrupt service routine.

The contents of stack register are returned sequentially to the program counter (PC) while executing return instructions (RTS).

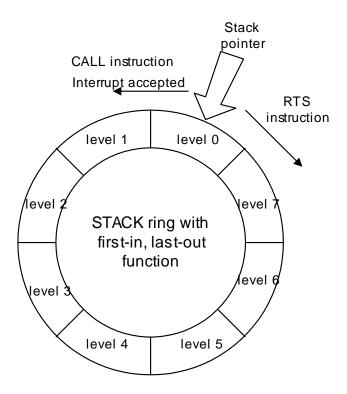
The stack register is organized using 11 bits by 8 levels but with no overflow flag; hence only 8 levels of subroutine call or interrupt are allowed (If the stacks are full, and either interrupt occurs or subroutine call executes, the first level will be overwritten).

Once the subroutine call or interrupt causes the stack register (STACK) overflows, the stack pointer will return to 0 and the content of the level 0 stack will be overwritten by the PC value.

The contents of the stack register (STACK) are returned sequentially to the program counter (PC) during execution of the RTS instruction.

Once the RTS instruction causes the stack register (STACK) underflows, the stack pointer will return to level 7 and the content of the level 7 stack will be restored to the program counter.

The following figure shows the diagram of the stack.



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#### 2.7 DATA MEMORY (RAM)

The static RAM is organized with 384 addresses x 4 bits and is used to store data.

The data memory may be accessed using two methods:

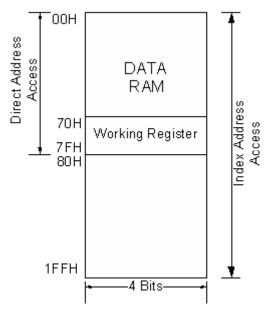
#### 1. Direct addressing mode

The address of the data memory is specified by the instruction and the addressing range is from 00H to 7FH.

## 2. Index addressing mode

The index address register (@HL) specifies the address of the data memory and all address space from 00H to 17FH can be accessed.

The 16 specified addresses (70H to 7FH) in the direct addressing memory are also used as 16 working registers. The function of working register will be described in detail in section 2-6.



This figure shows the Data Memory (RAM) and Working Register Organization

### 2.8 WORKING REGISTER (WR)

The locations 70H to 7FH of the data memory (RAM) are not only used as general-purpose data memory but also as the working register (WR). The following will introduce the general usage of working registers:

- 1. Can be used to perform operations on the contents of the working register and immediate data. Such as: ADCI, ADCI\*, SBCI, SBCI\*, ADDI, ADDI\*, SUBI, SUBI\*, ADNI, ADNI\*, ANDI, ANDI\*, EORI, EORI\*, ORI, ORI\*.
- 2. Can transfer the data between the working register and any address in the direct addressing data memory (RAM). Such as: MWR Rx, Ry; MRW Ry, Rx.

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**3.** Can decode (or directly transfer) the contents of the working register and output to the LCD PLA circuit. Such as: LCT, LCB, LCP.

# 2.9 ACCUMULATOR (AC)

The accumulator (AC) is a register that plays the most important role in operations and controls. By using it in conjunction with the ALU (Arithmetic and Logic Unit), data transfer between the accumulator and other registers or data memory can be performed.

### 2.10 ALU (Arithmetic and Logic Unit)

This is a circuitry that performs arithmetic and logic operation. The ALU provides the following functions:

Binary addition/subtraction (INC, DEC, ADC, SBC, ADD, SUB, ADN, ADCI, SBUI, ADNI)

Logic operation (AND, EOR, OR, ANDI, EORI, ORI)

Shift (SR0, SR1, SL0, SL1)

Decision (JB0, JB1, JB2, JB3, JC, JNC, JZ, and JNZ)

BCD operation (DAA, DAS)

## 2.11 HEXADECIMAL CONVERT TO DECIMAL (HCD)

Decimal format is another number format for TM8725. When the content of the data memory has been assigned as decimal format, it is necessary to convert the results to decimal format after the execution of ALU instructions. When the decimal converting operation is being processed, all of the operand data (including the contents of the data memory (RAM), accumulator (AC), immediate data, and look-up table) should be in the decimal format, otherwise the results of conversion will be incorrect.

Instructions DAA, DAA\*, DAA @HL can convert the data from hexadecimal to decimal format after any addition operation. The conversion rules are shown in the following table and illustrated in example 1.

AC data before DAA	CF data before DAA	AC data after DAA	CF data after DAA
execution	execution	execution	execution
$0 \le AC \le 9$	CF = 0	no change	no change
$A \le AC \le F$	CF = 0	AC = AC + 6	CF = 1
$0 \le AC \le 3$	CF = 1	AC= AC+ 6	no change

## Example 1:

LDS 10h, 9 ; Load immediate data "9" to data memory address 10H.

LDS 11h, 1 ; Load immediate data "1" to data memory address 11H

; and AC.

RF 1h ; Reset CF to 0.

ADD\* 10h ; Contents of the data memory address 10H and AC are

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; binary-added; the result loads to AC & data memory address

; 10H. (R10 = AC = AH, CF = 0)

DAA\* 10h ; Convert the content of AC to

; decimal format.

; The result in the data memory address 10H is "0" and in ; the CF is "1". This represents the decimal number "10".

Instructions DAS, DAS\*, DAS @HL can convert the data from hexadecimal format to decimal format after any subtraction operation. The conversion rules are shown in the following table and illustrated in Example 2.

AC data before DAS	CF data before DAS	AC data after DAS	CF data after DAS
execution	execution	execution	execution
$0 \le AC \le 9$	CF = 1	no change	no change
$6 \le AC \le F$	CF = 0	AC = AC + A	no change

#### Example 2:

LDS 10h, 1; Load immediate data "1" to the data memory address 10H.

LDS 11h, 2; Load immediate data "2" to the data memory address 11H and AC.

SF 1h ; Set CF to 1, which means no borrowing has occurred.
SUB\* 10h ; Content of data memory address 10H is binary-subtracted;

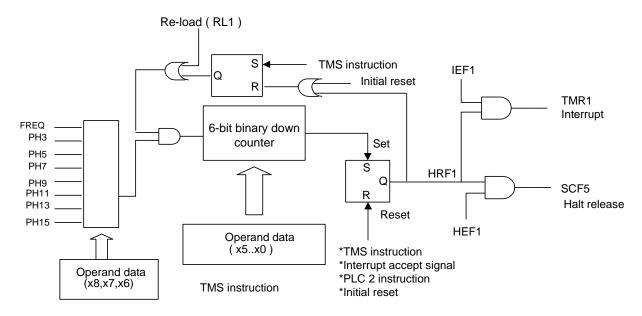
; the result loads to data memory address

; 10H. (R10 = AC = FH, CF = 0)

DAS\* 10h ; Convert the content of the data memory address 10H to decimal format.

; The result in the data memory address 10H is "9" and in ; the CF is "0". This represents the decimal number "-1".

# **2.12 TIMER 1 (TMR1)**



This figure shows the TMR1 organization.



#### 2.12.1 NORMAL OPERATION

TMR1 consists of a programmable 6-bit binary down counter, which is loaded and enabled by executing TMS or TMSX instruction.

Once the TMR1 counts down to 3Fh, it generates an underflow signal to set the halt release request flag 1 (HRF1) to 1 and then stop to count down.

When HRF1 = 1, and the TMR1 interrupt enable flag (IEF1) = 1, the interrupt is generated.

When HRF1 = 1, if the IEF1 = 0 and the TMR1 halt release enable (HEF1) = 1, program will escape from halt mode (if CPU is in halt mode) and then set the start condition flag 5 (SCF5) to 1 in the status register 3 (STS3).

After power on reset, the default clock source of TMR1 is PH3.

If watchdog reset occurs, the clock source of TMR1 will still keep the previous selection.

The following table shows the definition of each bit in TMR1 instructions

OPCODE	Select clock				In	itiate val	ue of tin	ner	
TMSX X	X8	X7	X6	X5	X4	X3	X2	X1	X0
TMS Rx	0	AC3	AC2	AC1	AC0	Rx3	Rx2	Rx1	Rx0
TMS @HL	0	bit7	bit6	bit5	Bit4	bit3	bit2	bit1	bit0

The following table shows the clock source setting for TMR1

X8	X7	X6	clock source
0	0	0	PH9
0	0	1	PH3
0	1	0	PH15
0	1	1	FREQ
1	0	0	PH5
1	0	1	PH7
1	1	0	PH11
1	1	1	PH13

## **Notes:**

1. When the TMR1 clock is PH3

TMR1 set time = (Set value + error) \*8 \* 1/fosc (KHz) (ms)

2. 2. When the TMR1 clock is PH9

TMR1 set time = (Set value + error) \* 512 \* 1/fosc (KHz) (ms)

3. When the TMR1 clock is PH15

TMR1 set time = (Set value + error) \* 32768 \* 1/fosc (KHz) (ms)

4. When the TMR1 clock is PH5

TMR1 set time = (Set value + error) \*32 \* 1/fosc (KHz) (ms)

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5. When the TMR1 clock is PH7

TMR1 set time = (Set value + error) \* 128 \* 1/fosc (KHz) (ms)

6. When the TMR1 clock is PH11

TMR1 set time = (Set value + error) \*2048 \* 1/fosc (KHz) (ms)

7. When the TMR1 clock is PH13

TMR1 set time = (Set value + error) \* 8192 \* 1/fosc (KHz) (ms)

Set value: Decimal number of timer set value error: the tolerance of set value, 0 < error < 1.

fosc: Input of the predivider

PH3: The 3rd stage output of the predivider

PH5: The 5th stage output of the predivider

PH7: The 7th stage output of the predivider

PH9: The 9th stage output of the predivider

PH11: The 11th stage output of the predivider

PH13: The 13th stage output of the predivider

PH15: The 15th stage output of the predivider

8. When the TMR1 clock is FREQ

TMR1 set time = (Set value + error) \* 1/FREQ (KHz) (ms).

FREQ: refer to section 3-3-4.

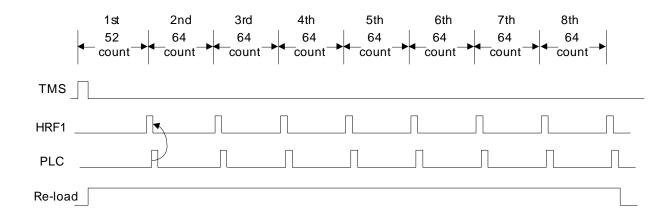
#### 2.12.2 RE-LOAD OPERATION

TMR1 provides the re-load function which can extend any time interval greater than 3Fh. The SF 80h instruction enables the re-load function and RF 80h instruction disables it. When the re-load function is enabled, the TMR1 will not stop counting until the re-load function is disabled and TMR1 underflows again. During this operation, the program must use the halt release request flag or interrupt to check the wanted counting value.

- It is necessary to execute the TMS or TMSX instruction to set the down count value before the reload function is enabled, because TMR1 will automatically count down with an unknown value once the re-load function is enabled.
- Never disable the re-load function before the last expected halt release or interrupt occurs. If TMS
  related instructions are not executed after each halt release or interrupt occurs, the TMR1 will stop
  operating immediately after the re-load function is disabled.

For example, if the expected count down value is 500, it may be divided as 52 + 7 \* 64. First, set the initiate count down value of TMR1 to 52 and start counting, then enable the TMR1 halt release or interrupt function. Before the first time underflow occurs, enable the re-load function. The TMR1 will continue operating even though TMR1 underflow occurs. When halt release or interrupt occurs, clear the HRF1 flag by PLC instruction. After halt release or interrupt occurs 8 times, disable the re-load function and the counting is completed.





In this example, S/W enters the halt mode to wait for the underflow of TMR1.

LDS 0, 0 ;initiate the underflow counting register

PLC 2

SHE 2 ;enable the HALT release caused by TMR1

TMS34h ;initiate the TMR1 value (52) and clock source is φ9

SF 80h ;enable the re-load function

RE\_LOAD:

HALT

INC\* 0 ;increase the underflow counter

PLC 2 ;clear HRF1

JB3 END\_TM1 ;if the TMR1 underflow counter is equal to 8, exit subroutine

JMP RE\_LOAD

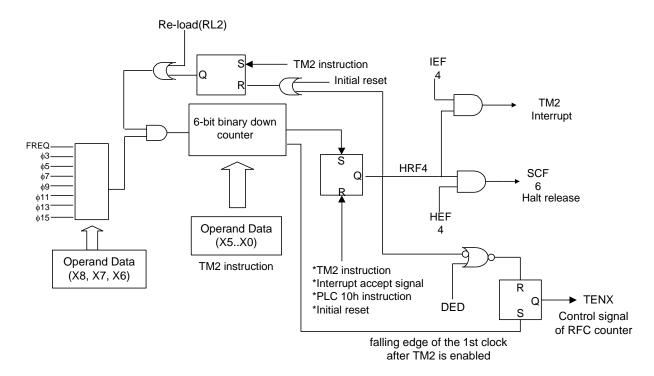
END\_TM1:

RF 80h ; disable the re-load function



#### 2.13 TIMER 2 (TMR2)

The following figure shows the TMR2 organization.



## 2.13.1 NORMAL OPERATION

TMR2 consists of a programmable 6-bit binary down counter, which is loaded and enabled by executing TM2 or TM2X instruction.

Once the TMR2 counts down to 3Fh, it stops counting, then generates an underflow signal and the halt release request flag 4 (HRF4) will be set to 1.

- When HRF4 = 1, and the TMR2 interrupt enabler (IEF4) is set to 1, the interrupt occurs.
- When HRF4 =1, IEF4 = 0, and the TMR2 halt release enabler (HEF4) is set to 1, program will escape from halt mode (if CPU is in halt mode) and then HRF4 sets the start condition flag 6 (SCF6) to 1 in the status register 4 (STS4).

After power on reset, the default clock source of TMR2 is PH7.

If watchdog reset occurs, the clock source of TMR2 will still keep the previous selection.

The following table shows the definition of each bit in TMR2 instructions

OPCODE Selec			Select clock		Ini	tiate val	ue of tin	ner	
TM2X X	X8	X7	X6	X5	X4	X3	X2	X1	X0
TM2 Rx	0	AC3	AC2	AC1	AC0	Rx3	Rx2	Rx1	Rx0
TM2 @HL	0	bit7	bit6	bit5	Bit4	bit3	bit2	bit1	bit0

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The following table shows the clock source setting for TMR2

X8	X7	X6	clock source
0	0	0	PH9
0	0	1	PH3
0	1	0	PH15
0	1	1	FREQ
1	0	0	PH5
1	0	1	PH7
1	1	0	PH11
1	1	1	PH13

#### **Notes:**

1. When the TMR2 clock is PH3

TMR2 set time = (Set value + error) \*8 \* 1/fosc (KHz) (ms)

2. When the TMR2 clock is PH9

TMR2 set time = (Set value + error) \* 512 \* 1/fosc (KHz) (ms)

3. When the TMR2 clock is PH15

TMR2 set time = (Set value + error) \* 32768 \* 1/fosc (KHz) (ms)

4. When the TMR2 clock is PH5

TMR2 set time = (Set value + error) \* 32 \* 1/fosc (KHz) (ms)

5. When the timer clock is PH7

TMR2 set time = (Set value + error) \* 128 \* 1/fosc (KHz) (ms)

6. When the TMR2 clock is PH11

TMR2 set time = (Set value + error) \* 2048 \* 1/fosc (KHz) (ms)

7. When the TMR2 clock is PH13

TMR2 set time = (Set value + error) \* 8192 \* 1/fosc (KHz) (ms)

Set value: Decimal number of timer set value

error: the tolerance of set value,  $0 < \mbox{error} < 1$ .

fosc: Input of the predivider

PH3: The 3rd stage output of the predivider

PH5: The 5th stage output of the predivider

PH7: The 7th stage output of the predivider

PH9: The 9th stage output of the predivider

PH11: The 11th stage output of the predivider

PH13: The 13th stage output of the predivider

PH15: The 15th stage output of the predivider

8. When the TMR2 clock is FREQ

TMR2 set time = (Set value + error) \* 1/FREQ (KHz) (ms).

FREQ: refer to section 3-3-4.



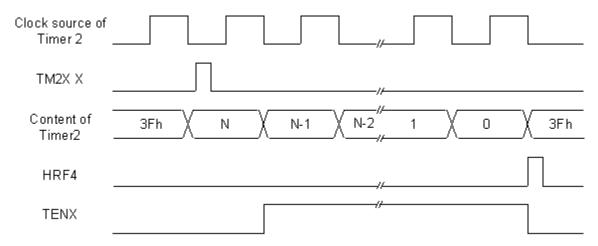
# 2.13.2 RE-LOAD OPERATION

TMR2 also provides the re-load function, the same as TMR1. The instruction SF2 1 enables the re-load function; the instruction RF2 1 disables it.

# 2.13.3 TIMER 2 (TMR2) IN RESISTOR TO FREQUENCY CONVERTER (RFC)

TMR2 also controlls the operation of RFC function.

TMR2 will set TENX flag to 1 to enable the RFC counter; once the TMR2 underflows, the TENX flag will be reset to 0 automatically. In this case, Timer 2 can set an accurate time period without setting a value error like the other operations of TMR1 and TMR2. Refer to 2-16 for detailed information on controlling the RFC counter. The following figure shows the operating timing of TMR 2 in RFC mode.



TMR2 also provides the re-load function when controlling the RFC function.

The SF2 1h instruction enables the re-load function, and the DED flag should be set to 1 by SF2 2h instruction. Once DED flag is set to 1, TENX flag will not be cleared to 0 while TMR2 underflows (but HRF4 will be set to1). The DED flag must be cleared to 0 by executing RF2 2h instruction before the last HRF4 occurs; thus, the TENX flag will be reset to 0 when the last HRF4 flag delivery. After the last underflow (HRF4) of TMR2 occurs, disable the re-load function by executing RF2 1h instruction.

For example, if the target set value is 500, it will be divided as 52 + 7 \* 64.

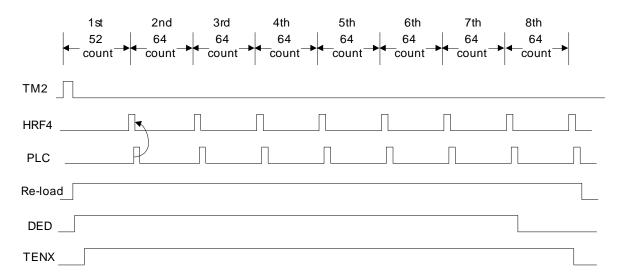
- 1. Set the initiate value of TMR2 to 52 and start counting.
- 2. Enable the TMR2 halt release or interrupt function.
- 3. Before the first underflow occurs, enable the re-load function and set the DED flag. The TMR2 will continue counting even if TMR2 underflows.
- 4. When halt release or interrupt occurs, clear the HRF4 flag by PLC instruction and increase the counting value to count the underflow times.
- 5. When halt release or interrupt occurs for the 7<sup>th</sup> time, reset the DED flag.
- 6. When halt release or interrupt occurs for the 8<sup>th</sup> time, disable the re-load function and the counting is completed.

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In this example, S/W enters the halt mode to wait for the underflow of TM2

```
LDS
                 0,0
                                 ;initiate the underflow counting register
       PLC
                 10h
       SHE
                 10h
                                 ;enable the halt release caused by TM2
       SRF
                 19h
                                 ;enable RFC, and controlled by TM2
                                 ;initiate the TM value (52) and clock source is \phi9
       TM2X
                34h
       SF2
                                 ;enable the re-load function and set DED flag to 1
                 3h
RE_LOAD:
       HALT
       INC*
                 0
                                 increase the underflow counter;
       PLC
                 10h
                                 ;clear HRF4
       LDS
                20h, 7
       SUB
                                 ;when halt is released for the 7th time, reset DED flag
       JNZ
                NOT_RESET_DED
       RF2
                                 ;reset DED flag
NOT_RESET_DED:
       LDA
                                 ;store underflow counter to AC
       JB3
                END_TM2
                                 ;if the TM2 underflow counter is equal to 8, exit this subroutine
       JMP
                 RE_LOAD
END_TM2:
       RF2
                                 ; disable the re-load function
                 1
```



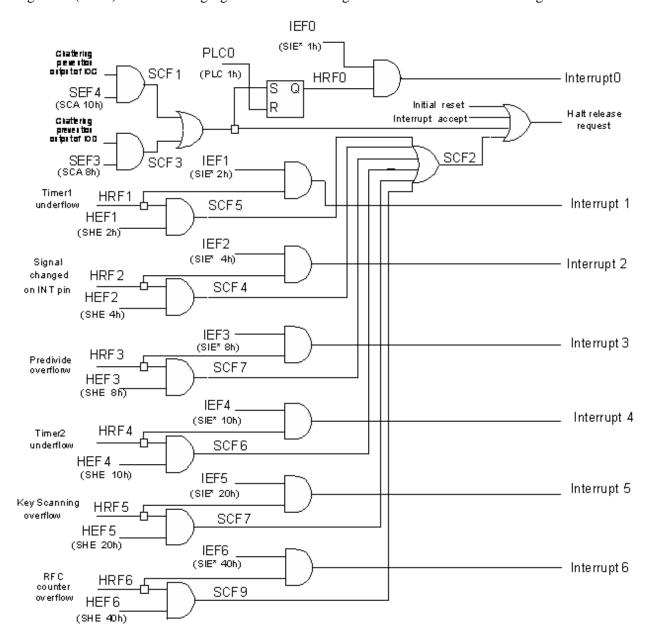
This figure shows the operating timing of TMR2 re-load function for RFC

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#### 2.14 STATUS REGISTER (STS)

The status register (STS) is organized with 4 bits and comes in 4 types: status register 1 (STS1) to status register 4 (STS4). The following figure shows the configuration of the start condition flags for TM8725.



# 2.14.1 STATUS REGISTER 1 (STS1)

Status register 1 (STS1) consists of 2 flags:

1. Carry flag (CF)

The carry flag is used to save the result of the carry or borrow during the arithmetic operation.

2. Zero flag (Z)



Indicate the accumulator (AC) status. When the content of the accumulator is 0, the Zero flag is set to 1. If the content of the accumulator is not 0, the zero flag is reset to 0.

- 3. The MAF instruction can be used to transfer data in status register 1 (STS1) to the accumulator (AC) and the data memory (RAM).
- 4. The MRA instruction can be used to transfer data of the data memory (RAM) to the status register 1 (STS1).

The bit pattern of status register 1 (STS1) is shown below.

Bit 3	Bit 2	Bit 1	Bit 0
Carry flag (AC)	Zero flag(Z)	NA	NA
Read/write	Read only	Read only	Read only

#### 2.14.2 STATUS REGISTER 2 (STS2)

Status register 2 (STS2) consists of start condition flag 1, 2 (SCF1, SCF2) and the backup flag.

The MSB instruction can be used to transfer data of status register 2 (STS2) to the accumulator (AC) and the data memory (RAM), but it is impossible to transfer data of the data memory (RAM) to status register 2 (STS2).

The following table shows the bit pattern of each flag in status register 2 (STS2).

Bit 3	Bit 2	Bit 1	Bit 0
Start condition flag 3	Start condition flag 2	Start condition flag 1	Backup flag
(SCF3)	(SCF2)	(SCF1)	(BCF)
Halt release caused by	Halt release caused by	Halt release caused by	The back up mode
the IOD port	SCF4,5,6,7,9	the IOC port	status
Read only	Read only	Read only	Read only

# • Start condition flag 3 (SCF3)

When the SCA instruction specified signal change occurs at port IOD to release the halt mode, SCF3 will be set. Executing the SCA instruction will cause SCF3 to be reset to 0.

# • Start condition flag 1 (SCF1)

When the SCA instruction specified signal change occurs at port IOC to release the halt mode, SCF1 will be set. Executing the SCA instruction will cause SCF1 to be reset to 0.

# • Start condition flag 2 (SCF2)

When a factor other than port IOA and IOC causes the halt mode to be released, SCF2 will be set to 1. In this case, if one or more start condition flags in SCF4, 5, 6, 7, 9 are set to 1, SCF2 will also be set to 1 simultaneously. When all of the flags in SCF4, 5, 6, 7, 9 are cleared, start condition flag 2 (SCF2) is reset to 0.

Note: If start condition flag is set to 1, the program will not be able to enter halt mode.

# • Backup flag (BCF)

This flag could be set/reset by executing the SF 2h/RF 2h instruction.



# 2.14.3 STATUS REGISTER 3 (STS3)

When the halt mode is released by start condition flag 2 (SCF2), status register 3 (STS3) will store the status of the factor in the release of the halt mode.

Status register 3 (STS3) consists of 4 flags:

1. Start condition flag 4 (SCF4)

Start condition flag 4 (SCF4) is set to 1 when the signal change at the INT pin causes the halt release request flag 2 (HRF2) to be output and the halt release enable flag 2 (HEF2) is set beforehand. To reset start condition flag 4 (SCF4), the PLC instruction must be used to reset the halt release request flag 2 (HRF2) or the SHE instruction must be used to reset the halt release enable flag 2 (HEF2).

2. Start condition flag 5 (SCF5)

Start condition flag 5 (SCF5) is set when an underflow signal from Timer 1 (TMR1) causes the halt release request flag 1 (HRF1) to be output and the halt release enable flag 1 (HEF1) is set beforehand. To reset start condition flag 5 (SCF5), the PLC instruction must be used to reset the halt release request flag 1 (HRF1) or the SHE instruction must be used to reset the halt release enable flag 1 (HEF1).

3. Start condition flag 7 (SCF7)

Start condition flag 7 (SCF7) is set when an overflow signal from the pre-divider causes the halt release request flag 3 (HRF3) to be output and the halt release enable flag 3 (HEF3) is set beforehand. To reset start condition flag 7 (SCF7), the PLC instruction must be used to reset the halt release request flag 3 (HRF3) or the SHE instruction must be used to reset the halt release enable flag 3 (HEF3).

4. The 15th stage's content of the pre-divider.

The MSC instruction is used to transfer the contents of status register 3 (STS3) to the accumulator (AC) and the data memory (RAM).

The following table shows the Bit Pattern of Status Register 3 (STS3)

	Bit 3	Bit 2	Bit 1	Bit 0
	Start condition flag 7	15th stage of the	Start condition flag 5	Start condition flag 4
	(SCF7)	pre-divider	(SCF5)	(SCF4)
	Halt release caused by		Halt release caused by	Halt release caused by
L	pre-divider overflow		TMR1 underflow	INT pin
	Read only	Read only	Read only	Read only

#### 2.14.4 STATUS REGISTER 3X (STS3X)

When the halt mode is released with start condition flag 2 (SCF2), status register 3X (STS3X) will store the status of the factor in the release of the halt mode.

Status register 3X (STS3X) consists of 3 flags:

1. Start condition flag 8 (SCF8)

SCF8 is set to 1 when any one of KI1~4 =1/0 (KI1~4=1 in LED mode / KI1~4=0 in LCD mode) causes the halt release request flag 5 (HRF5) to be output and the halt release enable flag 5 (HEF5) is



set beforehand. To reset the start condition flag 8 (SCF8), the PLC instruction must be used to reset the halt release request flag 5 (HRF5) or the SHE instruction must be used to reset the halt release enable flag 5 (HEF5).

# 2. Start condition flag 6 (SCF6)

SCF6 is set to 1 when an underflow signal from timer 2 (TMR2) causes the halt release request flag 4 (HRF4) to be output and the halt release enable flag 4 (HEF4) is set beforehand. To reset the start condition flag 6 (SCF6), the PLC instruction must be used to reset the halt release request flag 4 (HRF4) or the SHE instruction must be used to reset the halt release enable flag 4 (HEF4).

# 3. Start condition flag 9 (SCF9)

SCF9 is set when a finish signal from mode 3 of RFC function causes the halt release request flag 6 (HRF6) to be output and the halt release enable flag 9 (HEF9) is set beforehand. In this case, the 16-counter of RFC function must be controlled by CX pin; please refer to 2-16-9. To reset the start condition flag 9 (SCF9), the PLC instruction must be used to reset the halt release request flag 6 (HRF6) or the SHE instruction must be used to reset the halt release enable flag 6 (HEF6).

The MCX instruction can be used to transfer the contents of status register 3X (STS3X) to the accumulator (AC) and the data memory (RAM).

The following table shows the Bit Pattern of Status Register 3X (STS3X)

Bit 3	Bit 2	Bit 1	Bit 0
Start condition flag 9 (SCF9)	NA	Start condition flag 6 (SCF6)	Start condition flag 8 (SCF8)
Halt release caused by RFC counter finish		Halt release caused by TMR2 underflow	Halt release caused by SKI underflow
Read only	Read only	Read only	Read only

#### 2.14.5 STATUS REGISTER 4 (STS4)

Status register 4 (STS4) consists of 3 flags:

# 1. System clock selection flag (CSF)

The system clock selection flag (CSF) indicates which clock source of the system clock generator (SCG) is used. Executing SLOW instruction will change the clock source (BCLK) of the system clock generator (SCG) to the slow speed oscillator (XT clock), and the system clock selection flag (CSF) is reset to 0. Executing FAST instruction will change the clock source (BCLK) of the system clock generator (SCG) to the fast speed oscillator (CF clock), and the system clock selection flag (CSF) is set to 1. For the operation of the system clock generator, *refer to 3-3*.

# 2. Watchdog timer enable flag (WTEF)

The watchdog timer enable flag (WDF) indicates the operating status of the watchdog timer.

# 3. Overflow flag of 16-bit counter of RFC (RFOVF)

The overflow flag of 16-bit counter of RFC (RFOVF) is set to 1 when the overflow of the 16-bit counter of RFC occurs. The flag will reset to 0 when this counter is initiated by executing SRF instruction.

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The MSD instruction can be used to transfer the contents of status register 4 (STS4) to the accumulator (AC) and the data memory (RAM).

The following table shows the Bit Pattern of Status Register 4 (STS4)

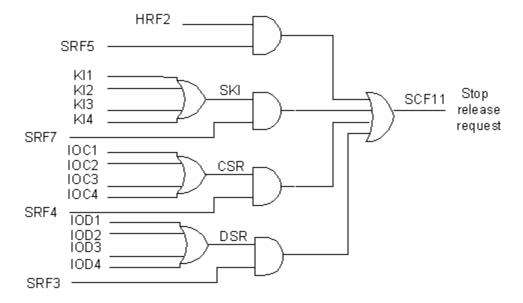
Bit 3	Bit 2	Bit 1	Bit 0
Reserved	The overflow flag of 16-bit	U	System clock
reserved	counter of RFC (RFVOF)	Enable flag (WDF)	selection flag (CSF)
Read only	Read only	Read only	Read only

#### 2.14.6 START CONDITION FLAG 11 (SCF11)

Start condition flag 11 (SCF11) will be set to 1 in STOP mode when the following conditions are met:

- A high level signal comes from the OR-ed output of the pins defined as input mode in IOC port, which causes the stop release flag of IOC port (CSR) to output, and stop release enable flag 4 (SRF4) is set beforehand.
- A high level signal comes from the OR-ed output of the pins defined as input mode in IOD port, which causes the stop release flag of IOD port (DSR) to output, and stop release enable flag 3 (SRF3) is set beforehand.
- A high level signal comes from the OR-ed output of the signals latch for KI1~4, which causes the stop release flag of Key Scanning (SKI) to output, and stop release enable flag 4 (SRF7) is set beforehand.
- The signal change from the INT pin causes the halt release flag 2 (HRF2) to output and the stop release enable flag 5 (SRF5) is set beforehand.

The following figure shows the organization of start condition flag 11 (SCF 11).



The stop release flags (SKI, CSR, DSR, and HRF2) are specified by the stop release enable flags (SRFx) and these flags should be cleared before the chip enters the stop mode. All of the pins in IOA and IOC

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port have to be defined as the input mode and keep in 0 state before the chip enters the STOP mode, or the program cannot enter the STOP mode.

Instruction SRE is used to set or reset the stop release enable flags (SRF4, 5, 7).

The following table shows the stop release request flags

	The OR-ed latched	The OR-ed input mode	The rising or falling edge
	signals for KI1~4	pins of IOC(IOD) port	on INT pin
Stop release request flag	SKI	CSR(DSR)	HRF2
Stop release enable flag	SRF7	SRF4(SRF3)	SRF5

# 2.15 CONTROL REGISTER (CTL)

The control register (CTL) comes in 4 types: control register 1 (CTL1) to control register 4 (CTL4).

#### 2.15.1 CONTROL REGISTER 1 (CTL1)

The control register 1 (CTL1), being a 1-bit register:

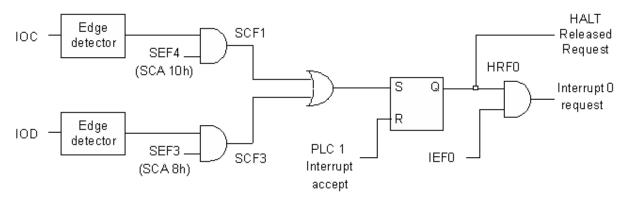
- 1. Switch enable flag 4 (SEF4)
  - Stores the status of the input signal change at pins of IOC defined as input mode that causes the halt mode or stop mode to be released.
- 2. Switch enable flag 3 (SEF3)
- 3. Stores the status of the input signal change at pins of IOD defined as input mode that causes the halt mode or stop mode to be released.

Executed SCA instruction may set or reset these flags.

The following table shows Bit Pattern of Control Register 1 (CTL1)

Bit 4	Bit3	
Switch enable flag 4 (SEF4)	Switch enable flag 3 (SEF3)	
Enables the halt release caused by the signal change on	Enables the halt release caused by the signal change on	
IOC port	IOD port	
Write only	Write only	

The following figure shows the organization of control register 1 (CTL1).





# 2.15.1.1 The Setting for Halt Mode

If the SEF4 (SEF3) is set to 1, the signal change on IOC (IOD) port will cause the halt mode to be released, and set SCF1 (SCF3) to 1. Because the input signal of IOC(IOD) port are ORed, so it is necessary to keep the unchanged input signals at "0" state and only one of the input signal can change state.

#### 2.15.1.2 The Setting for Stop Mode

If SRF4 (SRF3) and SEF4 (SEF3) are set, the stop mode will be released to set the SCF1 (SCF3) when a high level signal is applied to one of the input mode pins of IOC (IOD) port and the other pins stay in "0" state.

After the stop mode is released, TM8725 enters the halt condition.

The high level signal must hold for a while to cause the chattering prevention circuitry of IOC (IOD) port to detect this signal and then set SCF1 (SCF3) to release the halt mode, or the chip will return to the stop mode again.

## 2.15.1.3 Interrupt for CTL1

The control register 1 (CTL1) performs the following function in the execution of the SIE instruction to enable the interrupt function.

The input signal changes at the input pins in IOC (IOD) port will deliver the SCF1 (SCF3) when SEF4 (SEF3) has been set to 1 by executing SCA instruction. Once the SCF1 (SCF3) is delivered, the halt release request flag (HRF0) will be set to 1. In this case, if the interrupt enable flag 0 (IEF0) is set to 1 by executing SIE instruction, the interrupt request flag 0 (interrupt 0) will be delivered to interrupt the program.

If the interrupt 0 is accepted by SEF4 (SEF3) and IEF0, the interrupt 0 request to the next signal change at IOC (IOD) will be inhibited. To release this mode, SCA instruction must be executed again. *Refer to* 2-16-1-1.

#### 2.15.2 CONTROL REGISTER 2 (CTL2)

Control register 2 (CTL2) consists of halt release enable flags 1, 2, 3, 4, 5, 6 (HEF1, 2, 3, 4, 5, 6) and is set by SHE instruction. The bit pattern of the control register (CTL2) is shown below.

Halt release enable flag	ase enable flag HEF6 HEF5		HEF4
	Enable the halt release	Enable the halt release	Enable the halt release
Halt release condition	caused by RFC counter to	caused by Key	caused by TMR2 underflow
	be finished (HRF6)	Scanning(HRF5)	(HRF4)

Halt release enable flag	HEF3	HEF2	HEF1
Halt release condition	Enable the halt release caused by pre-divider overflow (HRF3)	Enable the halt release caused by INT pin (HRF2)	Enable the halt release caused by TM1 underflow (HRF1)

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When the halt release enable flag 6 (HEF6) is set, a finish signal from the 16-bit counter of RFC causes the halt mode to be released. In the same manner, when HEF1 to HEF4 are set to 1, the following conditions will cause the halt mode to be released respectively: an underflow signal from TMR1, the signal change at the INT pin, an overflow signal from the pre-divider and an underflow signal from TMR2, a 'H' signal from OR-ed output of KI1~4 latch signals.

When the stop release enable flag 5 (SRF5) and the HEF2 are set, the signal change at the INT pin can cause the stop mode to be released.

When the stop release enable flag 7 (SRF7) and the HEF5 are set, the 'H' signal from OR-ed output of K1~4 latch signals can cause the stop mode to be released.

## 2.15.3 CONTROL REGISTER 3 (CTL3)

Control register 3 (CTL3) is organized with 7 bits of interrupt enable flags (IEF) to enable/disable interrupts.

The interrupt enable flag (IEF) is set/reset by SIE\* instruction. The bit pattern of control register 3 (CTL3) is shown below.

Interrupt enable flag	IEF6	IEF5	IEF4
Interrupt request flag	Enable the interrupt request caused by RFC counter to be finished (HRF6)	Enable the interrupt request caused by Key Scanning (HRF5)	Enable the interrupt request caused by TMR2 underflow (HRF4)
Interrupt flag	Interrupt 6	Interrupt 4	Interrupt 4
Interrupt enable flag	IEF3	IEF2	IEF1
Interrupt request flag	Enable the interrupt request caused by predivider overflow (HRF3)	Enable the interrupt request caused by INT pin (HRF2)	Enable the interrupt request caused by TM1 underflow (HRF1)
Interrupt flag	Interrupt 3	Interrupt 2	Interrupt 1
Interrupt enable flag	IEF0		
Interrupt request flag	Enable the interrupt request caused by IOC or IOD port signal to be changed (HRF0)		
Interrupt flag	Interrupt 0		

When any of the interrupts are accepted, the corresponding HRFx and the interrupt enable flag (IEF) will be reset to 0 automatically. Therefore, the desirable interrupt enable flag (IEFx) must be set again before exiting from the interrupt routine.

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# 2.15.4 CONTROL REGISTER 4 (CTL4)

Control register 4 (CTL4), being a 3-bit register, is set/reset by SRE instruction.

The following table shows the Bit Pattern of Control Register 4 (CTL4)

Stop release enable flag	SRF7	SRF5	SRF4 (SRF3)
Stop release	Enable the stop release request	Enable the stop release request	Enable the stop release request
request flag	caused by signal change on	caused by signal change on INT	caused by signal change on IOC
request mag	KI1~4 (SKI)	pin (HRF2)	(IOD)

When the stop release enable flag 7 (SRF7) is set to 1, the input signal change at the KI1~4 pins causes the stop mode to be released. In the same manner, when SRF4 (SRF3) and SRF5 are set to 1, the input signal change at the input mode pins of IOC (IOD) port and the signal changed on INT pin causes the stop mode to be released respectively.

#### **Example:**

This example illustrates the stop mode released by port IOC, KI1~4 and INT pin. Assume all of the pins in IOD and IOC have been defined as input mode.

PLC	25h	; Reset the HRF0, HRF2 and HRF5.
SHE	24h	; HEF2 and HEF5 is set so that the signal change at INT or
		; KI1~4 pin causes start condition flag 4 or 8 to be set.
SCA	10h	; SEF4 is set so that the signal changes at port IOC
		; cause the start conditions SCF1 to be set.
SRE	0b0h	; SRF7, 5, 4 are set so that the signal changes at KI1~4 pins,
		; port IOC and INT pin cause the stop mode to be released.
STOP		; Enter the stop mode.
		; STOP release
MSC	10h	; Check the signal change at INT pin that causes the stop mode
		; to be released.
MSB	11h	; Check the signal change at port IOC that causes the stop
		; mode to be released.
MCX		
111021	12h	; Check the signal change at KI1~4 pins that causes the stop

## 2.16 HALT FUNCTION

The halt function is provided to minimize the current dissipation of the TM8725 when LCD is operating. During the halt mode, the program memory (ROM) is not in operation and only the oscillator circuit, predivider circuit, sound circuit, I/O port chattering prevention circuit, and LCD driver output circuit are in operation (If the timer has started operating, the timer counter still operates in the halt mode).

After the HALT instruction is executed and no halt release signal (SCF1, SCF3, HRF1 ~ 6) is delivered, the CPU enters the halt mode.

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The following 3 conditions are available to release the halt mode.

# 1. An interrupt is accepted.

When an interrupt is accepted, the halt mode is released automatically, and the program will enter halt mode again by executing the RTS instruction after completion of the interrupt service.

When the halt mode is released and an interrupt is accepted, the halt release signal is reset automatically.

- 2. The signal change specified by the SCA instruction is applied to port IOC (SCF1) or IOD (SCF3).
- **3.** The halt release condition specified by the SHE instruction is met (HRF1 ~ HRF6). When the halt mode is released in either (2) or (3), it is necessary that the MSB, MSC, or MCX instruction is executed in order to test the halt release signal and that the PLC instruction is then executed to reset the halt release signal (HRF).

Even when the halt instruction is executed in the state where the halt release signal is delivered, the CPU does not enter the halt mode.

#### 2.17 HEAVY LOAD FUNCTION

When heavy loading (lamp light-up, motor start, etc...) causes a temporary voltage drop on supply voltage, the heavy loading function (set BCF = 1) prevents TM8725 from malfunctioning, especially where a battery with high internal impedance, such as Li battery or alkali battery, is used.

During back up mode, the 32.768 KHz Crystal oscillator will add an extra buffer in parallel and switch the internal power (BAK) from VDD1 to VDD2 (Li power option only). In this condition, all of the functions in TM8725 will work under VDD voltage range; this will cause TM8725 to get better noise immunity.

For shorten the start-up time of 32.768 KHz Crystal oscillator, TM8725 will set the BCF to 1 during reset cycle and reset BCF to 0 after reset cycle automatically in Ag and Li power mode option. In EXT-V power mode option, however, BCF is set to 1 by default setting and can not be reset to 0, and BCF will be reset to 0 by default setting during normal operation.

Table 2-17-1 The back-up flag status in different conditions

	Ag option	Li option	EXT-V option	Remark
Reset cycle	BCF=1	BCF=1	BCF=0	large current
After reset cycle	BCF=1	BCF=1	BCF=0	large current
SF 2 executed	BCF=1	BCF=1	BCF=1	large current
RF 2 executed	BCF=0	BCF=0	BCF=0	

For low power consumption application, reset BCF to 0 is necessary; the 32.768 KHz Crystal oscillator operates with a normal buffer only, so switch the internal power (BAK) to VDD1 (Li power option only). In this condition, only peripheral circuitry operates under VDD voltage range; the other functions will operate under 1/2 VDD voltage range. In Ag and EXT-V power options, the internal power (BAK) will not be affected by the setting of BCF. With Li power option, it is necessary to connect a 0.1 uf capacitor from BAK power pin to GND for the backup mode application.

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When the heavy load function is performed, the current dissipation will increase.

Table 2-17-2 Ag power option:

	Initial reset	After reset	STOP mode	SF 2	RF 2
BCF	1	1	1*	1	0
Internal logic	VDD	VDD	VDD	VDD	VDD
Peripheral logic	VDD	VDD	VDD	VDD	VDD

Table 2-17-3 Li power option:

	Initial reset	After reset	Stop mode	SF 2	RF 2
BCF	1	1	1*	1	0
Internal logic	VDD	VDD	VDD	VDD	1/2 VDD
Peripheral logic	VDD	VDD	VDD	VDD	VDD

Table 2-17-4 EXT-V power option:

	Initial reset	After reset	Stop mode	SF 2	RF 2
BCF	0	0	1*	1	1
Internal logic	VDD	VDD	VDD	VDD	VDD
Peripheral logic	VDD	VDD	VDD	VDD	VDD

<u>Note:</u> When the program enters the stop mode, the BCF will set to 1 automatically to insure that the low speed oscillator will start up in a proper condition while stop release occurs.

# 2.18 STOP FUNCTION (STOP)

The stop function is another solution to minimize the current dissipation for TM8725. In stop mode, all of functions in TM8725 are held including oscillators. All of the LCD corresponding signals (COM and Segment) will output "L" level. In this mode, TM8725 does not dissipate any power in the stop mode. Because the stop mode will set the BCF flag to 1 automatically, it is recommended to reset the BCF flag after releasing the stop mode in order to reduce power consumption. Before the stop instruction is executed, all of the signals on the pins defined as input mode of IOD and IOC ports must be in the "L" state, and no stop release signal (SRFn) should be delivered. The CPU will then enter the stop mode.

The following conditions cause the stop mode to be released.

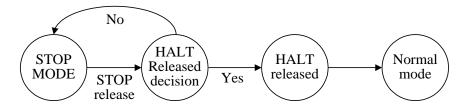
- One of the signals on the input mode pin of IOD or IOC port is in "H" state and holds long enough to cause the CPU to be released from halt mode.
- A signal change in the INT pin.
- The stop release condition specified by the SRE instruction is met.

When the TM8725 is released from the stop mode, the TM8725 enters the halt mode immediately and will process the halt release procedure. If the "H" signal on the IOC (IOD) port does not hold long enough to set the SCF1 (SCF3), once the signal on the IOC port returns to "L", the TM8725 will enter the stop mode immediately. The backup flag (BCF) will be set to 1 automatically after the program enters the stop mode.

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The following diagram shows the stop release procedure:



This Figure shows the stop release state machine

Before the stop instruction is executed, the following operations must be completed:

- Specify the stop release conditions by the SRE instruction.
- Specify the halt release conditions corresponding to the stop release conditions if needed.
- Specify the interrupt conditions corresponding to the stop release conditions if needed.

When the stop mode is released by an interrupt request, the TM8725 will enter the halt mode immediately. While the interrupt is accepted, the halt mode will be released by the interrupt request. The stop mode returns by executing the RTS instruction after completion of interrupt service. After the stop release, it is necessary that the MSB, MSC or MCX instruction be executed to test the halt release signal and that the PLC instruction then be executed to reset the halt release signal. Even when the stop instruction is executed in the state where the stop release signal (SRF) is delivered, the CPU does not enter the stop mode but the halt mode. When the stop mode is released and an interrupt is accepted, the halt release signal (HRF) is reset automatically.

# 2.19 BACK UP FUNCTION

TM8725 provide a back up mode to avoid system malfunction when heavy loading occurs, such as buzzer is active, LED is lighting, etc.... Since the heavy loading will cause a large voltage drop on the supply voltage, and the system will be malfunction in this condition.

Once the program enter back up mode (BCF = 1), 32.768 KHz Crystal oscillator will operate in a large driver condition and internal logic function operates with higher supply voltage. TM8725 will get more power supply noise margin while back up mode is active but also increases more power consumption.

The back up flag (BCF) indicates the status of back up function. BCF flag could be set or reset by executing SF or RF instruction respectively. The back up function has different performance corresponding to different power mode option, shown in the following table.

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# 1.5V battery mode:

TM8725 status	BCF flag status
Initial reset cycle	BCF = 1 (hardware controlled)
After initial reset cycle	BCF = 1 (hardware controlled)
Executing SF 2h instruction	BCF = 1
Executing RF 2h instruction	BCF = 0
HALT mode	Previous state
STOP mode	BCF = 1 (hardware controlled)

TM8725 status	BCF = 0	BCF = 1
32.768 KHz Crystal Oscillator	Small driver	Large driver
Voltage on BAK pin	VDD1	VDD1
Internal operating voltage	VDD1	VDD1

# 3V battery or higher mode:

TM8725 status	BCF flag status
Initial reset cycle	BCF = 1 (hardware controlled)
After initial reset cycle	BCF = 1 (hardware controlled)
Executing SF 2h instruction	BCF = 1
Executing RF 2h instruction	BCF = 0
HALT mode	Previous state
STOP mode	BCF = 1 (hardware controlled)

	BCF = 0	BCF = 1
32.768 KHz Crystal Oscillator	Small driver	Large driver
Voltage on BAK pin	VDD1	VDD2
Internal operating voltage	VDD1	VDD2

# Ext-V power mode:

TM8725 status	BCF flag status
Initial reset cycle	BCF = 0 (hardware controlled)
After initial reset cycle	BCF = 0 (hardware controlled)
Executing SF 2h instruction	BCF = 1
Executing RF 2h instruction	BCF = 0
HALT mode	Previous state
STOP mode	BCF = 1 (hardware controlled)

	BCF = 0	BCF = 1
32.768 KHz Crystal Oscillator	Large driver	Large driver
Voltage on BAK pin	VDD2	VDD2
Internal operating voltage	VDD2	VDD2

**Note:** For power saving reason, it is recommended to reset BCF flag to 0 when back up mode is not used.



# 3. Control Function

# 3.1 INTERRUPT FUNCTION

There are 7 interrupt resources: 3 external interrupt factors and 4 internal interrupt factors. When an interrupt is accepted, the program in execution is suspended temporarily and the corresponding interrupt service routine specified by a fix address in the program memory (ROM) is called.

The following table shows the flag and service of each interrupt:

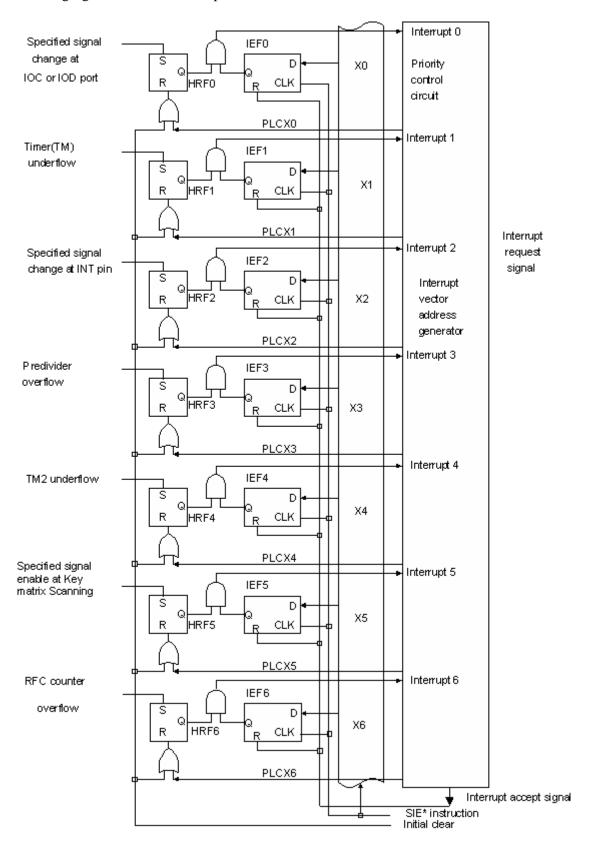
Table 3-1-1 Interrupt information

Interrupt source	INT pin	IOC or IOD port	TMR1 underflow	Pre-divider overflow	TMR2 underflow	Key matrix Scanning	RFC counter overflow
Interrupt vector	010H	014H	018H	01CH	020H	024H	028H
Interrupt enable flag	IEF2	IEF0	IEF1	IEF3	IEF4	IEF5	IEF6
Interrupt priority	6 <sup>th</sup>	5 <sup>th</sup>	2 <sup>nd</sup>	1 <sup>st</sup>	$3^{\rm rd}$	7 <sup>th</sup>	4 <sup>th</sup>
Interrupt request flag	Interrupt 2	Interrupt 0	Interrupt 1	Interrupt 3	Interrupt 4	Interrupt 5	Interrupt 6

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The following figure shows the Interrupt Control Circuit





# 3.1.1 INTERRUPT REQUEST AND SERVICE ADDRESS

### 3.1.1.1 External interrupt factor

The external interrupt factor involves the use of the INT pin, IOC or IOD ports, or Key matrix Scanning.

## (1) External INT pin interrupt request.

By using mask option, either a rise or fall of the signal at the INT pin can be selected for applying an interrupt. If the interrupt enable flag 2 (IEF2) is set and the signal on the INT pin change that matches the mask option will issue the HRF2, interrupt 2 is accepted and the instruction at address 10H is executed automatically. It is necessary to apply level "L" before the signal rises and level "H" after the signal rises to the INT pin for at least 1 machine cycle.

# (2) I/O port IOC (IOD) interrupts request.

An interrupt request signal (HRF0) is delivered when the input signal changes at I/O port IOC (IOD) specified by the SCA instruction. In this case, if the interrupt enabled by flag 0 (IEF0) is set to 1, interrupt 0 is accepted and the instruction at address 14H is executed automatically.

### (3) Key matrix Scanning interrupt request.

An interrupt request signal (HRF5) is delivered when the input signal generated in scanning interval. If the interrupt enable flag 5 (IEF5) is set to 1 and interrupt 5 is accepted, the instruction at address 24H will be executed automatically.

#### 3.1.1.2 nternal interrupt factor

The internal interrupt factor involves the use of timer 1 (TMR1), timer 2 (TMR2), RFC counter and the pre-divider.

## (1) Timer1/2 (TMR1/2) interrupt request

An interrupt request signal (HRF1/4) is delivered when timer1/2 (TMR1/2) underflows. In this case, if the interrupt enable flag 1/4 (IEF1/4) is set, interrupt 1/4 is accepted and the instruction at address 18H/20H is executed automatically.

#### (2) Pre-divider interrupt request

An interrupt request signal (HRF3) is delivered when the pre-divider overflows. In this case, if the interrupt enable flag3 (IEF3) is set, interrupt 3 is accepted and the instruction at address 1CH is executed automatically.

# (3) 16-bit counter of RFC (CX pin control mode) interrupt request

An interrupt request signal (HRF6) is delivered when the 2nd falling edge applied on CX pin and 16-bit counter stops to operate. In this case, if the interrupt enable flag6 (IEF6) is set, interrupt 6 is accepted and the instruction at address 28H is executed automatically.



#### 3.1.2 INTERRUPT PRIORITY

If all interrupts are requested simultaneously during a state when all interrupts are enabled, the predivider interrupt is given the first priority and other interrupts are held. When the interrupt service routine is initiated, all of the interrupt enable flags (IEF0  $\sim$  IEF6) are cleared and should be set with the next execution of the SIE instruction.

## **Example:**

; Assume all interrupts are requested simultaneously when all interrupts are enabled, and ; all of the pins of IOC have been defined as input mode.

PLC 7Fh ; Clear all of the HRF flags

SCA 10h; Enable the interrupt request of IOC

SIE\* 7Fh ; Enable all interrupt requests

; All interrupts are requested simultaneously.

; Interrupt caused by the predivider overflow occurs, and interrupt service is concluded.

SIE\* 77h ; Enable the interrupt request (except the predivider).

; Interrupt caused by the TM1 underflow occurs, and interrupt service is concluded.

SIE\* 75h ; Enable the interrupt request (except the predivider and TMR1).

; Interrupt caused by the TM2 underflow occurs, and interrupt service is concluded.

SIE\* 65h ; Enable the interrupt request (except the predivider, TMR1 and TMR2).

; Interrupt caused by the RFC counter overflow occurs, and interrupt service is concluded.

SIE\* 25h ; Enable the interrupt request (except the predivider, TMR1,

; TMR2, and the RFC counter).

; Interrupt caused by the IOC port, and interrupt service is concluded.

SIE\* 24h ; Enable the interrupt request (except the predivider, TMR1,

; TMR2, RFC counter, and IOC port)

; Interrupt caused by the INT pin, and interrupt service is concluded.

SIE\* 20h ;Enable the interrupt request (except the predivider, TMR1,

;TMR2, RFC counter, IOC port, and INT)

; Interrupt caused by the Key matrix Scanning, and interrupt service is concluded.

; All interrupt requests have been processed.



#### 3.1.3 INTERRUPT SERVICING

When an interrupt is enabled, the program in execution is suspended and the instruction at the interrupt service address is executed automatically. In this case, the CPU performs the following services automatically.

- (1) As for the return address of the interrupt service routine, the addresses of the program counter (PC) installed before interrupt service begin are saved in the stack register (STACK).
- (2) The corresponding interrupt service routine address is loaded in the program counter (PC).

The interrupt request flag corresponding to the interrupt accepted is reset and the interrupt enable flags are all reset.

When the interrupt occurs, the TM8725 will follow the procedure below:

Instruction 1; In this instruction, interrupt is accepted.

NOP ; TM8725 stores the program counter data into the STACK. At this

; time, no instruction will be executed, as with NOP instruction.

Instruction A ; The program jumps to the interrupt service routine.

Instruction B Instruction C

.....

RTS ; Finish the interrupt service routine

Instruction 1\*; re-execute the instruction which is interrupted.

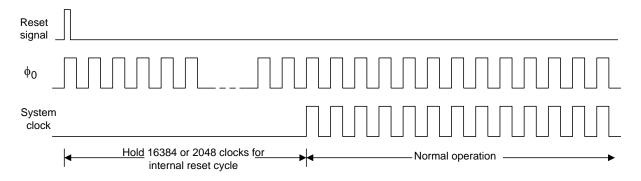
Instruction 2

Note: If instruction 1 is "halt" instruction, the CPU will return to "halt" after interrupt.

When an interrupt is accepted, all interrupt enable flags are reset to 0 and the corresponding HRF flag will be cleared; the interrupt enable flags (IEF) must be set again in the interrupt service routine as required.

#### 3.2 RESET FUNCTION

TM8725 contains four reset sources: power-on reset, RESET pin reset, IOC port reset and watchdog timer reset. When reset signal is accepted, TM8725 will generate a time period for internal reset cycle and there are two types of internal reset cycle time could be selected by mask option, the one is PH15/2 and the other is PH12/2.





## • Internal reset cycle time is PH15/2

#### MASK OPTION table:

Mask Option name	Selected item
RESET TIME	(1) PH15/2

In this option, the reset cycle time will be extended 16384 clocks (clock source comes form pre-divider) long at least.

# • Internal reset cycle time is PH12/2

#### MASK OPTION table:

Mask Option name	Selected item
RESET TIME	(2) PH12/2

In this option, the reset cycle time will be extended 2048 clocks (clock source comes form pre-divider) long at least.

#### 3.2.1 POWER ON RESET

TM8725 provides a power on reset function. If the power (VDD) is turned on or power supply drops below 0.6V, it will generate a power-on reset signal. Power-on reset function can be disabled by mask option.

## MASK OPTION table:

Mask Option name	Selected item
POWER ON RESET	(1) USE
POWER ON RESET	(2) NO USE

## 3.2.2 RESET PIN RESET

When "H" level is applied to the reset pin, the reset signal will issue. There is a built-in pull down resistor on this pin. Two types of reset method for RESET pin and the type could be mask option, the one is level reset and other is pulse reset. It is recommended to connect a capacitor (0.1 uf) between RESET pin and VDD. This connection will prevent the bounce signal on RESET pin.

#### 3.2.2.1 Level Reset

Once a "1" signal applied on the RESET pin, TM8725 will not release the reset cycle until the signal on RESET pin returned to "0". After the signal on reset pin is cleared to 0, TM8725 begins the internal reset cycle and then release the reset status automatically.

#### • MASK OPTION table:

Mask Option name	Selected item
RESET PIN TYPE	(1) LEVEL

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# 3.2.2.2 Pulse Reset

Once a "1" signal applied on the RESET pin, TM8725 will escape from reset state and begin the normal operation after internal reset cycle automatically no matter what the signal on RESET pin returned to "0" or not.

#### • MASK OPTION table:

Mask Option name	Selected item
RESET PIN TYPE	(2) PULSE

The following table shows the initial condition of TM8725 in reset cycle.

Program counter	(PC)	Address 000H
Start condition flags 1 to 7	(SCF1-7)	0
Backup flag	(BCF)	1 (Ag, Li version) 0 (EXTV version)
Stop release enable flags 4,5,7	(SRF3,4,5,7)	0
Switch enable flags 4	(SEF3,4)	0
Halt release request flag	(HRF 0~6)	0
Halt release enable flags 1 to 3	(HEF1-6)	0
Interrupt enable flags 0 to 3	(IEF0-6)	0
Alarm output	(ALARM)	DC 0
Pull-down flags in I/OC, I/OD port		1(with pull-down resistor)
Input/output ports I/OA, I/OB, I/OC, I/OD	(PORT I/OA, I/OB, I/OC, I/OD)	Input mode
I/OC, I/OD port chattering clock	Cch	PH10*
EL panel driver pumping clock source and duty cycle	Celp	PH0, duty cycle is 1/4
EL panel driver clearing clock source and duty cycle	Celc	PH8, duty cycle is 1/4
Frequency generator clock source and duty cycle	Cfq	PH0, duty cycle is 1/4, output is inactive
Resistor frequency converter	(RFC)	Inactive, RR/RT/RH output 0
LCD driver output		All lighted (mask option)*
Timer 1/2		Inactive
Watchdog timer	(WDT)	Reset mode, $WDF = 0$
Clock source	(BCLK)	XT clock (slow speed clock in dual clock option)

Notes: PH3: the 3rd output of predivider PH10: the 10th output of predivider

Mask option can unlight all of the LCD output

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# 3.2.3 IOC Port / Key Matrix RESET

Key reset function is selected by mask option. When IOC port or key matrix scanning input (KI1~4) is in use, the '0' signal applied to all these pins that has been set as input mode in the same time (KI1~4 pins need to wait scanning time), reset signal is delivered.

# MASK OPTION table:

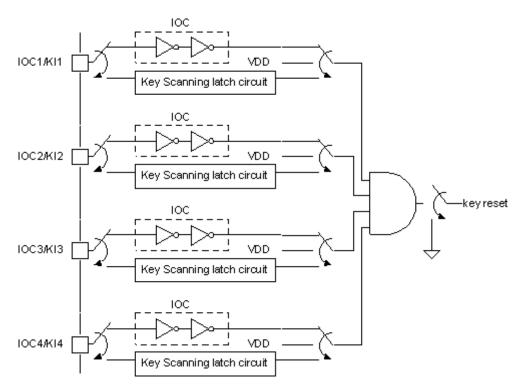
• IOC or KI pins are used as key reset:

Mask Option name	Selected item
IOC1/KI1 FOR KEY RESET	(1) USE
IOC2/KI2 FOR KEY RESET	(1) USE
IOC3/KI3 FOR KEY RESET	(1) USE
IOC4/KI4 FOR KEY RESET	(1) USE

# • IOC or KI pins aren't used as key reset:

Mask Option name	Selected item			
IOC1/KI1 FOR KEY RESET	(2) NO USE			
IOC2/KI2 FOR KEY RESET	(2) NO USE			
IOC3/KI3 FOR KEY RESET	(2) NO USE			
IOC4/KI4 FOR KEY RESET	(2) NO USE			

The following figure shows the key reset organization.



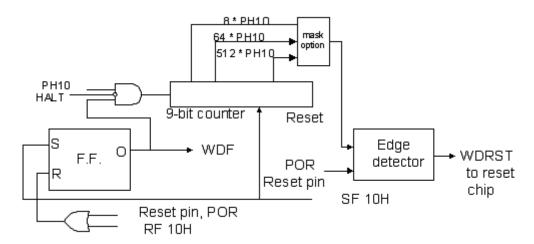


#### 3.2.4 WATCHDOG RESET

The timer is used to detect unexpected execution sequence caused by software run-away. The watchdog timer consists of a 9-bit binary counter. The timer input (PH10) is the 10th stage output of the pre-divider.

When the watchdog timer overflows, it generates a reset signal to reset TM8725 and most of the functions in TM8725 will be initiated except for the watchdog timer (which is still active), WDF flag will not be affected and PH0 ~ PH10 of the pre-divider will not be reset.

The following figure shows the watchdog timer organization.



During initial reset (power on reset [POR] or reset pin), the timer is inactive and the watchdog flag (WDF) is reset. Instruction SF 10h will enable the watchdog timer and set the watchdog flag (WDF) to 1. At the same time, the content of the timer will be cleared. Once the watchdog timer is enabled, the timer will be paused when the program enters the halt mode or stop mode. When the TM8725 wakes up from the halt or stop mode, the timer operates continuously. It is recommended to execute SF 10h instruction before the program enters the halt or stop mode in order to initialize the watchdog timer.

Once the watchdog timer is enabled, the program must execute SF 10h instruction periodically to prevent the timer overflowed.

The overflow time interval of watchdog timer is selected by mask option:

## MASK OPTION table:

Mask Option name	Selected item
WATCHDOG TIMER OVERFLOW TIME INTERVAL	(1) 8 x PH10
WATCHDOG TIMER OVERFLOW TIME INTERVAL	(2) 64 x PH10
WATCHDOG TIMER OVERFLOW TIME INTERVAL	(3) 512 x PH10

Note: timer overflow time interval is about 16 seconds when PH0 = 32.768 KHz

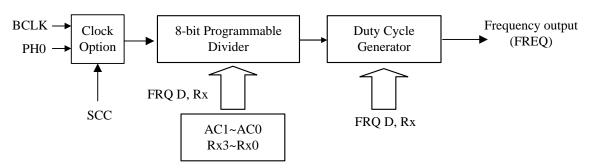


#### 3.3 CLOCK GENERATOR

#### 3.3.1 FREQUENCY GENERATOR

The Frequency Generator is a versatile programmable divider that is capable of delivering a clock with wide frequency range and different duty cycles. The output of the frequency generator may be the clock source for the alarm function, timer1, timer2 and RFC counter.

The following shows the organization of the frequency generator.



SCC instruction may specify the clock source selection for the frequency generator. The frequency generator outputs the clock with different frequencies and duty cycles corresponding to the presetting data of FRQ related instructions. The FRQ related instructions preset a letter N into the programming divider and letter D into the duty cycle generator. The frequency generator will then output the clock using the following formula:

FREQ= (clock source) / 
$$((N+1) * X)$$
 Hz.  $(X=1, 2, 3, 4 \text{ for } 1/1, 1/2, 1/3, 1/4 \text{ duty})$ 

This letter N is a combination of data memory and accumulator (AC), or the table ROM data or operand data specified in the FRQX instruction. The following table shows the bit pattern of the combination.

The following table shows the bit pattern of the preset letter N

	The bit pattern of preset letter N							
Programming divider	bit7	Bit6	bit 5	bit 4	bit 3	Bit 2	bit 1	bit 0
FRQ D,Rx	AC3	C2	AC1	AC0	Rx3	Rx2	Rx1	Rx0
FRQ D,@HL	T7	T6	T5	T4	Т3	T2	T1	T0
FRQX D,X	X7	X6	X5	X4	X3	X2	X1	X0

Notes: 1. T0 ~ T7 represents the data of table ROM.

2.  $X0 \sim X7$  represents the data specified in operand X.

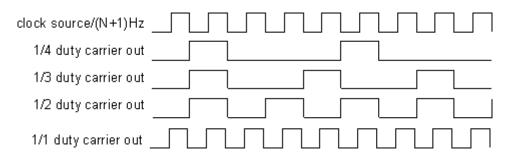
The following table shows the bit pattern of the preset letter D

Preset I	Letter D	Duty Cycle		
D1	D0	Duty Cycle		
0	0	1/4 duty		
0	1	1/3 duty		
1	0	1/2 duty		
1	1	1/1 duty		

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The following diagram shows the output waveform for different duty cycles.



# 3.3.2 Melody Output

The frequency generator may generate the frequency for melody usage. When the frequency generator is used to generate the melody output, the tone table is shown below:

- (1) The clock source is PH0, i.e. 32,768 Hz
- (2) The duty cycle is 1/2 Duty (D=2)
- (3) "FREQ" is the output frequency
- (4) "ideal" is the ideal tone frequency
- (5) "%" is the frequency deviation

The following table shows the note table for melody application

Tone	N	FREQ	Ideal	%	Tone	N	FREQ	Ideal	%
C2	249	65.5360	65.4064	0.19	C4	62	260.063	261.626	-0.60
#C2	235	69.4237	69.2957	0.18	#C4	58	277.695	277.183	0.18
D2	222	73.4709	73.4162	0.07	D4	55	292.571	293.665	-0.37
#D2	210	77.6493	77.7817	-0.17	#D4	52	309.132	311.127	-0.64
E2	198	82.3317	82.4069	-0.09	E4	49	327.680	329.628	-0.59
F2	187	87.1489	87.3071	-0.18	F4	46	348.596	349.228	-0.18
#F2	176	92.5650	92.4986	0.07	#F4	43	372.364	369.994	0.64
G2	166	98.1078	97.9989	0.11	G4	41	390.095	391.995	-0.48
#G2	157	103.696	103.826	-0.13	#G4	38	420.103	415.305	1.16
A2	148	109.960	110.000	-0.04	A4	36	442.811	440.000	0.64
#A2	140	116.199	116.541	-0.29	#A4	34	468.114	466.164	0.42
B2	132	123.188	123.471	-0.23	B4	32	496.485	493.883	0.53
C3	124	131.072	130.813	0.20	C5	30	528.516	523.251	1.01
#C3	117	138.847	138.591	0.19	#C5	29	546.133	554.365	-1.48
D3	111	146.286	146.832	-0.37	D5	27	585.143	587.330	-0.37
#D3	104	156.038	155.563	0.31	#D5	25	630.154	622.254	1.27
E3	98	165.495	164.814	0.41	E5	24	655.360	659.255	-0.59
F3	93	174.298	174.614	-0.18	F5	22	712.348	698.456	1.99
#F3	88	184.090	184.997	-0.49	#F5	21	744.727	739.989	0.64
G3	83	195.048	195.998	-0.48	G5	20	780.190	783.991	-0.48
#G3	78	207.392	207.652	-0.13	#G5	19	819.200	830.609	-1.37
A3	73	221.405	220.000	0.64	A5	18	862.316	880.000	-2.01
#A3	69	234.057	233.082	0.42	#A5	17	910.222	932.328	-2.37
В3	65	248.242	246.942	0.53	В5	16	963.765	987.767	-2.43

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Notes: 1. Above variation does not include X'tal variation.

2. If PH0 = 65536 Hz, C3 - B5 may have more accurate frequency.

During the application of melody output, sound effect output or carrier output of remote control, the frequency generator needs to combine with the alarm function (BZB, BZ). For detailed information about this application, *refer to section 3-4*.

#### 3.3.3 Halver/Doubler/Tripler

The halver/doubler/tripler circuits are used to generate the bias voltage for LCD and are composed of a combination of PH2, PH3, PH4, and PH5. When the Li battery application is used, the 1/2 VDD voltage generated by the halver operation is supplied to the circuits which are not related to input / output operation.

## 3.3.4 Alternating Frequency for LCD

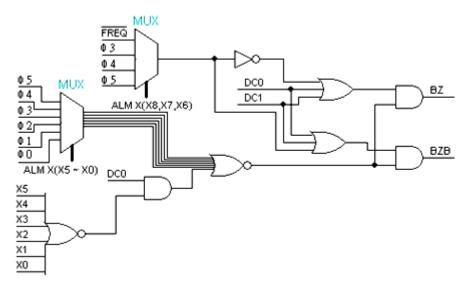
The alternating frequency for LCD is a frequency used to make the LCD waveform.

#### 3.4 BUZZER OUTPUT PINS

There are two output pins, BZB and BZ. Each is MUXed with IOB3 and IOB4 by mask option, respectively. BZB and BZ pins are versatile output pins with complementary output polarity. When buzzer output function combined with the clock source comes from the frequency generator, this output function may generate melody, sound effect or carrier output of remote control.

#### MASK OPTION table:

Mask Option name	Selected item
SEG30/IOB3/BZB	(3) BZB
SEG31/IOB4/BZ	(3) BZ



This figure shows the organization of the buzzer output.

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#### 3.4.1 BASIC BUZZER OUTPUT

The buzzer output (BZ, BZB) is suitable for driving a transistor for the buzzer with one output pin or driving a buzzer with BZ and BZB pins directly. It is capable of delivering a modulation output in any combination of one signal of FREQ, PH3 (1024 Hz), PH4 (2048 Hz), PH5 (1024 Hz) and multiple signals of PH10 (32 Hz), PH11 (16 Hz), PH12 (8 Hz), PH13 (4 Hz), PH14 (2 Hz), PH15 (1 Hz). The ALM instruction is used to specify the combination. The higher frequency clock is the carrier of modulation output and the lower frequency clock is the envelope of the modulation output.

### **Notes:**

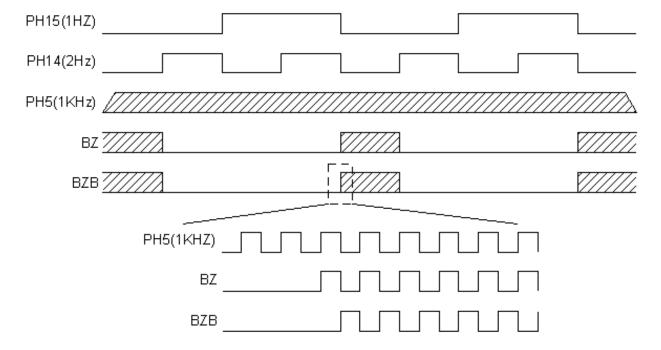
- 1. The high frequency clock source should only be one of PH3, PH4, PH5 or FREQ, and the lower frequency may be any/all of the combinations from PH10 ~ PH15.
- 2. The frequencies in () corresponding to the input clock of the pre-divider (PH0) is 32768 Hz.
- 3. The BZ and BZB pins will output DC0 after the initial reset.

#### **Example:**

Buzzer output generates a waveform with 1 KHz carrier and (PH15 + PH14) envelope.

LDS 20h, 0Ah
........
ALM 70h ; Output the waveform.

In this example, the BZ and BZB pins will generate the waveform as shown in the following figure:





#### 3.4.2 THE CARRIER FOR REMOTE CONTROL

If buzzer output combines with the timer and frequency generator, the output of the BZ pin may deliver the waveform for the IR remote controller. For remote control usage, the setting value of the frequency generator must be greater than or equal to 3, and the ALM instruction must be executed immediately after the FRQ related instructions in order to deliver the FREQ signal to the BZ pin as the carrier for IR remote controller.

#### Example:

SHE 1; Enable timer 1 halt release enable flag.

TMSX 3Fh; Set value for timer 1 is 3Fh and the clock source is PH9. SCC 40h; Set the clock source of the frequency generator as BCLK.

FRQX 2, 3; FREQ = BCLK / (4\*2), setting value for the frequency generator

; is 3 and duty cycle is 1/2.

ALM 1C0h; FREQ signal is output. This instruction must be executed

; after the FRQ related instructions.

HALT ; Wait for the halt release caused by timer 1.

; Halt released.

ALM 0; Stop the buzzer output.

#### 3.5 INPUT/OUTPUT PORTS

Four I/O ports are available in TM8725: IOA, IOB, IOC and IOD. Each I/O port is composed of 4 bits and has the same basic function. When the I/O pins are defined as non-IO function by mask option, the input/output function of the pins will be disabled.

## **3.5.1 IOA PORT**

IOA1 ~ IOA4 pins are MUXed with CX / SEG24, RR / SEG25, RT / SEG26 and RH / SEG27 pins respectively by mask option.

# MASK OPTION table:

Mask Option name	Selected item
SEG24/IOA1/CX	(2) IOA1
SEG25/IOA2/RR	(2) IOA2
SEG26/IOA3/RT	(2) IOA3
SEG27/IOA4/RH	(2) IOA4

In initial reset cycle, the IOA port is set as input mode and each bit of port can be defined as input mode or output mode individually by executing SPA instructions. Executing OPA instructions may output the content of specified data memory to the pins defined as output mode; the pins defined as the input mode will still remain the input mode. Executing IPA instructions may store the signals applied to the IO pins into the specified data memory. When the IO pins are defined as the output mode, executing IPA instruction will store the content that stored in the latch of the output pin into the specified data memory. Before executing SPA instruction to define the I/O pins as the output mode, the OPA instruction must be



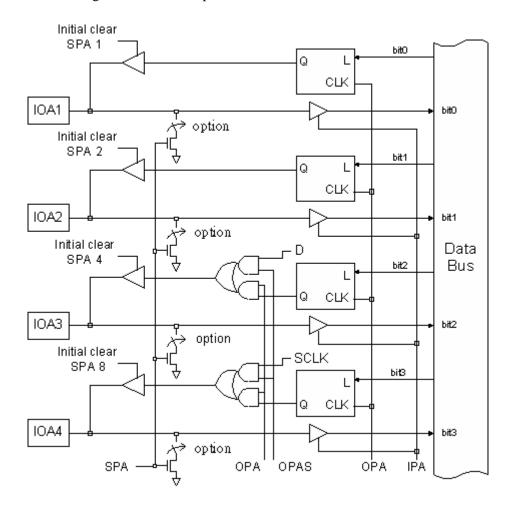
executed to output the data to those output latches beforehand. This will prevent the chattering signal on the I/O pin when the I/O mode changes.

IOA port has built-in pull-down resistor. The pull-low device for each pin is selected by mask option and executing SPA instruction to enable/disable this device.

# Pull-low function option:

Mask Option name	Selected item
IOA PULL LOW RESISTOR	(1) USE
IOA PULL LOW RESISTOR	(2) NO USE

This figure shows the organization of IOA port.



<u>Note:</u> If the input level is in the floating state, a large current (straight-through current) flows to the input buffer. The input level must not be in the floating state.

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# 3.5.1.1 Pseudo Serial Output

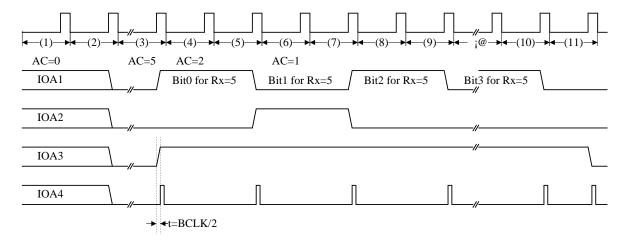
IOA port may operate as a pseudo serial output port by executing OPAS instruction. IOA port must be defined as the output mode before executing OPAS instruction.

- (1) BIT0 and BIT1 of the port deliver RAM data.
- (2) BIT2 of the port delivers the constant value of the OPAS.
- (3) BIT3 of the port delivers pulses.

Shown below is a sample program using the OPAS instruction.

0AH, 0 (1) LDS (2) OPA 0AH (**3**) SPA 0FH 1,5 LDS (4) OPAS 1,1 ;Bit 0 output, shift gate open (**5**) SR0 ;Shift bit 1 to bit 0 1 **(6)** OPAS 1,1 ;Bit 1 output (7) SR0 ;Shift bit2 to bit 0 1 (8) OPAS 1,1 ;Bit 2 output (9) SR0 1 ;Shift bit 3 to bit 0 (10) OPAS 1,1 ;Bit 3 output (11) OPAS 1,1 :Last data (12) OPAS 1,0 ;Shift gate closes

The timing chart below illustrates the above program.





If IOA1 pin is used as the CX pin for RFC function and the other pins (IOA2  $\sim$  IOA3) are used for normal IO pins, IOA1 pin must always be defined as the output mode to avoid the influence from the CX when the input chattering prevention function is active. On the other hand, the RFC counter can receive the signal changes on IOA1 when the RFC counter is enabled.

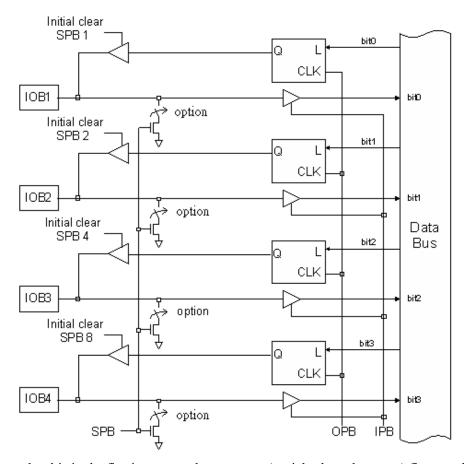
#### **3.5.2 IOB PORT**

IOB1~IOB4 pins are MUXed with ELC/SEG28, ELP/SEG29, BZB/SEG30 and BZ/SEG31 pins respectively by mask option.

# MASK OPTION table:

Mask Option name	Selected item
SEG28/IOB1/ELC	(2) IOB1
SEG29/IOB2/ELP	(2) IOB2
SEG30/IOB3/BZB	(2) IOB3
SEG31/IOB4/BZ	(2) IOB4

The following figure shows the organization of IOB port.



<u>Note:</u> If the input level is in the floating state, a large current (straight-through current) flows to the input buffer. The input level must not be in the floating state.

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After the reset cycle, the IOB port is set as input and each bit of port can be defined as input or output individually by executing SPB instructions. Executing OPB instructions may output the content of specified data memory to the pins defined as output mode; the other pins which are defined as the input will still be input.

Executed IPB instructions may store the signals applied on the IOB pins into the specified data memory. When the IOB pins are defined as the output, executing IPB instruction will save the data stored in the output latch into the specified data memory.

Before executing SPB instruction to define the I/O pins as output, the OPB instruction must be executed to output the data to the output latches. This will prevent the chattering signal on the I/O pin when the I/O mode changed.

IOB port has built-in pull-down resistor. The pull-low device for each pin is selected by mask option and executing SPB instruction to enable/disable this device.

# Pull-low function option:

Mask Option name	Selected item
IOB PULL LOW RESISTOR	(1) USE
IOB PULL LOW RESISTOR	(2) NO USE

#### **3.5.3 IOC PORT**

IOC1~IOC4 pins are MUXed with KI1/SEG32, KI2/SEG33, KI3/SEG34 and KI4/SEG35 pins respectively by mask option.

# MASK OPTION table:

Mask Option name	Selected item
SEG32/IOC1/KI1	(2) IOC1
SEG33/IOC2/KI2	(2) IOC2
SEG34/IOC3/KI3	(2) IOC3
SEG35/IOC4/KI4	(2) IOC4

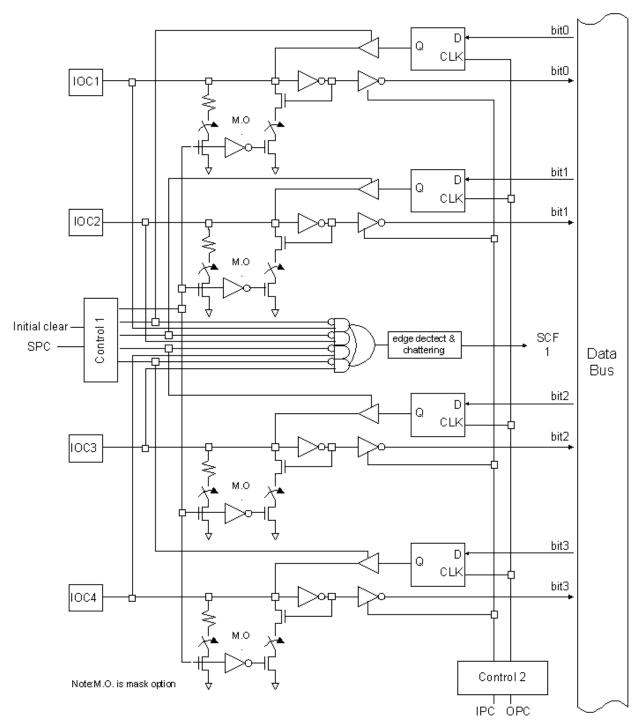
After the reset cycle, the IOC port is set as input mode and each bit of port can be defined as input mode or output mode individually by executing SPC instruction. Executed OPC instruction may output the content of specified data memory to the pins defined as output; the other pins which are defined as the input will still remain the input mode.

Executed IPC instructions may store the signals applied to the IOC pins in the specified data memory. When the IOC pins are defined as the output, executing IPC instruction will save the data stored in the output latches in the specified data memory.

Before executing SPC instruction to define the IOC pins as output, the OPC instruction must be executed to output the data to those output latches. This will prevent the chattering signal when the IOC pins change to output mode.

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This figure shows the organization of IOC port.

Note: If the input level is in the floating state, a large current (straight-through current) flows to the input buffer when both the pull low and L-level hold devices are disabled. The input level must not be in the floating state

IOC port may select the pull-low device or low-level hold device for each pin by mask option or enable/disable this device by program setting. When the pull-low device and low-level hold device are both enabled by mask option, the reset will enable the pull-low device and disable the low-level hold



device. Executing SPC 10h instruction may also enable the pull-low device and disable the low-level hold device, and executing SPC 0h may disable the pull-low device and enable the low-level hold device.

When the IOC pin has been defined as the output mode, both the pull-low and low-level hold devices will be disabled.

#### MASK OPTION table:

Pull-low function option

Mask Option name	Selected item
IOC PULL LOW RESISTOR	(1) USE
IOC PULL LOW RESISTOR	(2) NO USE

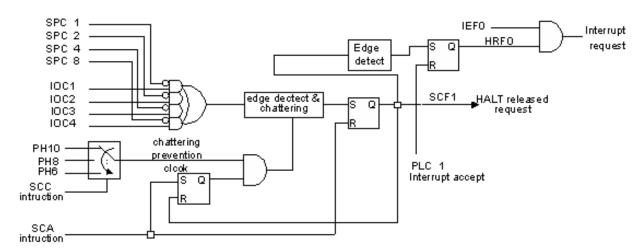
The low-level-hold function will not be available when pull-low function is not actived.

Low-level-hold function option

Mask Option name	Selected item
C PORT LOW LEVEL HOLD	(1) USE
C PORT LOW LEVEL HOLD	(2) NO USE

# 3.5.3.1 Chattering Prevention Function and Halt Release

The port IOC is capable of preventing high/low chattering of the switch signal applied on IOC1 to IOC4 pins. The chattering prevention time can be selected as PH10 (32 ms), PH8 (8 ms) or PH6 (2 ms) by executing SCC instruction, and the default selection is PH10 after the reset cycle. When the pins of the IOC port are defined as output, the signals applied to the output pins will be inhibited for the chattering prevention function. The following figure shows the organization of chattering prevention circuitry.



**Note:** The default prevention clock is PH10

This chattering prevention function works when the signal at the applicable pin (ex. IOC1) is changed from "L" level to "H" level or from "H" level to "L" level, and the remaining pins (ex, IOC2 to IOC4) are held at "L" level.

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When the signal changes at the input pins of IOC port specified by the SCA instruction occur and keep the state for at least two chattering clock (PH6, PH8, and PH10) cycles, the control circuit at the input pins will deliver the halt release request signal (SCF1). At that time, the chattering prevention clock will stop due to the delivery of SCF1. The SCF1 will be reset to 0 by executing SCA instruction and the chattering prevention clock will be enabled at the same time. If the SCF1 has been set to 1, the halt release request flag 0 (HRF0) will be delivered.

In this case, if the port IOC interrupt enable mode (IEF0) is provided, the interrupt is accepted. Since no flip-flop is available to hold the information of the signal at the input pins IOC1 to IOC4, the input data at the port IOC must be read into the RAM immediately after the halt mode is released.

# **3.5.4 IOD PORT**

IOD1~IOD4 pins are MUXed with SEG36, SEG37, SEG38 and SEG39 pins respectively by mask option.

#### MASK OPTION table:

Mask Option name	Selected item
SEG36/IOD1	(2) IOD1
SEG37/IOD2	(2) IOD2
SEG38/IOD3	(2) IOD3
SEG39/IOD4	(2) IOD4

After the reset cycle, the IOD port is set as input mode and each bit of port can be defined as input mode or output mode individually by executing SPD instruction. Executed OPD instruction may output the content of specified data memory to the pins defined as output; the other pins which are defined as the input will still remain the input mode.

Executed IPD instructions may store the signals applied to the IOD pins in the specified data memory. When the IOD pins are defined as the output, executing IPD instruction will save the data stored in the output latches in the specified data memory.

Before executing SPD instruction to define the IOD pins as output, the OPD instruction must be executed to output the data to those output latches. This will prevent the chattering signal when the IOD pins change to output mode.

IOD port has built in pull-low device for each pin and that is selected by mask option. Enable or disable this device by executing SPD instruction.

When the IOD pin has been defined as the output mode, the pull-low device will be disabled.

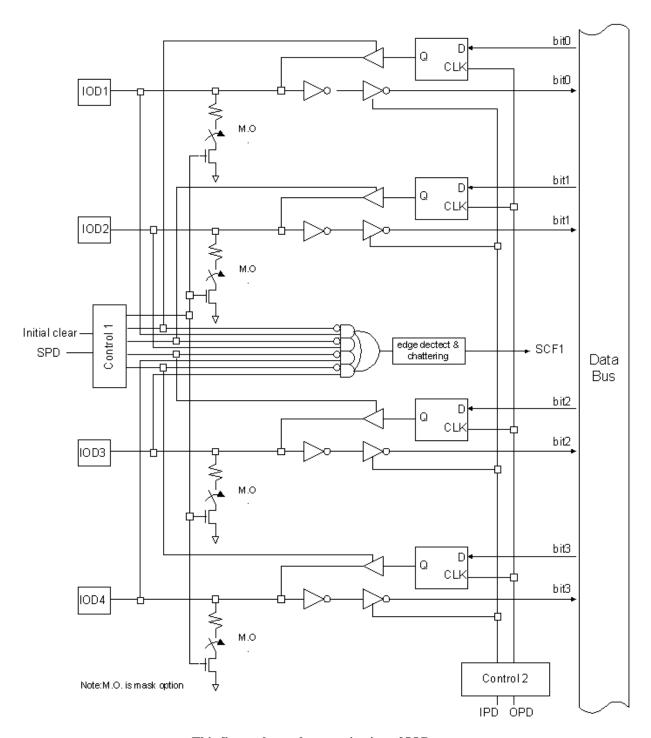
# MASK OPTION table:

Pull-low function option

Mask Option name	Selected item
IOC PULL LOW RESISTOR	(1) USE
IOC PULL LOW RESISTOR	(2) NO USE

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This figure shows the organization of IOD port.

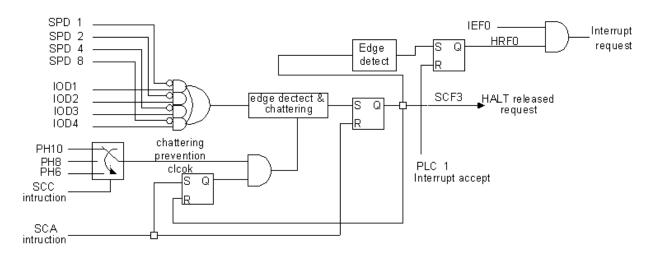
Note: If the input level is in the floating state, a large current (straight-through current) flows to the input buffer when both the pull low and L-level hold devices are disabled. The input level must not be in the floating state

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# 3.5.4.1 Chattering Prevention Function and Halt Release

The port IOD is capable of preventing high/low chattering of the switch signal applied on IOD1 to IOD4 pins. The chattering prevention time can be selected as PH10 (32 ms), PH8 (8 ms) or PH6 (2 ms) by executing SCC instruction, and the default selection is PH10 after the reset cycle. When the pins of the IOD port are defined as output, the signals applied to the output pins will be inhibited for the chattering prevention function. The following figure shows the organization of chattering prevention circuitry.



This figure shows the organization of chattering prevention circuitry.

# Note: The default prevention clock is PH10

This chattering prevention function works when the signal at the applicable pin (ex. IOD1) changes from "L" level to "H" level or from "H" level to "L" level, and the remaining pins (ex, IOD2 to IOD4) are held at "L" level.

When the signal changes at the input pins of IOD port specified by the SCA instruction occur and keep the state for at least two chattering clock (PH6, PH8, and PH10) cycles, the control circuit at the input pins will deliver the halt release request signal (SCF3). At that time, the chattering prevention clock will stop due to the delivery of SCF3. The SCF3 will be reset to 0 by executing SCA instruction and the chattering prevention clock will be enabled at the same time. If the SCF3 has been set to 1, the halt release request flag 0 (HRF0) will be delivered. In this case, if the port IOD interrupt enable mode (IEF0) is provided, the interrupt is accepted.

Since no flip-flop is available to hold the information of the signal at the input pins IOD1 to IOD4, the input data at the port IOD must be read into the RAM immediately after the halt mode is released.

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#### 3.6 EL PANEL DRIVER

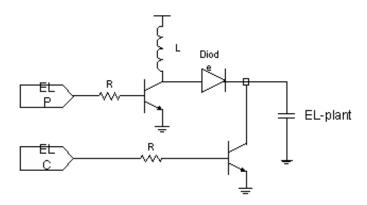
TM8725 provides an EL panel driver for the backlight of the LCD panel. The user can choose different voltage pumping frequencies, duty cycle and ON/OFF frequency to operate, with few external components. This circuitry could generate output voltage up to AC 150V or above for driving the EL-plant; the ELC and ELP output is MUXed with IOB1/SEG28 and IOB2/SEG29, and is selected by mask option.

#### MASK OPTION table:

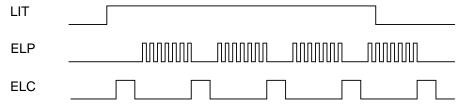
Mask Option name	Selected item
SEG28/IOB1/ELC	(3) ELC
SEG29/IOB2/ELP	(3) ELP

The ELP pin will output clocks to pump voltage to the EL-plant, the ELC pin will output the pulse to discharge the EL-plant. The EL-plant driver will not operate until the light control signal (LIT) is enabled. Once the light control signal (LIT) is enabled, the ELC pin will output a pulse to discharge the capacitor before the pumping clocks output to ELP pin. This will insure that there is no residual voltage that may cause damage while the first pumping clock is applied.

When the light control signal (LIT) is disabled, the ELC pin will output a pulse to discharge the EL-plant after the last pumping clock.



This figure shows the application circuit of EL-plant.



This figure shows the output waveform of EL-plant driver

Executing ELC instruction can change ELP/ELC pulse frequency and duty cycle. When ELC pin outputs the discharge pulse, the clock on ELP pin will be inhibited.

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# For ELP setting:

(X8, X7, X6)	Pumping clock frequency	(X5, X4)	Duty cycle
000	PH0	00	1/4 duty
100	BCLK	01	1/3 duty
101	BCLK/2	10	1/2 duty
110	BCLK/4	11	1/1 duty
111	BCLK/8		

# For ELC setting:

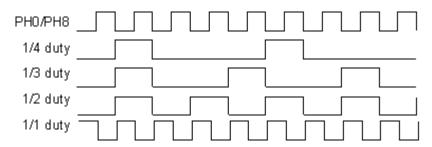
(X3, X2)	Discharge pulse frequency	(X1, X0)	Duty cycle
00	PH8	00	1/4 duty
01	PH7	01	1/3 duty
10	PH6	10	1/2 duty
11	PH5	11	1/1 duty

The default setting after the initial reset is:

ELP: PH0 clock of pre-divider and 1/4 duty cycle

ELC: PH8 clock of pre-divider and 1/4 duty cycle

The timing of the duty cycle is shown below:



# **Example:**

ELC	110h	;ELP outputs BCLK clock with 1/3 duty cycle and ELC outputs PH8 clock
		;with 1/4 duty cycle.
SF	4h	;Enables the light control signal (LIT) and turns on the EL-light driver.

RF 4h ;Disables the light control signal and turns off the EL-light driver.

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# 3.7 EXTERNAL INT PIN

The INT pin can be selected as pull-up or pull-down or open type by mask option. The signal change (either rising edge or falling edge by mask option) sets the interrupt flag, delivering the halt release request flag 2 (HRF2). In this case, if the halt release enable flag (HEF2) is provided, the start condition flag 2 is delivered. If the INT pin interrupt enable mode (IEF2) is provided, the interrupt is accepted.

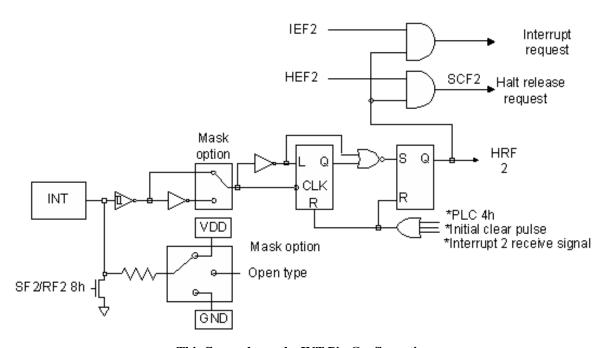
# MASK OPTION table:

For internal resistor type:

Mask Option name	Selected item
INT PIN INTERNAL RESISTOR	(1) PULL HIGH
INT PIN INTERNAL RESISTOR	(2) PULL LOW
INT PIN INTERNAL RESISTOR	(3) OPEN TYPE

# For input triggered type:

Mask Option name	Selected item
INT PIN TRIGGER MODE	(1) RISING EDGE
INT PIN TRIGGER MODE	(2) FALLING EDGE



This figure shows the INT Pin Configuration

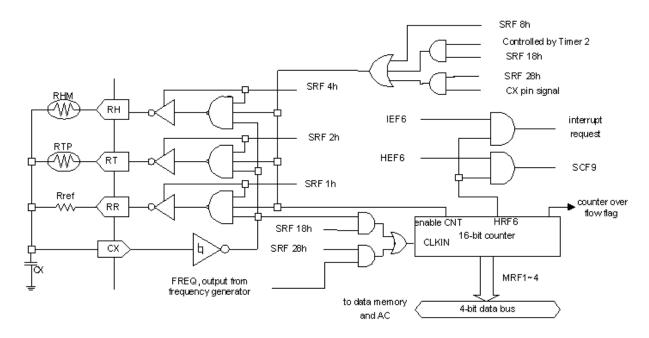
Note: For Ag battery power supply, positive power is connected to VDD1; for anything other than Ag battery power supply, it is connected to VDD2.

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# 3.8 RESISTOR TO FREQUENCY CONVERTER (RFC)

The resistor to frequency converter (RFC) can compare two different sensors with the reference resistor separately. This figure shows the block diagram of RFC.



This RFC contains four external pins:

CX: the oscillation Schmmit trigger input

RR: the reference resistor output pin

RT: the temperature sensor output pin

RH: the humidity sensor output pin (this can also be used as another temperature sensor or can even be left floating)

These CX, RR, RT and RH pins are MUXed with IOA1/SEG37 to IOA4/SEG40 respectively and selected by mask option.

# MASK OPTION table:

Mask Option name	Selected item
SEG24/IOA1/CX	(3) CX
SEG25/IOA2/RR	(3) RR
SEG26/IOA3/RT	(3) RT
SEG27/IOA4/RH	(3) RH

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#### 3.8.1 RC Oscillation Network

The RFC circuitry may build up 3 RC oscillation networks through RR, RT or RH and CX pins with external resistors. Only one RC oscillation network may be active at a time. When the oscillation network is built up (executing SRF 1h, SRF 2h, SRF 4h instructions to enable RR, RT, RH networks respectively), the clock will be generated by the oscillation network and transferred to the 16-bit counter through the CX pin. It will then enable or disable the 16-bit counter in order to count the oscillation clock.

Build up the RC oscillation network:

- 1. Connect the resistor and capacitor on the RR, RT, RH and CX pins. Fig. 2-24 illustrates the connection of these networks.
- **2.** Execute SRF 1h, SRF 2h, or SRF 4h instructions to activate the output pins for RC networks respectively. The RR, RT, RH pins will become of a tri-state type when these networks are disabled.
- **3.** Execute SRF 8, SRF 18h or SRF 28h instructions to enable the RC oscillation network and 16-bit counter. The RC oscillation network will not operate if these instructions have not been executed, and the RR, RT, RH pins output 0 state at this time.

To get a better oscillation clock from the CX pin, activate the output pin for each RC network before the counter is enabled. The RFC function provides 3 modes for the operation of the 16-bit counter. Each mode will be described in the following sections:

# 3.8.2 Enable/Disable the Counter by Software

The clock input of the 16-bit counter comes from the CX pin and is enabled/disabled by the S/W. When SRF 8h instruction is executed, the counter will be enabled and will start to count the signals on the CX pin. The counter will be disabled when SRF 0 instruction is executed. Executing MRF1  $\sim$  4 instructions may load the result of the counter into the specified data memory and AC.

Each time the 16-bit counter is enabled, the content of the counter will be cleared automatically.

#### **Example:**

If you intend to count the clock input from the CX pin for a specified time period, you can enable the counter by executing SRF 8 instruction and setting timer1 to control the time period. Check the overflow flag (RFOVF) of this counter when the time period elapses. If the overflow flag is not set to 1, read the content of the counter; if the overflow flag has been set to 1, you must reduce the time period and repeat the previous procedure again. In this example, use the RR network to generate the clock source.

;Timer 1 is used to enable/disable the counter

```
LDS
                0,0
                        ;set the TMR1 clock source (PH9)
       LDS
                1.3
                        ;initiate TMR1 setting value to 3F
       LDS
                2, 0Fh
                2
       SHE
                        ; enable halt release by TMR1
RE_CNT:
       LDA
                0
       OR*
                1
                        ;combine the TMR1 setting value
       TMS
                2
                        enable the TMR1
       SRF
                9
                        ;build up the RR network and enable the counter
       HALT
```

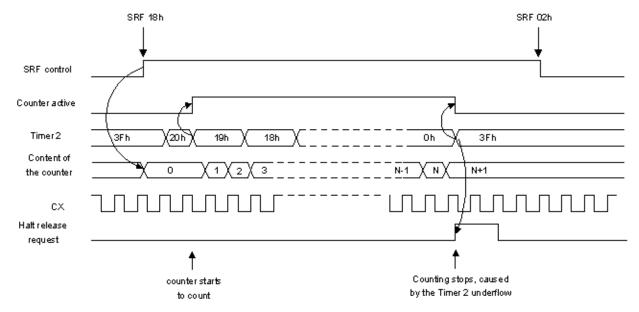


```
SRF
               1
                               ;stop the counter when TMR1 underflows
       MRF1
               10h
                               :read the content of the counter
       MRF2
               11h
       MRF3
               12h
       MRF4
               13h
       MSD
               20h
       JB2
               CNT1_OF
                                       ;check the overflow flag of counter
       JMP
               DATA ACCEPT
CNT1_OF:
       DEC*
                                       :decrease the TM1 value
               2
       LDS
               20h, 0
       SBC*
       JZ
               CHG_CLK_RANGE
                                       ;change the clock source of TMR1
       PLC
                                       ;clear the halt release request flag of TMR1
       JMP
               RE CNT
```

# 3.8.3 Enable/Disable the Counter by Timer 2

TMR2 will control the operation of the counter in this mode. When the counter is controlled by SRF 18 instruction, the counter will start to operate until TMR2 is enabled and the first falling edge of the clock source gets into TMR2. When the TMR2 underflow occurs, the counter will be disabled and will stop counting the CX clock at the same time. This mode can set an accurate time period with which to count the clock numbers on the CX pin. For a detailed description of the operation of TMR2, *please refer to 2-12*.

Each time the 16-bit counter is enabled, the content of the counter will be cleared automatically.



This figure shows the timing of the RFC counter controlled by timer 2



#### **Example:**

	;In this example,	use the RT net	twork to generate	the clock source.
--	-------------------	----------------	-------------------	-------------------

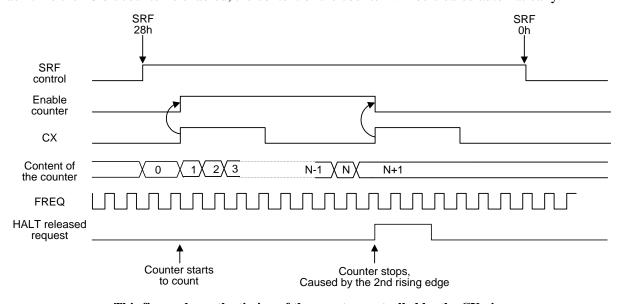
SRF	1Ah	;Build up the RT network and enable the counter ;controlled by TM2
SHE	10h	;enable the halt release caused by TM2
TM2X	20h	;set the PH9 as the clock source of TM2 and the down ;count value is 20h.
HALT		
PLC	10h	;Clear the halt release request flag of TM2
MRF1	10h	;read the content of the counter.
MRF2	11h	
MRF3	12h	
MRF4	13h	

# 3.8.4 Enable/Disable the Counter by CX Signal

This is another use for the 16-bit counter. In previous modes, CX is the clock source of the counter and the program must specify a time period by timer or subroutine to control the counter. In this mode, however, the counter has a different operation method. CX pin becomes the controlled signal to enable/disable the counter and the clock source of the counter comes from the output of the frequency generator (FREQ).

The counter will start to count the clock (FREQ) after the first rising edge signal applied on the CX pin when the counter is enabled. Once the second rising edge is applied to the CX pin after the counter is enabled, the halt release request (HRF6) will be delivered and the counter will stop counting. In this case, if the interrupt enable mode (IEF6) is provided, the interrupt is accepted; and if the halt release enable mode (HEF6) is provided, the halt release request signal is delivered, setting the start condition flag 9 (SCF9) in status register 4 (STS4).

Each time the 16-bit counter is enabled, the content of the counter will be cleared automatically.



This figure shows the timing of the counter controlled by the CX pin



# **Example:**

SCC	0h	;select the base clock of the frequency generator that comes
		; from PH0 (XT clock)
FRQX	1, 5	;set the frequency generator to FREQ = $(PH0/3)/5$
		; the setting value of the frequency generator is 5 and FREQ $$
		;has 1/3 duty waveform.
SHE	40h	;enable the halt release caused by 16-bit counter
SRF	28h	;enable the counter controlled by the CX signal
HALT		
PLC	40h	;halt release is caused by the 2 <sup>nd</sup> rising edge on CX pin and
		;then clear the halt release request flag
MRF1	10h	;read the content of the counter
MRF2	11h	
MRF3	12h	
MRF4	13h	

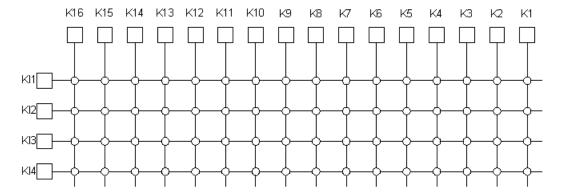
# 3.9 KEY MATRIX SCANNING

TM8725 shared the timing of LCD waveform to scan the key matrix circuitry and these scanning output pins are SEG1 $\sim$ 16 (for easy to understand, named these pins as K1  $\sim$  K16). The time sharing of LCD waveform will not affect the display of LCD panel. The input port of key matrix circuitry is composed by KI1  $\sim$  KI4 pins (these pins are muxed with SEG32  $\sim$  SEG35 pins and selected by mask option).

# MASK OPTION table:

Mask Option name	Selected item
SEG32/IOC1/KI1	(3) KI1
SEG33/IOC2/KI2	(3) KI2
SEG34/IOC3/KI3	(3) KI3
SEG35/IOC4/KI4	(3) KI4

The typical application circuit of key matrix scanning is shown below:



Executing SPKX X, SPK Rx and SPK @HL instructions could set the scanning type of key matrix.



The bit pattern of these 3 instructions is shown below:

Instruction	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
SPKX X	X7	X6	X5	X4	X3	X2	X1	X0
SPK Rx	AC3	AC2	AC1	AC0	Rx3	Rx2	Rx1	Rx0
SPK @HL	T@HL7	T@HL6	T@HL5	T@HL4	T@HL3	T@HL2	T@HL1	T@HL0

The following description shows the bit definitions in the operand of SPKX instruction.

- $X_6$  = "0", when HEF5 is set to 1, the HALT released request (HRF5) will be set to 1 after the key depressed on the key matrix and then set SCF7 to 1.
  - "1", when HEF5 is set to 1, the HALT released request (HRF5) will be set to 1 after each scanning cycle no matter the key is depressed or not and then set SCF7 to 1.
- $X_7X_5X_4 = 000$ , in this setting, each scanning cycle only check one specified column (K1 ~ K16) on key matrix. The specified column is defined by the setting of  $X_3 \sim X_0$ .

 $X_3 \sim X_0 = 0000$ , active K1 column

 $X_3 \sim X_0 = 0001$ , active K2 column

.....

 $X_3 \sim X_0 = 1110$ , active K15 column

 $X_3 \sim X_0 = 1111$ , active K16 column

- $X_7X_5X_4 = 001$ , in this setting, all of the matrix columns (K1 ~ K16) will be checked simultaneously in each scanning cycle.  $X_3 \sim X_0$  don't care.
- $X_7X_5X_4 = 010$ , in this setting, the key matrix scanning function will be disable.  $X_3 \sim X_0$  don't care.
- $X_7X_5X_4 = 10X$ , in this setting, each scanning cycle check 8 specified columns on key matrix. The specified column is defined by the setting of  $X_3$ .

X3 = 0, active K1 ~ K8 columns simultaneously

X3 = 1, active  $K9 \sim K16$  columns simultaneously

X2 ~ X0 don't care.

 $X_7X_5X_4 = 110$ , in this setting, each scanning cycle check four specified columns on key matrix. The specified columns are defined by the setting of  $X_3$  and  $X_2$ .

X3X2 = 00, active K1 ~ K4 columns simultaneously

X3X2 = 01, active K5 ~ K8 columns simultaneously

X3X2 = 10, active K9 ~ K12 columns simultaneously

X3X2 = 11, active K13 ~ K16 columns simultaneously

X1, X0 don't care.

 $X_7X_5X_4 = 111$ , in this setting, each scanning cycle check two specified columns on key matrix. The specified columns are defined by the setting of  $X_3$ ,  $X_2$  and  $X_1$ .

X3X2X1 = 000, active K1 ~ K2 columns simultaneously

X3X2X1 = 001, active  $K3 \sim K4$  columns simultaneously

.....

X3X2X1 = 110, active  $K13 \sim K14$  columns simultaneously

X3X2X1 = 111, active K15 ~ K16 columns simultaneously

X0 don't care.

When KI1~4 is defined for Key matrix scanning input by mask option, it is necessary to execute SPC instruction to set the internal unused IOC port as output mode before the key matrix scanning function is active. Fig 2-27 shows the organization of Key matrix scanning input port. Each one of SKI1~4 change



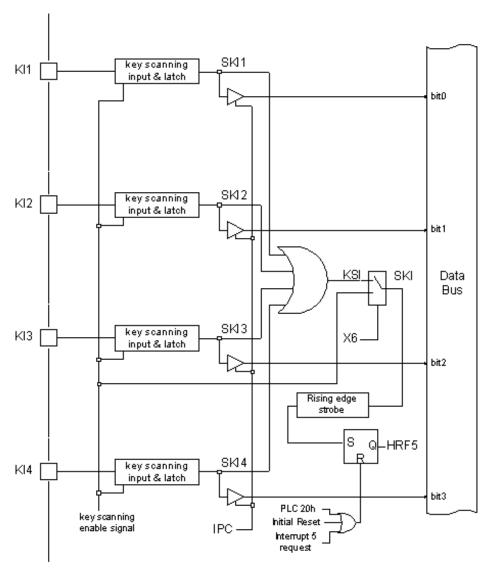
to "High" will set HRF5 to 1. If HEF5 has been set to 1 beforehand, this will cause SCF7 to be set and release the HALT mode. After the key scanning cycle, the states of SKI1 ~ 4 will be latched and executing IPC instruction could store these states into data RAM. Execute PLC 20h instruction to clear HRF5 flag.

Since the key matrix scanning function shares the timing of LCD waveform, so the scanning frequency is corresponding to LCD frame frequency and LCD duty cycle. The formula for key matrix scanning frequency is shown below:

Key matrix scanning frequency (Hz) = (LCD frame frequency) x (LCD duty cycle) x 2

Note: "2" is a factor

For example, if the LCD frame frequency is 32 Hz, and duty cycle is 1/5 duty, the scanning frequency for key matrix is: 320 Hz (32 x 5 x 2).



This figure shows the organization of Key matrix scanning input

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# Example:

	SPC	Ofh	; Disable all the pull-down device on internal IOC port.
	CDIZX	1.01.	; Set all of the IOC pins as output mode.
	SPKX	10h	; Generate HALT released request when key depressed
	DI C	201	; Scanning all columns simultaneous in each cycle.
	PLC	20h	; Clear HRF5
	SHE	20h	; Set HEF5.
	HALT	1.01	; Wait for the halt release caused by key matrix.
	MCX	10h	; Check SCF8 (SKI).
	JB0	ski_release	
		••	
1. 1		•	
ski_rele		1.01	D 1771 41 (1.1)
	IPC	10h	; Read KI1~4 input latch state.
	JB0	ki1_release	
	JB1	ki2_release	
	JB2	ki3_release	
	JB3	ki4_release	
	•		
ki1_rel			
	SPKX	40h	; Check key depressed on K1 column.
	PLC	20h	; Clear HRF5 to avoid the false HALT released
	CALL	wait_scan_again	; Waiting for the next key matrix scanning cycle.
			; The waiting period must longer than key matrix scanning cycle.
	IPC	10h	; Read KI1 input latch state.
	JB0	ki1_seg1	
		••	
	SPK	4fh	; Only enable SEG16 scanning output.
	PLC	20h	; Clear HRF5 to avoid the false HALT released
	CALL	wait_scan_again	; Wait for time over halt LCD clock cycle to sure
	;scan aga	in.	
	IPC	10h	; Read KI1 input latch state.
	JB0	kil_seg16	
wait_sc	an_again:		
	HALT		
	PLC	20h	
	RTS		



# 4. LCD DRIVER OUTPUT

The number of the LCD driver outputs in TM8725 is 40 segment pins with 6 common pins. All of these output pins can also be used as DC output ports (mask option). If more than one of LCD driver output pin is defined as DC output, the following mask option must be selected.

#### MASK OPTION table:

When more than one of SEG or COM pins has been used to drive LCD panel

Mask Option name	Selected item	
LCD ACTIVE TYPE	(1) LCD	

When all of SEG and COM5, 6 pins have been used for DC output port:

Mask Option name	Selected item
LCD ACTIVE TYPE	(2) O/P

During the initial reset cycle, all of LCD's lighting system may be lighted or unlighted by mask option. All of the LCD output will keep the initial setting until the LCD relative instructions are executed to change the output data.

#### MASK OPTION table:

Mask Option name	Selected item
LCD DISPLAY IN RESET CYCLE	(1) ON
LCD DISPLAY IN RESET CYCLE	(2) OFF

#### 4.1 LCD LIGHTING SYSTEM IN TM8725

There are several LCD lighting systems could be selected by mask option in TM8725, they are: 1/2 bias 1/2 duty, 1/2 bias 1/3 duty, 1/2 bias 1/4 duty, 1/2 bias 1/5 duty, 1/2 bias 1/6 duty, 1/3 bias 1/3 duty, 1/3 bias 1/4 duty, 1/3 bias 1/5 duty, 1/3 bias 1/6 duty, 1/3 bias 1/7 duty, All of these lighting systems are combined with 2 kinds of mask options, the one is "LCD DUTY CYCLE" and the other is "BIAS".

# MASK OPTION table:

# LCD duty cycle option

Mask Option Name	Selected Item
LCD DUTY CYCLE	(1) O/P
LCD DUTY CYCLE	(2) DUPLEX (note: 1/2 duty)
LCD DUTY CYCLE	(3) 1/3 DUTY
LCD DUTY CYCLE	(4) 1/4 DUTY
LCD DUTY CYCLE	(5) 1/5 DUTY
LCD DUTY CYCLE	(6) 1/6 DUTY
LCD DUTY CYCLE	(7) 1/7 DUTY
LCD DUTY CYCLE	(8) 1/8 DUTY

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# LCD bias option

Mask Option name	Selected item
BIAS	(1) NO BIAS
BIAS	(2) 1/2 BIAS
BIAS	(3) 1/3 BIAS

The frame frequency for each lighting system is shown below; these frequencies could be selected by mask option (All of the LCD frame frequencies in the following tables based on the clock source frequency of the pre-divider (PH0) is 32768 Hz).

The LCD alternating frequency in duplex (1/2 duty) type

Mask Option name	Selected item	Remark (alternating frequency)
LCD frame frequency	(1) SLOW	16 Hz
LCD frame frequency	(2) TYPICAL	32 Hz
LCD frame frequency	(2) FAST	64 Hz
LCD frame frequency	(2) O/P	0 Hz (LCD not used)

The LCD alternating frequency in 1/3 duty type

Mask Option name	Selected item	Remark (alternating frequency)
LCD frame frequency	(1) SLOW	21 Hz
LCD frame frequency	(2) TYPICAL	42 Hz
LCD frame frequency	(2) FAST	85 Hz
LCD frame frequency	(2) O/P	0 Hz (LCD not used)

The LCD alternating frequency in 1/4 duty type

Mask Option name	Selected item	Remark (alternating frequency)
LCD frame frequency	(1) SLOW	16 Hz
LCD frame frequency	(2) TYPICAL	32 Hz
LCD frame frequency	(2) FAST	64 Hz
LCD frame frequency	(2) O/P	0 Hz (LCD not used)

The LCD alternating frequency in 1/5 duty type

Mask Option name	Selected item	Remark (alternating frequency)
LCD frame frequency	(1) SLOW	25 Hz
LCD frame frequency	(2) TYPICAL	51 Hz
LCD frame frequency	(2) FAST	102 Hz
LCD frame frequency	(2) O/P	0 Hz (LCD not used)

The LCD alternating frequency in 1/6 duty type

Mask Option name	Selected item	Remark (alternating frequency)
LCD frame frequency	(1) SLOW	21 Hz
LCD frame frequency	(2) TYPICAL	42 Hz
LCD frame frequency	(2) FAST	85 Hz
LCD frame frequency	(2) O/P	0 Hz (LCD not used)

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The following table shows the relationship between the LCD lighting system and the maximum number of driving LCD segments.

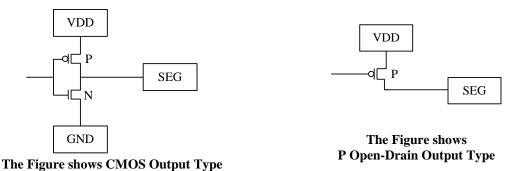
LCD Lighting System	Maximum Number of Driving LCD Segments	Remarks
Duplex (1/2 bias,1/2 duty)	82	Connect VDD3 to VDD2
1/2 bias 1/3 duty	123	Connect VDD3 to VDD2
1/2 bias 1/4 duty	164	Connect VDD3 to VDD2
1/2 bias 1/5 duty	205	Connect VDD3 to VDD2
1/2 bias 1/6 duty	246	Connect VDD3 to VDD2
1/3 bias 1/3 duty	123	
1/3 bias 1/4 duty	164	
1/3 bias 1/5 duty	205	
1/3 bias 1/6 duty	246	

When choosing the LCD frame frequency, it is recommended to choice the frequency that higher than 24 Hz. If the frame frequency is lower than 24 Hz, the pattern on the LCD panel will start to flash.

# 4.2 DC OUTPUT

TM8725 permits LCD driver output pins (COM5 ~ COM6 and SEG1 ~ SEG40) to be defined as CMOS type DC output or P open-drain DC output ports by mask option. In this case, it is possible to use some LCD driver output pins for DC output and the rest LCD driver output pins for LCD driver. *Refer to 4-3-4*.

The configurations of CMOS output type and P open-drain type are shown below. When the LCD driver output pins (SEG) are defined as DC output, the output data on this port will not be affected while the program entered stop mode or LCD turn-off mode.



Only unused COM and SEG pad can be defined as DC output pin. The COM pad sequence for LCD driver cannot be interrupted when defined the COM pads as the DC output port. For example, when the LCD lighting system is specified as 1/5 duty, the used COM pad for LCD driver must be COM1 ~ COM5. Only COM6 pad could be defined as DC output port, *refer to section 4-3-4*.

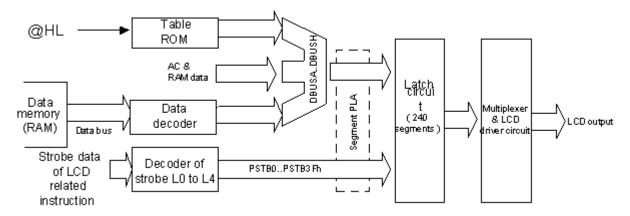
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# 4.3 SEGMENT PLA CIRCUIT FOR LCD DISPLAY

# 4.3.1 PRINCIPLE OF OPERATION OF LCD DRIVER SECTION

Explained below is how the LCD driver section operates when the instructions are executed.



This Figure shows Principal Drawing of LCD Driver Section

The LCD driver section consists of the following units:

- Data decoder to decode data supplied from RAM or table ROM
- Latch circuit to store LCD lighting information
- L0 to L4 decoder to decode the Lz-specified data in the LCD-related instructions which specifies the strobe of the latch circuit
- Multiplexer to select 1/2 duty, 1/3 duty, 1/4 duty, 1/5 duty, 1/6 duty
- LCD driver circuitry
- Segment PLA circuit connected between data decoder, L0 to L4 decoder and latch circuit.

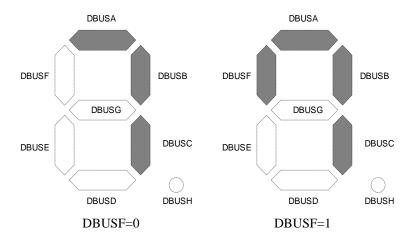
The data decoder is used for decoding the content of the working register specified in LCD-related instructions as 7-segment pattern on LCD panel. The decoding table is shown below:

Content of data	Output of data decoder							
memory	DBUSA	DBUSB	DBUSC	DBUSD	DBUSE	DBUSF	DBUSG	DBUSH
0	1	1	1	1	1	1	0	1
1	0	1	1	0	0	0	0	1
2	1	1	0	1	1	0	1	1
3	1	1	1	1	0	0	1	1
4	0	1	1	0	0	1	1	1
5	1	0	1	1	0	1	1	1
6	1	0	1	1	1	1	1	1
7	1	1	1	0	0	*note	0	1
8	1	1	1	1	1	1	1	1
9	1	1	1	1	0	1	1	1
A-F	0	0	0	0	0	0	0	0

Note: The DBUSF of decoded output can be selected as 0 or 1 by mask option.



The LCD pattern of this option is shown below:



The following table shows the option table for displaying digit "7" pattern:

#### MASK OPTION table:

Mask Option name	Selected item
F SEGMENT FOR DISPLAY "7"	(1) ON
F SEGMENT FOR DISPLAY "7"	(2) OFF

Both LCT and LCB instructions use the data-decoder table to decode the content of data memory that is specified. When the content of data memory that is specified by LCB instruction is "0", the decoded output of DBUSA ~ DBUSH are all "0" (this is used for blanking the leading digit "0" on LCD panel).

The LCP instruction transferred the data of the RAM (Rx) and accumulator (AC) directly from "DBUSA" to "DBUSH" without passing through the data decoder.

The LCD instruction transfers the table ROM data (T@HL) directly from "DBUSA" to "DBUSH" without passing through the data decoder.

*Table 4-3-1-1 The mapping table of LCP and LCD instructions* 

	DBUSA	DBUSB	DBUSC	DBUSD	DBUSE	DBUSF	DBUSG	DBUSH
LCP	Rx0	Rx1	Rx2	Rx3	AC0	AC1	AC2	AC3
LCD	T@HL0	T@HL1	T@HL2	T@HL3	T@HL4	T@HL5	T@HL6	T@HL7

There are 8 data decoder outputs of "DBUSA" to "DBUSH" and 32 L0 to L4 decoder outputs of PSTB 0h to PSTB 3Fh. The input data and clock signal of the latch circuit are "DBUSA" to "DBUSH" and PSTB 0h to PSTB 1Fh, respectively. Each segment pin has 8 latches corresponding to COM1-8.

The segment PLA performs the function of combining "DBUSA" to "DBUSH" inputs to each latch and strobe PSTB 0h to PSTB3Fh is selected freely by mask option.

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Of 512 signals obtainable by combining "DBUSA" to "DBUSH" and PSTB 0h to PSTB 3Fh, any 320 (corresponding to the number of latch circuits incorporated in the hardware) signals can be selected by programming and the above-mentioned segment PLA. Table 4-3-1-2 shows the PSTB 0h to PSTB 3Fh signals concretely.

Table 4-3-1-2 Strobe Signal for LCD Latch in Segment PLA and Strobe in LCT Instruction:

strobe signal for LCD latch	Strobe in LCT, LCB, LCP, LCD instructions The values of Lz in "LCT Lz, Q": *
PSTB0	ОН
PSTB1	1H
PSTB2	2Н
PSTB3	3Н
PSTB4	4H
PSTB5	5H
PSTB1Ah	1AH
PSTB1Bh	1BH
PSTB1Ch	1CH
PSTB1Dh	1DH
PSTB1Eh	1EH
PSTB1Fh	1FH

<u>Note:</u> The values of Q are the addresses of the working register in the data memory (RAM). In the LCD instruction, O is the index address in the table ROM.

The LCD outputs could be turned off without changing the segment data. Executed SF2 4h instruction could turn off the display simultaneously and executed RF2 4h could turn on the display with the patterns before turned off. These two instructions will not affect the content stored in the latch circuitry. When the LCD is turned off by executing RF2 4h instruction, the program could still execute LCT, LCB, LCP and LCD instructions to update the content in the latch circuitry and the new content will be output to the LCD while the display is turned on again. In stop state, all COM and SEG outputs of LCD driver will automatically switch to the GND state to avoid the DC voltage bias on the LCD panel.

#### 4.3.2 Relative Instructions

# 1. LCT Lz, Ry

Decodes the content specified in Ry with the data decoder and transfers the DBUSA  $\sim$  H to LCD latch specified by Lz.

# 2. LCB Lz, Ry

Decodes the content specified in Ry with the data decoder and transfers the DBUSA ~ H to LCD latch specified by Lz. The "DBUSA" to "DBUSH" are all 0 when the input data of the data decoder is 0.

#### 3. LCD Lz, @HL

Transfers the table ROM data specified by @HL directly to "DBUSA" to "DBUSH" without passing through the data decoder. The mapping table is shown in table 2-32.



# 4. LCP Lz, Ry

The data of the RAM and accumulator (AC) are transferred directly to "DBUSA" to "DBUSH" without passing through the data decoder. The mapping table is shown below:

#### 5. LCT Lz, @HL

Decodes the index RAM data specified in @HL with the data decoder and transfers the DBUSA ~ H to LCD latch specified by Lz.

# 6. LCB Lz, @HL

Decodes the index RAM data specified in @HL with the data decoder and transfers the DBUSA ~ H to LCD latch specified by Lz. The "DBUSA" to "DBUSH" are all 0 when the input data of the data decoder is 0.

# 7. LCP Lz, @HL

The data of the index RAM and accumulator (AC) are transferred directly to "DBUSA" to "DBUSH" without passing through the data decoder. The mapping table is shown below:

Table 4-3-2-1 The mapping table of LCP and LCD instructions

	DBUSA	DBUSB	DBUSC	DBUSD	DBUSE	DBUSF	DBUSG	DBUSH
LCP	Rx0	Rx1	Rx2	Rx3	AC0	AC1	AC2	AC3
LCD	T@HL0	T@HL1	T@HL2	T@HL3	T@HL4	T@HL5	T@HL6	T@HL7

#### 8. SF2 4h

Turns off the LCD display.

#### **9.** RF2 4h

Turns on the LCD display.

# 4.3.3 CONCRETE EXPLANATION

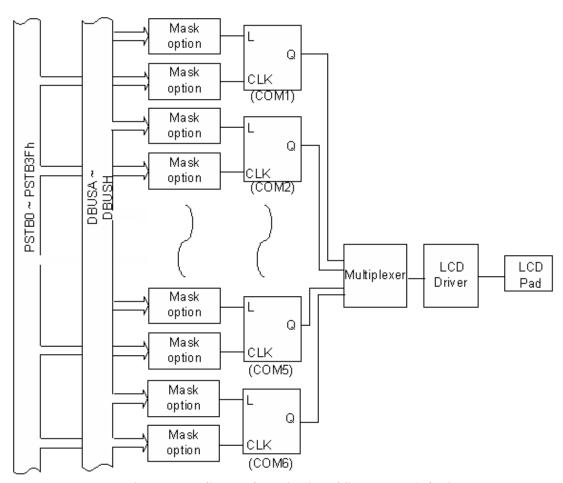
Each LCD driver output corresponds to the LCD 1/6 duty panel and has 6 latches (refer to The Figure shows Sample Organization of Segment PLA Option). Since the latch input and the signal to be applied to the clock (strobe) are selected with the segment PLA, the combination of the segments in the LCD driver outputs is flexible. In other words, one of the data decoder outputs "DBUSA" to "DBUSH" is applied to the latch input L, and one of the PSTB0 to PSTB3Fh outputs are applied to clock CLK.

TM8725 provides a flash type instruction to update the LCD pattern. When LCTX D, LCBX D, LCPX D and LCDX D instruction are executed, the pattern of DBUS will be output to 16 latches (Lz) specified by D simultaneously.

D	Specified range of latched
0	$Lz = 00h \sim 0Fh$
1	$Lz = 10h \sim 1Fh$



Refer to Chapter 5 for detail description of these instructions.



The Figure shows Sample Organization of Segment PLA Option

# 4.3.4 THE CONFIGURATION FILE FOR MASK OPTION

When configuring the mask option of LCD PLA, the \*.cfg file provides the necessary format for editing the LCD configuration.

The syntax in \*.cfg file is as follows:

#### SEG COM PSTB DBUS

SEG: Specifies the segment pin No.

"1" ~ "40" represents segment pin No., "C1" ~ "C6" represents common pin No.

When the common pin (COM) is specified as DC output pin, assigned "C1"  $\sim$  "C6" in this column. "C1"  $\sim$  "C6" represents COM1  $\sim$  COM6 respectively.

COM: Specifies the corresponding latch in each segment pin. Only 0, 1, 2, 3, 4, 5, 6 can be specified in this column. "1"  $\sim$  "6" represents COM1 latch  $\sim$  COM6 latch respectively. "0" is for CMOS type DC output option and "10" is for P open-drain DC output option.

PSTB: Specifies the strobe data for the latch. DBUS: Specifies the DBUS data for the latch.

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# 5. Detail Explanation of TM8725 Instructions

- It is necessary to initialize the content of data memory after initial reset, because the initial content of the data memory is unknown.
- The working registers are part of the data memory (RAM), and the relationship between them is shown as follows:

[The absolute address of working register Rx=Ry+70H]\*

Address of working registers specified by Ry	Absolute address of data memory (Rx)
0Н	70H
1H	71H
2H	72H
·	•
·	•
•	•
DH	7DH
EH	7EH
FH	7FH

• Lz represents the address of the latch of LCD PLA (PSTB data in \*.cfy file); the address range specified by Lz is from 00H to 1FH.

# 5.1 INPUT/OUTPUT INSTRUCTIONS

LCT Lz, Ry

Function: LCD latch [Lz]  $\leftarrow$  data decoder  $\leftarrow$  [Ry]

Description: The working register contents specified by Ry are loaded to the LCD latch

specified by Lz through the data decoder.

Lz:  $00 \sim 1$ FH, Ry:  $0 \sim F$ H.

LCB Lz, Ry

Function: LCD latch  $[Lz] \leftarrow$  data decoder  $\leftarrow [Ry]$ 

The working register contents specified by Ry are loaded to the LCD latch Description:

specified by Lz through the data decoder.

If the content of Ry is "0", the outputs of the data decoder are all "0".

 $Lz:00 \sim 1FH, Ry:0 \sim FH.$ 

LCP Lz, Ry

Function: LCD latch  $[Lz] \leftarrow [Ry]$ , AC

Description: The working register contents specified by Ry and the contents of AC are loaded

> to the LCD latch specified by Lz.  $Lz : 00 \sim 1FH, Ry : 0 \sim FH.$

Table 4-2 The mapping table of LCD latches with the contents of AC and Ry.

	DBUSA	DBUSB	DBUSC	DBUSD	DBUSE	DBUSF	DBUSG	DBUSH
LCP	Rx0	Rx1	Rx2	Rx3	AC0	AC1	AC2	AC3
LCD	T@HL0	T@HL1	T@HL2	T@HL3	T@HL4	T@HL5	T@HL6	T@HL7



LCD Lz, @HL

Function: LCD latch  $[Lz] \leftarrow TAB[@HL]$ 

Description: @HL indicates an index address of table ROM.

The contents of table ROM specified by @HL are loaded to the LCD latch

specified by Lz directly. Refer to Table 4-2.

Lz: 00 ~ 1FH.

LCT Lz, @HL

Function: LCD latch  $[Lz] \leftarrow$  data decoder  $\leftarrow [@HL]$ 

Description: The contents of index RAM specified by @HL are loaded to the LCD latch

specified by Lz through the data decoder. Refer to Table 4-2.

Lz: 00 ~ 1FH.

LCB Lz, @HL

Function: LCD latch [Lz]  $\leftarrow$  data decoder  $\leftarrow$  [@HL]

Description: The contents of index RAM specified by @HL are loaded to the LCD latch

specified by Lz through the data decoder. Refer to Table 4-2.

If the content of @HL is "0", the outputs of the data decoder are all "0".

Lz: 00 ~ 1FH.

LCP Lz, @HL

Function: LCD latch  $[Lz] \leftarrow [@HL]$ , AC

Description: The contents of index RAM specified by @HL and the contents of AC are

loaded to the LCD latch specified by Lz. Refer to Table 4-2.

Lz: 00 ~ 1FH.

LCDX D

Function: Mullti-LCD latches  $[Lz(s)] \leftarrow TAB[@HL]$ 

Description: @HL indicates an index address of table ROM.

The content of table ROM specified by @HL is loaded to several LCD latches (Lz) simultaneously. Refer to Table 4-2. The range of multi-Lz is specified by

data "D". D: 0 ~ 1.

Table shows The range of multi-Lz latches

D=0	Multi-Lz=00H~0FH
D=1	Multi-Lz=10H~1FH

LCTX D

Function: Mullti-LCD latch [Lz]  $\leftarrow$  data decoder  $\leftarrow$  [@HL]

Description: The contents of index RAM specified by @HL are loaded to several LCD

latches (Lz) simultaneously. The range of multi-Lz is specified by data "D".

Refer to Tabel 4-3.

D:  $0 \sim 1$ .

LCBX D

Function: Mullti- LCD latch [Lz]  $\leftarrow$  data decoder  $\leftarrow$  [@HL]

Description: The contents of index RAM specified by @HL are loaded to the LCD latch

specified by Lz through the data decoder. The range of multi-Lz is specified by

data "D". Refer to Table 4-3.

D:  $0 \sim 1$ .



LCPX D

Function: Mullti- LCD latch [Lz]  $\leftarrow$  [@HL],AC

Description: The contents of index RAM specified by @HL and the contents of AC are

loaded to several LCD latches (Lz) simultaneously. Refer to Table 4-2. The

range of multi-Lz is specified by data "D". Refer to Table 4-3.

D:  $0 \sim 1$ .

SPA X

Function: Defines the input/output mode of each pin for IOA port and enables/disables the

pull-low device.

Description: Sets the I/O mode and turns on/off the pull-low device. The meaning of each bit

of X(X4, X3, X2, X1, and X0) is shown below:

Bit pattern	Setting	Bit pattern	Setting
X4=1	Enable the pull-low device on IOA1~IOA4 simultaneously	X4=0	Disable the pull-low device on IOA1~IOA4 simultaneously
X3=1	IOA4 as output mode	X3=0	IOA4 as input mode
X2=1	IOA3 as output mode	X2=0	IOA3 as input mode
X1=1	IOA2 as output mode	X1=0	IOA2 as input mode
X0=1	IOA1 as output mode	X0=0	IOA1 as input mode

OPA Rx

Function:  $I/OA \leftarrow [Rx]$ 

Description: The content of Rx is output to I/OA port.

OPAS Rx, D

Function: IOA1,2  $\leftarrow$  [Rx], IOA3  $\leftarrow$  D, IOA4  $\leftarrow$  pulse

Description: Content of Rx is output to IOA port. D is output to IOA3, pulse is output to

IOA4. D = 0 or 1

IPA Rx

Function:  $[Rx], AC \leftarrow [I/OA]$ 

Description: The data of I/OA port are loaded to AC and data memory Rx.

SPB X

Function: Defines the input/output mode of each pin for IOB port and enables/disables the

pull-low device.

Description: Sets the I/O mode and turns on/off the pull-low device. The meaning of each bit

of X(X4, X3, X2, X1, X0) is shown below:

Bit pattern	Setting	Bit pattern	Setting
X4=1	Enable the pull-low device on IOB1~IOB4 simultaneously	X4=0	Disable the pull-low device on IOB1~IOB4 simultaneously
X3=1	IOB4 as output mode	X3=0	IOB4 as input mode
X2=1	IOB3 as output mode	X2=0	IOB3 as input mode
X1=1	IOB2 as output mode	X1=0	IOB2 as input mode
X0=1	IOB1 as output mode	X0=0	IOB1 as input mode



OPB Rx

Function:  $I/OB \leftarrow [Rx]$ 

Description: The contents of Rx are output to I/OB port.

IPB Rx

Function:  $[Rx],AC \leftarrow [I/OB]$ 

Description: The data of I/OB port are loaded to AC and data memory Rx.

SPC X

Function: Defines the input/output mode of each pin for IOC port and enables/disables the

pull-low device or low-level hold device.

Description: The meaning of each bit of X(X4, X3, X2, X1, and X0) is shown below:

Bit pattern	Setting	Bit pattern	Setting
X4=1	Enable all of the pull-low and disables the low-level hold devices	X4=0	Disable all of the pull-low and enables the low-level hold devices
X3=1	IOC4 as output mode	X3=0	IOC4 as input mode
X2=1	IOC3 as output mode	X2=0	IOC3 as input mode
X1=1	IOC2 as output mode	X1=0	IOC2 as input mode
X0=1	IOC1 as output mode	X0=0	IOC1 as input mode

OPC Rx

Function:  $I/OC \leftarrow [Rx]$ 

Description: The content of Rx is output to I/OC port.

IPC Rx

Function:  $[Rx],AC \leftarrow [I/OC]$ 

Description: The data of I/OC port is loaded to AC and data memory Rx.

SPD X

Function: Defines the input/output mode of each pin for IOD port and enables/disables the

pull-low device.

Description: Sets the I/O mode and turns on/off the pull-low device. The meaning of each bit

of X(X4, X3, X2, X1, X0) is shown below:

Bit pattern	Setting	Bit pattern	Setting
X4=1	Enable the pull-low device on IOD1~IOD4 simultaneously	X4=0	Disable the pull-low device on IOD1~IOD4 simultaneously
X3=1	IOD4 as output mode	X3=0	IOD4 as input mode
X2=1	IOD3 as output mode	X2=0	IOD3 as input mode
X1=1	IOD2 as output mode	X1=0	IOD2 as input mode
X0=1	IOD1 as output mode	X0=0	IOD1 as input mode

OPD Rx

Function:  $I/OD \leftarrow [Rx]$ 

Description: The content of Rx is output to I/OD port.

IPD Rx

Function:  $[Rx], AC \leftarrow [I/OD]$ 

Description: The data of I/OD port are loaded to AC and data memory Rx.



#### SPKX X

Function: Description:

Sets Key matrix scanning output state.

When SEG1~16 are used for LCD driver pins, set X(X7~0) to specify the key matrix scanning output state for each SEGn pin in scanning interval.

 $X_6$  = "0", when HEF5 is set to 1, the HALT released request (HRF5) will be set to 1 after the key depressed on the key matrix and then set SCF7 to 1.

"1", when HEF5 is set to 1, the HALT released request (HRF5) will be set to 1 after each scanning cycle no matter the key is depressed or not and then set SCF7 to 1.

 $X_7X_5X_4 = 000$ , in this setting, each scanning cycle only check one specified column (K1 ~ K16) on key matrix. The specified column is defined by the setting of  $X_3 \sim X_0$ .

 $X_3 \sim X_0 = 0000$ , active K1 column

 $X_3 \sim X_0 = 0001$ , active K2 column

 $X_3 \sim X_0 = 1110$ , active K15 column

 $X_3 \sim X_0 = 1111$ , active K16 column

 $X_7X_5X_4$  = 001, in this setting, all of the matrix columns (K1 ~ K16) will be checked simultaneously in each scanning cycle.  $X_3$  ~  $X_0$  don't care

X7X5X4 = 010, in this setting, the key matrix scanning function will be disable.  $X3 \sim X0$  don't care.

X7X5X4 = 10X, in this setting, each scanning cycle check 8 specified columns on key matrix. The specified column is defined by the setting of X3.

X3 = 0, active  $K1 \sim K8$  columns simultaneously

X3 = 1, active  $K9 \sim K16$  columns simultaneously

 $(X2 \sim X0 \text{ don't care})$ 

X7X5X4 = 110, in this setting, each scanning cycle check four specified columns on key matrix. The specified columns are defined by the setting of X3 and X2.

X3X2 = 00, active K1 ~ K4 columns simultaneously

X3X2 = 01, active K5 ~ K8 columns simultaneously

X3X2 = 10, active K9 ~ K12 columns simultaneously

X3X2 = 11, active K13 ~ K16 columns simultaneously

(X1, X0 don't care)

X7X5X4 = 111, in this setting, each scanning cycle check two specified columns on key matrix. The specified columns are defined by the setting of X3, X2 and X1.

X3X2X1 = 000, active K1 ~ K2 columns simultaneously

X3X2X1 = 001, active K3 ~ K4 columns simultaneously

.....

X3X2X1 = 110, active K13 ~ K14 columns simultaneously

X3X2X1 = 111, active K15 ~ K16 columns simultaneously

(X0 don't care)

#### SPK Rx

Function: Description:

Sets Key matrix scanning output state.

When SEG1~16 are used for LCD driver pins, set the content of AC and Rx to specify the key matrix scanning output state for each SEGn pin in scanning interval.



The bit setting is the same as SPKX instruction and bit pattern of AC and Rx corresponding to SPKX is shown below:

Instruction	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
SPK Rx	AC3	AC2	AC1	AC0	Rx3	Rx2	Rx1	Rx0
SPKX X	X7	X6	X5	X4	X3	X2	X1	X0

SPK @HL

Function: Sets Key matrix scanning output state.

Description: When SEG1~16 are used for LCD driver pins, set the content of table

ROM([@HL]) to specify the key matrix scanning output state for each SEGn pin

in scanning interval.

The bit setting is the same as SPKX instruction and bit pattern of table ROM

corresponding to SPKX is shown below:

Instruction	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
SPK @HL	(T@HL)7	(T@HL)6	(T@HL)5	(T@HL)4	(T@HL)3	(T@HL)2	(T@HL)1	(T@HL)0
SPKX X	X7	X6	X5	X4	X3	X2	X1	X0

ALM X

Function: Sets buzzer output frequency.

Description: The waveform specified by  $X(X8 \sim X0)$  is delivered to the BZ and BZB pins.

The output frequency could be any combination in the following table.

The bit pattern of X (for higher frequency clock source):

X8	X7	X6	clock source (higher frequency)
1	1	1	FREQ*
1	0	0	DC1
0	1	1	PH3 (4 KHz)
0	1	0	PH4 (2 KHz)
0	0	1	PH5 (1 KHz)
0	0	0	DC0

The bit pattern of X (for lower frequency clock source)\*:

Bit	clock source(lower frequency)
X5	PH15 (1 Hz)
X4	PH14 (2 Hz)
X3	PH13 (4 Hz)
X2	PH12 (8 Hz)
X1	PH11 (16 Hz)
X0	PH10 (32 Hz)

# **Notes:**

- 1. FREQ is the output of frequency generator.
- 2. When the buzzer output does not need the envelope waveform,  $X5 \sim X0$  should be set to 0
- 3. The frequency inside the () bases on the PH0 is 32768 Hz.

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**ELC** X Function: The bit control of EL panel driver.

Description: The meaning of each bit specified by  $X(X9 \sim X0)$  is shown below:

# For ELP pin output clock setting:

(X8, X7, X6)	Pumping clock frequency	(X9, X5, X4)	Duty cycle	
000	PH0	100	3/4 duty	
100	BCLK	101	2/3 duty	
101	BCLK/2	X10	1/2 duty	
110	BCLK/4	X11	1/1 duty (original)	
111	BCLK/8	001	1/3 duty	
		000	1/4 duty	

Note: "X" represents don't care.

# For ELC pin output clock setting:

(X3, X2)	Discharge pulse frequency	(X1,X0)	Duty cycle	
00	PH8	00	1/4 duty	
01	PH7	01	1/3 duty	
10	PH6	10	1/2 duty	
11	PH5	11	1/1 duty (original)	

SRF X

Function: The operation control for RFC.

Description: The meaning of each control bit  $(X5 \sim X0)$  is shown below:

X0=1	enables the RC oscillation network of RR	X0=0	disables the RC oscillation network of RR
X1=1	enables the RC oscillation network of RT	X1=0	disables the RC oscillation network of RT
X2=1	enables the RC oscillation network of RH	X2=0	disables the RC oscillation network of RH
X3=1	enables the 16-bit counter	X3=0	disables the 16-bit counter
X4=1	Timer 2 controls the 16-bit counter. X3 must be set to 1 when this bit is set to 1.	X4=0	disables timer 2 to control the 16-bit counter.
X5=1	The 16-bit counter is controlled by the signal on CX pin. X3 must be set to 1 when this bit is set to 1.	X5=0	Disables the CX pin to control the 16-bit counter.

Note: X4 and X5 cannot be set to 1 at the same time.



# 5.2 ACCUMULATOR MANIPULATION INSTRUCTIONS AND MEMORY MANIPULATION INSTRUCTIONS

MRW Ry, Rx

Function:  $AC,[Ry] \leftarrow [Rx]$ 

Description: The content of Rx is loaded to AC and the working register specified by Ry.

MRW @HL, Rx

Function: AC,  $R[@HL] \leftarrow [Rx]$ 

Description: The content of data memory specified by Rx is loaded to AC and data memory

specified by @HL.

MRW#@HL, Rx

Function: AC,  $R[@HL] \leftarrow [Rx]$ ,  $@HL \leftarrow HL + 1$ 

Description: The content of data memory specified by Rx is loaded to AC and data memory

specified by @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

MWR Rx, Ry

Function:  $AC, [Rx] \leftarrow [Ry]$ 

Description: The content of working register specified by Ry is loaded to AC and data

memory specified by Rx.

MWR Rx, @HL

Function: AC,  $[Rx] \leftarrow R[@HL]$ 

Description: The content of data memory specified by @HL is loaded to AC and data

memory specified by Rx.

MWR#Rx, @HL

Function: AC,  $[Rx] \leftarrow R[@HL]$ ,  $@HL \leftarrow HL + 1$ 

Description: The content of data memory specified by @HL is loaded to AC and data

memory specified by Rx.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

SR0 Rx

Function:  $[Rx]n, ACn \leftarrow [Rx](n+1), AC(n+1)$ 

 $[Rx]3, AC3 \leftarrow 0$ 

Description: The Rx content is shifted right and 0 is loaded to the MSB.

The result is loaded to the AC.

Content of Rx	Bit3	Bit2	Bit1	Bit0
Before	Rx3	Rx2	Rx1	Rx0
After	0	Rx3	Rx2	Rx1

SR1 Rx

Function:  $[Rx]n, ACn \leftarrow [Rx](n+1),AC(n+1)$ 

 $[Rx]3, AC3 \leftarrow 1$ 



Description: The Rx content is shifted right and 1 is loaded to the MSB. The result is loaded

to the AC.

Content of Rx	Bit3	Bit2	Bit1	Bit0
Before	Rx3	Rx2	Rx1	Rx0
After	1	Rx3	Rx2	Rx1

SLO Rx

Function:  $[Rx]n, ACn \leftarrow [Rx](n-1), [ACn-1]$ 

 $[Rx]0, AC0 \leftarrow 0$ 

Description: The Rx content is shifted left and 0 is loaded to the LSB. The results are loaded

to the AC.

Content of Rx	Bit3	Bit2	Bit1	Bit0
Before	Rx3	Rx2	Rx1	Rx0
After	Rx2	Rx1	Rx0	0

SL1 Rx

Function:  $[Rx]n, ACn \leftarrow [Rx](n-1),AC(n-1)$ 

 $[Rx]0, AC0 \leftarrow 1$ 

Description: The Rx content is shifted left and 1 is loaded to the LSB. The results are loaded

to the AC.

Content of Rx	Bit3	Bit2	Bit1	Bit0
Before	Rx3	Rx2	Rx1	Rx0
After	Rx2	Rx1	Rx0	1

MRA Rx

Function:  $CF \leftarrow [Rx]3$ 

Description: Bit3 of the content of Rx is loaded to carry flag (CF).

MAF Rx

Function: AC,  $[Rx] \leftarrow CF$ , Zero flag

Description: The content of CF is loaded to AC and Rx. The content of AC and meaning of

bit after execution of this instruction are as follows:

Bit 3.... CF

Bit 2.... Zero (AC=0) flag

Bit 1.... (No Use) Bit 0.... (No Use)

#### **5.3 OPERATION INSTRUCTIONS**

INC\* Rx

Function:  $[Rx],AC \leftarrow [Rx]+1$ 

Description: Add 1 to the content of Rx; the result is loaded to data memory Rx and AC.

\* Carry flag (CF) will be affected.

INC\* @HL

Function:  $[@HL],AC \leftarrow R[@HL]+1$ 

Description: Add 1 to the content of @HL; the result is loaded to data memory @HL and AC.

\* Carry flag (CF) will be affected.



INC\*# @HL

Function:  $[@HL],AC \leftarrow R[@HL]+1, @HL \leftarrow HL+1$ 

Description: Add 1 to the content of @HL; the result is loaded to data memory @HL and AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

\* Carry flag (CF) will be affected.

• @HL indicates an index address of data memory.

DEC\* Rx

Function: [Rx],  $AC \leftarrow [Rx] -1$ 

Description: Substrate 1 from the content of Rx; the result is loaded to data memory Rx and

AC.

• Carry flag (CF) will be affected.

DEC\* @HL

Function:  $R@HL, AC \leftarrow R[@HL] -1$ 

Description: Substrate 1 from the content of @HL; the result is loaded to data memory @HL

and AC.

\* Carry flag (CF) will be affected.

• @HL indicates an index address of data memory.

**DEC\*#@HL** 

Function:  $R@HL, AC \leftarrow R[@HL] -1, @HL \leftarrow HL + 1$ 

Description: Substrate 1 from the content of @HL; the result is loaded to data memory @HL

and AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

\* Carry flag (CF) will be affected.

• @HL indicates an index address of data memory.

ADC Rx

Function:  $AC \leftarrow [Rx] + AC + CF$ 

Description: The contents of Rx, AC and CF are binary-added; the result is loaded to AC.

\* Carry flag (CF) will be affected.

ADC @HL

Function:  $AC \leftarrow [@HL] + AC + CF$ 

Description: The contents of @HL,AC and CF are binary-added; the result is loaded to AC.

\* Carry flag (CF) will be affected.

• @HL indicates an index address of data memory.

ADC# @HL

Function:  $AC \leftarrow [@HL] + AC + CF, @HL \leftarrow HL + 1$ 

Description: The contents of @HL,AC and CF are binary-added; the result is loaded to AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

\* Carry flag (CF) will be affected.



ADC\* Rx

Function: AC,  $[Rx] \leftarrow [Rx] + AC + CF$ 

Description: The contents of Rx, AC and CF are binary-added; the result is loaded to AC and

data memory Rx.

\* Carry flag (CF) will be affected.

ADC\* @HL

Function:  $AC,[@HL] \leftarrow [@HL] + AC + CF$ 

Description: The contents of @HL,AC and CF are binary-added; the result is loaded to AC

and data memory @HL.

\* Carry flag (CF) will be affected.

• @HL indicates an index address of data memory.

**ADC\*#@HL** 

Function: AC,  $[@HL] \leftarrow [@HL] + AC + CF$ ,  $@HL \leftarrow HL + 1$ 

Description: The contents of @HL,AC and CF are binary-added; the result is loaded to AC

and data memory @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

\* Carry flag (CF) will be affected.

• @HL indicates an index address of data memory.

SBC Rx

Function:  $AC \leftarrow [Rx] + (AC)B + CF$ 

Description: The contents of AC and CF are binary-subtracted from content of Rx; the result

is loaded to AC.

• Carry flag (CF) will be affected.

SBC @HL

Function:  $AC \leftarrow [@HL] + (AC)B + CF$ 

Description: The contents of AC and CF are binary-subtracted from content of @HL; the

result is loaded to AC.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

SBC# @HL

Function:  $AC \leftarrow [@HL] + (AC)B + CF, @HL \leftarrow HL + 1$ 

Description: The contents of AC and CF are binary-subtracted from content of @HL; the

result is loaded to AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

SBC\* Rx

Function: AC,  $[Rx] \leftarrow [Rx] + (AC)B + CF$ 

Description: The contents of AC and CF are binary-subtracted from content of Rx; the result

is loaded to AC and data memory Rx.

• Carry flag (CF) will be affected.



SBC\* @HL

Function:  $AC,[@HL] \leftarrow [@HL] + (AC)B + CF$ 

Description: The contents of AC and CF are binary-subtracted from content of @HL; the

result is loaded to AC and data memory @HL.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

SBC\*# @HL

Function:  $AC, [@HL] \leftarrow [@HL] + (AC)B + CF, @HL \leftarrow HL + 1$ 

Description: The contents of AC and CF are binary-subtracted from content of @HL; the

result is loaded to AC and data memory @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

ADD Rx

Function:  $AC \leftarrow [Rx] + AC$ 

Description: The contents of Rx and AC are binary-added; the result is loaded to AC.

• Carry flag (CF) will be affected.

ADD @HL

Function:  $AC \leftarrow [@HL] + AC$ 

Description: The contents of @HL and AC are binary-added; the result is loaded to AC.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

ADD# @HL

Function:  $AC \leftarrow [@HL] + AC, @HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are binary-added; the result is loaded to AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

ADD\* Rx

Function: AC,  $[Rx] \leftarrow [Rx] + AC$ 

Description: The contents of Rx and AC are binary-added; the result is loaded to AC and data

memory Rx.

• Carry flag (CF) will be affected.

ADD\* @HL

Function:  $AC,[@HL] \leftarrow [@HL] + AC$ 

Description: The contents of @HL and AC are binary-added; the result is loaded to AC and

data memory @HL.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.





#### ADD\*#@HL

Function:  $AC,[@HL] \leftarrow [@HL] + AC, @HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are binary-added; the result is loaded to AC and

data memory @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

#### SUB Rx

Function:  $AC \leftarrow [Rx] + (AC)B+1$ 

Description: The content of AC is binary-subtracted from content of Rx; the result is loaded

to AC.

• Carry flag (CF) will be affected.

#### SUB @HL

Function:  $AC \leftarrow [@HL] + (AC)B+1$ 

Description: The content of AC is binary-subtracted from content of @HL; the result is

loaded to AC.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

#### SUB# @HL

Function:  $AC \leftarrow [@HL] + (AC)B + 1, @HL \leftarrow HL + 1$ 

Description: The content of AC is binary-subtracted from content of @HL; the result is

loaded to AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

#### SUB\* Rx

Function:  $AC, [Rx] \leftarrow [Rx] + (AC)B+1$ 

Description: The content of AC is binary-subtracted from content of Rx; the result is loaded

to AC and Rx.

\* Carry flag (CF) will be affected.

#### SUB\* @HL

Function: AC,  $[@HL] \leftarrow [@HL] + (AC)B+1$ 

Description: The content of AC is binary-subtracted from content of @HL; the result is

loaded to AC and data memory @HL.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.



SUB\*# @HL

Function: AC,  $[@HL] \leftarrow [@HL] + (AC)B+1$ ,  $@HL \leftarrow HL + 1$ 

Description: The content of AC is binary-subtracted from content of @HL; the result is

loaded to AC and data memory @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

\* Carry flag (CF) will be affected.

ADN Rx

Function:  $AC \leftarrow [Rx] + AC$ 

Description: The contents of Rx and AC are binary-added; the result is loaded to AC.

\* The result will not affect the carry flag (CF).

ADN @HL

Function:  $AC \leftarrow [@HL] + AC$ 

Description: The contents of @HL and AC are binary-added; the result is loaded to AC.

\* The result will not affect the carry flag (CF).

• @HL indicates an index address of data memory.

AND# @HL

Function:  $AC \leftarrow [@HL] + AC, @HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are binary-added; the result is loaded to AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

\* The result will not affect the carry flag (CF).

• @HL indicates an index address of data memory.

ADN\* Rx

Function: AC,  $[Rx] \leftarrow [Rx] + AC$ 

Description: The contents of Rx and AC are binary-added; the result is loaded to AC and data

memory Rx.

\* The result will not affect the carry flag (CF).

ADN\* @HL

Function: AC,  $[@HL] \leftarrow [@HL] + AC$ 

Description: The contents of @HL and AC are binary-added; the result is loaded to AC and

data memory @HL.

\* The result will not affect the carry flag (CF).

• @HL indicates an index address of data memory.

ADN\*#@HL

Function: AC,  $[@HL] \leftarrow [@HL] + AC$ ,  $@HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are binary-added; the result is loaded to AC and

data memory @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

\* The result will not affect the carry flag (CF).



AND Rx

Function:  $AC \leftarrow [Rx] \& AC$ 

Description: The contents of Rx and AC are binary-ANDed; the result is loaded to AC.

AND @HL

Function:  $AC \leftarrow [@HL] \& AC$ 

Description: The contents of @HL and AC are binary-ANDed; the result is loaded to AC.

• @HL indicates an index address of data memory.

AND# @HL

Function:  $AC \leftarrow [@HL] \& AC, @HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are binary-ANDed; the result is loaded to AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

AND\* Rx

Function: AC,  $[Rx] \leftarrow [Rx] & AC$ 

Description: The contents of Rx and AC are binary-ANDed; the result is loaded to AC and

data memory Rx.

AND\* @HL

Function: AC,  $[@HL] \leftarrow [@HL] \& AC$ 

Description: The contents of @HL and AC are binary-ANDed; the result is loaded to AC and

data memory @HL.

• @HL indicates an index address of data memory.

AND\*#@HL

Function: AC,  $[@HL] \leftarrow [@HL] \& AC$ ,  $@HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are binary-ANDed; the result is loaded to AC and

data memory @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

EOR Rx

Function:  $AC \leftarrow [Rx] \oplus AC$ 

Description: The contents of Rx and AC are exclusive-Ored; the result is loaded to AC.

EOR @HL

Function:  $AC \leftarrow [@HL] \oplus AC$ 

Description: The contents of @HL and AC are exclusive-Ored; the result is loaded to AC.

• @HL indicates an index address of data memory.

EOR# @HL

Function:  $AC \leftarrow [@HL] \oplus AC, @HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are exclusive-ORed; the result is loaded to AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.





EOR\* Rx

Function: AC,  $Rx \leftarrow [Rx] \oplus AC$ 

Description: The contents of Rx and AC are exclusive-Ored; the result is loaded to AC and

data memory Rx.

EOR\* @HL

Function: AC,  $[@HL] \leftarrow [@HL] \oplus AC$ 

Description: The contents of @HL and AC are exclusive-Ored; the result is loaded to AC and

data memory @HL.

• @HL indicates an index address of data memory.

EOR\*#@HL

Function: AC,  $[@HL] \leftarrow [@HL] \oplus AC$ ,  $@HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are exclusive-ORed; the result is loaded to AC

and data memory @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

OR Rx

Function:  $AC \leftarrow [Rx] \mid AC$ 

Description: The contents of Rx and AC are binary-Ored; the result is loaded to AC.

OR @HL

Function:  $AC \leftarrow [@HL] \mid AC$ 

Description: The contents of @HL and AC are binary-Ored; the result is loaded to AC.

• @HL indicates an index address of data memory.

OR# @HL

Function:  $AC \leftarrow [@HL] \mid AC, @HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are binary-ORed; the result is loaded to AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

OR\* Rx

Function: AC,  $Rx \leftarrow [Rx] \mid AC$ 

Description: The contents of Rx and AC are binary-Ored; the result is loaded to AC data

memory Rx.

OR\* @HL

Function:  $AC,[@HL] \leftarrow [@HL] \mid AC$ 

Description: The contents of @HL and AC are binary-ORed; the result is loaded to AC and

data memory @HL.



OR\*# @HL

Function:  $AC, @HL = (@HL) | AC, @HL \leftarrow HL + 1$ 

Description: The contents of @HL and AC are binary-ORed; the result is loaded to AC and

data memory @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

ADCI Ry, D

Function:  $AC \leftarrow [Ry] + D + CF$ 

Description: D represents the immediate data.

The contents of Ry, D and CF are binary-ADDed; the result is loaded to AC.

\* The carry flag (CF) will be affected.

 $D = 0H \sim FH$ 

ADCI\* Ry, D

Function:  $AC,[Ry] \leftarrow [Ry] + D + CF$ 

Description: D represents the immediate data.

The contents of Ry, D and CF are binary-ADDed; the result is loaded to AC and

working register Ry.

\* The carry flag (CF) will be affected.

 $D = 0H \sim FH$ 

SBCI Ry, D

Function:  $AC \leftarrow [Ry] + \#(D) + CF$ 

Description: D represents the immediate data.

The CF and immediate data D are binary-subtracted from working register Ry;

the result is loaded to AC.

\* The carry flag (CF) will be affected.

 $D = 0H \sim FH$ 

SBCI\* Ry, D

Function:  $AC,[Ry] \leftarrow [Ry] + \#(D) + CF$ Description: D represents the immediate data.

The CF and immediate data D are binary-subtracted from working register Ry;

the result is loaded to AC and working register Ry.

\* The carry flag (CF) will be affected.

 $D = 0H \sim FH$ 

ADDI Ry, D

Function:  $AC \leftarrow [Ry] + D$ 

Description: D represents the immediate data.

The contents of Ry and D are binary-ADDed; the result is loaded to AC.

\* The carry flag (CF) will be affected.

 $D = 0H \sim FH$ 



ADDI\* Rv, D

Function:  $AC,[Ry] \leftarrow [Ry]+D$ 

Description: D represents the immediate data.

The contents of Ry and D are binary-ADDed; the result is loaded to AC and

working register Ry.

\* The carry flag (CF) will be affected.

 $D = 0H \sim FH$ 

SUBI Ry, D

Function:  $AC \leftarrow [Ry] + \#(D) + 1$ 

Description: D represents the immediate data.

The immediate data D is binary-subtracted from working register Ry; the result

is loaded to AC.

\* The carry flag (CF) will be affected.

 $D = 0H \sim FH$ 

SUBI\* Rv, D

Function:  $AC_{,}[Ry] \leftarrow [Ry] + \#(Y) + 1$ 

Description: D represents the immediate data.

The immediate data D is binary-subtracted from working register Ry; the result

is loaded to AC and working register Ry.
\* The carry flag (CF) will be affected.

 $D = 0H \sim FH$ 

ADNI Ry, D

Function:  $AC \leftarrow [Ry]+D$ 

Description: D represents the immediate data.

The contents of Ry and D are binary-ADDed; the result is loaded to AC.

\* The result will not affect the carry flag (CF).

 $D = 0H \sim FH$ 

ADNI\* Ry, D

Function: AC,  $[Ry] \leftarrow [Ry] + D$ 

Description: D represents the immediate data.

The contents of Ry and D are binary-ADDed; the result is loaded to AC and

working register Ry.

\* The result will not affect the carry flag (CF).

 $D = 0H \sim FH$ 

ANDI Ry, D

Function:  $AC \leftarrow [Ry] \& D$ 

Description: D represents the immediate data.

The contents of Ry and D are binary-ANDed; the result is loaded to AC.

 $D = 0H \sim FH$ 

ANDI\* Ry, D

Function:  $AC,[Ry] \leftarrow [Ry] \& D$ 

Description: D represents the immediate data.

The contents of Ry and D are binary-ANDed; the result is loaded to AC and

working register Ry.

 $D = 0H \sim FH$ 



EORI Ry, D

Function:  $AC \leftarrow [Ry] EOR D$ 

Description: D represents the immediate data.

The contents of Ry and D are exclusive-ORed; the result is loaded to AC.

 $D = 0H \sim FH$ 

EORI\* Ry, D

Function:  $AC, [Ry] \leftarrow [Ry] \oplus D$ 

Description: D represents the immediate data.

The contents of Ry and D are exclusive-OREd; the result is loaded to AC and

working register Ry.

 $D = 0H \sim FH$ 

ORI Ry, D

Function:  $AC \leftarrow [Ry] \mid D$ 

Description: D represents the immediate data.

The contents of Ry and D are binary-OREd; the result is loaded to AC.

 $D = 0H \sim FH$ 

ORI\* Ry, D

Function:  $AC, [Ry] \leftarrow [Ry] \mid D$ 

Description: D represents the immediate data.

The contents of Ry and D are binary-OREd; the result is loaded to AC and

working register Ry.

 $D = 0H \sim FH$ 

#### 5.4 LOAD/STORE INSTRUCTIONS

STA Rx

Function:  $[Rx] \leftarrow AC$ 

Description: The content of AC is loaded to data memory specified by Rx.

STA @HL

Function:  $[@HL] \leftarrow AC$ 

Description: The content of AC is loaded to data memory specified by @HL.

• @HL indicates an index address of data memory.

STA# @HL

Function:  $[@HL] \leftarrow AC, @HL \leftarrow HL + 1$ 

Description: The content of AC is loaded to data memory specified by @HL.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

LDS Rx, D

Function:  $AC,[Rx] \leftarrow D$ 

Description: Immediate data D is loaded to the AC and data memory specified by Rx.

 $D = 0H \sim FH$ 



LDA Rx

Function:  $AC \leftarrow [Rx]$ 

Description: The content of Rx is loaded to AC.

LDA @HL

Function:  $AC \leftarrow [@HL]$ 

Description: The content specified by @HL is loaded to AC.

• @HL indicates an index address of data memory.

LDA# @HL

Function:  $AC \leftarrow [@HL], @HL \leftarrow HL + 1$ 

Description: The content specified by @HL is loaded to AC.

The content of index register (@HL) will be incremented automatically after

executing this instruction.

• @HL indicates an index address of data memory.

LDH Rx, @HL

Function: [Rx],  $AC \leftarrow TAB[@HL]$  high nibble\*

Description: The higher nibble data of look-up table specified by @HL is loaded to data

memory specified by Rx.

LDH\* Rx, @HL

Function: [Rx],  $AC \leftarrow TAB[@HL]$  high nibble, @HL=@HL+1

Description: The higher nibble data of look-up table specified by @HL is loaded to data

memory specified by Rx and then is increased in @HL.

LDL Rx, @HL

Function: [Rx],  $AC \leftarrow TAB[@HL]$  low nibble

Description: The lower nibble data of look-up table specified by @HL is loaded to the data

memory specified by Rx.

LDL\* Rx, @HL

Function: [Rx],  $AC \leftarrow TAB[@HL]$  low nibble, @HL=@HL+1

Description: The lower nibble data of look-up table specified by @HL is loaded to the data

memory specified by Rx and then is increased in @HL.

MRF1 Rx

Function: [Rx],  $AC \leftarrow RFC[3 \sim 0]$ 

Description: Loads the lowest nibble data of 16-bit counter of RFC to AC and data memory

specified by Rx.

Bit 3 ← RFC[3] Bit 2 ← RFC[2]

Bit 1 **←** RFC[1]

Bit 0 **←** RFC[0]



MRF2 Rx

Function: [Rx],  $AC \leftarrow RFC[7 \sim 4]$ 

Description: Loads the 2<sup>nd</sup> nibble data of 16-bit counter of RFC to AC and data memory

specified by Rx. Bit 3 ← RFC[7] Bit 2 ← RFC[6] Bit 1 ← RFC[5] Bit 0 ← RFC[4]

MRF3 Rx

Function: [Rx],  $AC \leftarrow RFC[11 \sim 8]$ 

Description: Loads the 3<sup>rd</sup> nibble data of 16-bit counter of RFC to AC and data memory

specified by Rx. Bit 3 ← RFC[11] Bit 2 ← RFC[10] Bit 1 ← RFC[9] Bit 0 ← RFC[8]

MRF4 Rx

Function: [Rx],  $AC \leftarrow RFC[15 \sim 12]$ 

Description: Loads the highest nibble data of 16-bit counter of RFC to AC and data memory

specified by Rx. Bit 3 ← RFC[15] Bit 2 ← RFC[14] Bit 1 ← RFC[13] Bit 0 ← RFC[12]

## 5.5 CPU CONTROL INSTRUCTIONS

NOP

Function: no operation Description: no operation

**HALT** 

Function: Enters halt mode

Description: The following 3 conditions cause the halt mode to be released.

1) An interrupt is accepted.

2) The signal change specified by the SCA instruction is applied to port IOC (SCF1) or IOD (SCF3).

3) The halt release condition specified by the SHE instruction is met (HRF1 ~ HRF6).

When an interrupt is accepted to release the halt mode, the halt mode returns by executing the RTS instruction after completion of interrupt service.

**STOP** 

Function: Enters stop mode and stops all oscillators

Description: Before executing this instruction, all signals on IOC port must be set to low.

The following 3 conditions cause the stop mode to be released.



- 1) One of the signals on the input mode pin of IOD or IOC port is in "H" state and holds long enough to cause the CPU to be released from halt mode.
- 2) A signal change in the INT pin.
- 3) The stop release condition specified by the SRE instruction is met.

#### SCA X

Function: The data specified by X causes the halt mode to be released.

Description: The signal change at port IOC, IOD is specified. The bit meaning of X(X4, X3)

is shown below:

Bit pattern	Description
X4=1	Halt mode is released when signal applied to IOC
X3=1	Halt mode is released when signal applied to IOD

X2~0 don't care.

## SIE\* X

Function: Set/Reset interrupt enable flag

Description:

X0=1	The IEF0 is set so that interrupt 0 (Signal change at port IOC or IOD specified by SCA) is accepted.
X1=1	The IEF1 is set so that interrupt 1 (underflow from timer 1) is accepted.
X2=1	The IEF2 is set so that interrupt 2 (the signal change at the INT pin) is accepted.
X3=1	The IEF3 is set so that interrupt 3 (overflow from the predivider) is accepted.
X4=1	The IEF4 is set so that interrupt 4 (underflow from timer 2) is accepted.
X5=1	The IEF5 is set so that interrupt 5 (key scanning) is accepted.
X6=1	The IEF6 is set so that interrupt 6 (overflow from the RFC counter) is accepted.

### SHE X

Function: Set/Reset halt release enable flag

Description:

X1=1	The HEF1 is set so that the halt mode is released by TMR1 underflow.
X2=1	The HEF2 is set so that the halt mode is released by signal change on INT pin.
X3=1	The HEF3 is set so that the halt mode is released by predivider overflow.
X4=1	The HEF4 is set so that the halt mode is released by TMR2 underflow.
X5=1	The HEF5 is set so that the halt mode is released by the signal is "L" applied on KI1~4 during scanning interval.
X6=1	The HEF6 is set so that the halt mode is released by RFC counter overflow.

Note: X0 don't care

## SRE X

Function: Set/Reset stop release enable flag

Description:

X3=1	The SRF3 is set so that the stop mode is released by the signal change on IOD port.
X4=1	The SRF4 is set so that the stop mode is released by the signal change on IOC port.
X5=1	The SRF5 is set so that the stop mode is released by the signal change on INT pin.
X7=1	The SRF7 is set so that the stop mode is released by the signal is "L" applied on KI1~4 in scanning interval.

Note: X2~0 don't care



**FAST** 

Switches the system clock to CFOSC clock. Function:

Description: Starts up the CFOSC (high speed osc.) and then switches the system clock to

high speed clock.

**SLOW** 

Function: Switches the system clock to XTOSC clock (low speed osc).

Description: Switches the system clock to low speed clock, and then stops the CFOSC.

MSB Rx

 $AC,[Rx] \leftarrow SCF3,SCF2,BCF1,BCF$ Function:

Description: The SCF1, SCF2, SCF3 and BCF flag contents are loaded to AC and the data

memory specified by Rx.

The content of AC and meaning of bit after execution of this instruction are as

follows:

Bit 3	Bit 2	Bit 1	Bit 0
Start condition flag 3 (SCF3)	Start condition flag 2 (SCF2)	Start condition flag 1 (SCF1)	Backup flag (BCF)
Halt release caused by the IOD port	Halt release caused by SCF4,5,6,7,8,9	Halt release caused by the IOC port	The backup mode status in TM8725

MSC Rx

Function:  $AC,[Rx] \leftarrow SCF4, SCF5, SCF7, PH15$ 

Description: The SCF4 to SCF7 contents are loaded to AC and the data memory specified by

The content of AC and meaning of bit after execution of this instruction are as follows:

Bit 3	Bit 2	Bit 1	Bit 0
Start condition flag 7 (SCF7)	The content of 15th stage of the predivider	Start condition flag 5 (SCF5)	Start condition flag 4 (SCF4)
Halt release caused by predivider overflow		Halt release caused by TM1 underflow	Halt release caused by INT pin

MCX Rx

 $AC,[Rx] \leftarrow SCF8,SCF6,SCF9$ Function:

The SCF8, SCF6, SCF9 contents are loaded to AC and the data memory Description: specified by Rx.

The content of AC and meaning of bit after execution of this instruction are as follows:

Bit 3	Bit 2	Bit 1	Bit 0
Start condition flag 9 (SCF9)	NA	Start condition flag 6 (SCF6)	Start condition flag 8 (SCF8)
Halt release caused by RFC counter overflow	NA	Halt release caused by TM2 underflow	Halt release caused by the signal change to "L" applied on KI1~4 in scanning interval



MSD Rx

Function:  $Rx, AC \leftarrow WDF, CSF, RFOVF$ 

Description: The watchdog flag, system clock status and overflow flag of RFC counter are

loaded to data memory specified by Rx and AC.

The content of AC and meaning of bit after execution of this instruction are as

follows:

Bit 3	Bit 2	Bit 1	Bit 0
Reserved	The overflow flag of 16-bit counter of RFC (RFOVF)	Watchdog timer enable flag (WDF)	System clock selection flag (CSF)

#### 5.6 INDEX ADDRESS INSTRUCTIONS

MVU Rx

Function:  $[@U] \leftarrow [Rx],AC$ 

Description: Loads content of Rx to index address buffer @U.

U3=[Rx]3, U2=[Rx]2, U1=[Rx]1, U0=[Rx]0,

MVH Rx

Function:  $[@H] \leftarrow [Rx],AC$ 

Description: Loads content of Rx to index address buffer @H.

H3=[Rx]3, H2=[Rx]2, H1=[Rx]1, H0=[Rx]0,

MVL Rx

Function:  $[@L] \leftarrow [Rx]$ 

Description: Loads content of Rx to index address buffer @L.

L3=[Rx]3, L2=[Rx]2, L1=[Rx]1, L0=[Rx]0

CPHL X

Function: If @HL = X, force next instruction as NOP.

Description: Compare the content of index register @HL in lower 8 bits (@H and @L) with

the immediate data X.

Note: In the duration of comparison the index address, all the interrupt enable flags

(IEF) has to be cleared to avoid malfunction.

If the compared result is equal, the next executed instruction that behind CPHL

instruction will be forced as NOP.

If the compared result is not equal, the next executed instruction that behind CPHL

instruction will operate normally.

The comparison bit pattern is shown below:

CPHL X	X7	X6	X5	X4	X3	X2	X1	X0
@HL	IDBF7	IDBF6	IDBF5	IDBF4	IDBF3	IDBF2	IDBF1	IDBF0



### 5.7 DECIMAL ARITHMETIC INSTRUCTIONS

DAA

Function:  $AC \leftarrow BCD[AC]$ 

Description: Converts the content of AC to binary format, and then restores to AC.

When this instruction is executed, the AC must be the result of any added instruction.

\* The carry flag (CF) will be affected.

DAA\* Rx

Function:  $AC, [Rx] \leftarrow BCD[AC]$ 

Description: Converts the content of AC to binary format, and then restores to AC and data

memory specified by Rx.

When this instruction is executed, the AC must be the result of any added instruction.

\* The carry flag (CF) will be affected.

DAA\* @HL

Function:  $AC,[@HL] \leftarrow BCD[AC]$ 

Description: Converts the content of AC to binary format, and then restores to AC and data

memory specified by @HL.

When this instruction is executed, the AC must be the result of any added instruction.

\* The carry flag (CF) will be affected.

DAA\*#@HL

Function:  $AC_{,}[@HL] \leftarrow BCD[AC]_{,} @HL = @HL + 1$ 

Description: Converts the content of AC to binary format, and then restores to AC and data

memory specified by @HL.

The content of index register (@HL) will be incremented automatically after executing

this instruction.

When this instruction is executed, the AC must be the result of any added instruction.

\* The carry flag (CF) will be affected.

AC data before DAA	CF data before DAA	AC data after DAA	CF data after DAA
execution	execution	execution	execution
$0 \le AC \le 9$	CF = 0	no change	no change
$A \le AC \le F$	CF = 0	AC = AC + 6	CF = 1
$0 \le AC \le 3$	CF = 1	AC = AC + 6	no change

DAS

Function:  $AC \leftarrow BCD[AC]$ 

Description: Converts the content of AC to binary format, and then restores to AC.

When this instruction is executed, the AC must be the result of any subtracted instruction.

\* The carry flag (CF) will be affected.

DAS\* Rx

Function:  $AC, [Rx] \leftarrow BCD[AC]$ 

Description: Converts the content of AC to binary format, and then restores to AC and data

memory specified by Rx.

When this instruction is executed, the AC must be the result of any subtracted instruction.

\* The carry flag (CF) will be affected.

DAS\* @HL

Function: AC,  $@HL \leftarrow BCD[AC]$ 



Description: Converts the content of AC to binary format, and then restores to AC and data

memory @HL.

When this instruction is executed, the AC must be the result of any subtracted instruction.

\* The carry flag (CF) will be affected.

DAS\*# @HL

Function: AC,  $@HL \leftarrow BCD[AC]$ , @HL = @HL + 1

Description: Converts the content of AC to binary format, and then restores to AC and data

memory @HL.

The content of index register (@HL) will be incremented automatically after executing

this instruction.

When this instruction is executed, the AC must be the result of any subtracted instruction.

\* The carry flag (CF) will be affected.

AC data before DAS	CF data before DAS	AC data after DAS	CF data after DAS
execution	execution	execution	execution
$0 \le AC \le 9$	CF = 1	No change	no change
$6 \le AC \le F$	CF = 0	AC = AC + A	no change

## **5.8 JUMP INSTRUCTIONS**

JBO X

Function: Program counter jumps to X in current page, if AC0=1.

Description: If bit0 of AC is 1, jump occurs.

If 0, the PC increases by 1.

The range of X is from 000H to 7FFH.

JB1 X

Function: Program counter jumps to X in current page, if AC1=1.

Description: If bit1 of AC is 1, jump occurs.

If 0, the PC increases by 1.

The range of X is from 000H to 7FFH.

JB2 X

Function: Program counter jumps to X in current page, if AC2=1.

Description: If bit2 of AC is 1, jump occurs.

If 0, the PC increases by 1.

The range of X is from 000H to 7FFH.

JB3 X

Function: Program counter jumps to X in current page, if AC3=1.

Description: If bit3 of AC is 1, jump occurs.

If 0, the PC increases by 1.

The range of X is from 000H to 7FFH.

JNZ X

Function: Program counter jumps to X in current page, if AC!=0.

Description: If the content of AC is not 0, jump occurs.

If 0, the PC increases by 1.

The range of X is from 000H to 7FFH.





JNC X

Function: Program counter jumps to X in current page, if CF=0.

Description: If the content of CF is 0, jump occurs.

If 1, the PC increases by 1.

The range of X is from 000H to 7FFH.

JZ X

Function: Program counter jumps to X in current page, if AC=0.

Description: If the content of AC is 0, jump occurs.

If 1, the PC increases by 1.

The range of X is from 000H to 7FFH.

JC X

Function: Program counter jumps to X in current page, if CF=1.

Description: If the content of CF is 1, jump occurs.

If 0, the PC increases by 1.

The range of X is from 000H to 7FFH.

JMP P, X

Function: Program counter jumps to (P\*800h + X).

Description: Unconditional jump.

When P = 0 (page 0), the program jump to address X (000H to 7FFH).

When P = 1 (page 1), the program jump to address 800h + X (800H to BFFH).

CALL P, X

Function: STACK  $\leftarrow$  (PC)+1,

Program counter jumps to (P\*800h + X).

Description: A subroutine is called.

When P = 0 (page 0), the program jump to address X (000H to 7FFH).

When P = 1 (page 1), the program jump to address 800h + X (800H to BFFH).

RTS

Function:  $PC \leftarrow (STACK)$ 

Description: A return from a subroutine occurs.



#### 5.9 MISCELLANEOUS INSTRUCTIONS

SCC X

Function: Setting the clock source for IOD and IOC chattering prevention, PWM output

and frequency generator.

Description: The following table shows the meaning of each bit for this instruction:

Bit pattern	Clock source setting	Bit pattern	Clock source setting
X6=1	The clock source of frequency generator comes from the system clock (BCLK).	X6=0	The clock source of frequency generator comes from the PH0. Refer to section 3-3-4 for \$\phi 0\$.

Bit pattern	Clock source setting	Bit pattern	Clock source setting
(X4,X3) = 01 (X2,X1,X0)=00 1	Chattering prevention clock of IOD port = PH0	(X4,X3) = 10 (X2,X1,X0) =001	Chattering prevention clock of IOC port = PH0
(X4,X3) = 01 (X2,X1,X0) =010	Chattering prevention clock of IOD port = PH8	(X4,X3) = 10 (X2,X1,X0) =010	Chattering prevention clock of IOC port = PH8
(X4,X3) = 01 (X2,X1,X0) =100	Chattering prevention clock of IOD port = PH6	(X4,X3) = 10 (X2,X1,X0) =100	Chattering prevention clock of IOC port = PH6

X5 is reserved

#### FRQ D, Rx

Function: Description:

Frequency generator  $\leftarrow$  D, [Rx], AC

Loads the content of AC and data memory specified by Rx and D (D1, D0) to frequency generator to set the duty cycle and initial value. The following table shows the preset data and the duty cycle setting:

	The bit pattern of preset letter N							
Programming divider	Bit7	Bit6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
FRQ D, Rx	AC3	AC2	AC1	AC0	Rx3	Rx2	Rx1	Rx0

Preset I	Duty Cycle			
D1	D1 D0			
0	0	1/4 duty		
0	1	1/3 duty		
1	0	1/2 duty		
1	1	1/1 duty		

## FRQ D, @HL

Function: Description:

Frequency generator  $\leftarrow$  D, T[@HL]

Loads the content of Table ROM specified by @HL and D (D1, D0) to frequency generator to set the duty cycle and initial value. The following table

shows the preset data and the duty cycle setting:

	The bit pattern of preset letter N							
Programming divider	Bit7	Bit6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
FRQ D,@HL	T7	T6	T5	T4	Т3	T2	T1	T0

Note: T0 ~ T7 represents the data of table ROM.



Preset I	Duty Cyala	
D1	D0	Duty Cycle
0	0	1/4 duty
0	1	1/3 duty
1	0	1/2 duty
1	1	1/1 duty

## FRQX D, X

Function: Description:

Frequency generator  $\leftarrow$  D, X

Loads the data  $X(X7 \sim X0)$  and D (D1, D0) to frequency generator to set the duty cycle and initial value. The following table shows the preset data and the duty cycle setting:

	The bit pattern of preset letter N							
Programming divider	Bit7	Bit6	Bit 5	Bit 4	Bit 3	Bit 2	bit 1	bit 0
FRQX D,X	X7	X6	X5	X4	X3	X2	X1	X0

Note:  $X0 \sim X7$  represents the data specified in operand X.

Preset I	Letter D	D . G .1
D1	D0	Duty Cycle
0	0	1/4 duty
0	1	1/3 duty
1	0	1/2 duty
1	1	1/1 duty

## 1. FRQ D, Rx

The content of Rx and AC as preset data N.

2. FRQ D, @HL

The content of table ROM specified by @HL as preset data N.

3. FRQX D, X

The data of operand in the instruction assigned as preset data N.

#### TMS Rx

Function: Description:

Select timer 1 clock source and preset timer 1.

The content of data memory specified by Rx and AC are loaded to timer 1 to start the timer.

The following table shows the bit pattern for this instruction:

	Select	clock		Prese	etting value of timer 1			
TMS Rx	AC3	AC2	AC1	AC0	Rx3	Rx2	Rx1	Rx0

The clock source selection for timer 1

AC3	AC2	Clock source
0	0	PH9
0	1	PH3
1	0	PH15
1	1	Output of frequency generator (FREQ)



TMS @HL

Select timer 1 clock source and preset timer 1. Function:

The content of table ROM specified by @Hl is loaded to timer 1 to start the Description:

The following table shows the bit pattern for this instruction:

	Select	clock		Presetting value of timer 1				
TMS @HL	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0

The clock source selection for timer 1

Bit7	Bit6	Clock source
0	0	PH9
0	1	PH3
1	0	PH15
1	1	Output of frequency generator (FREQ)

TMSX X

Function: Selects timer 1 clock source and preset timer 1.

The data specified by  $X(X7 \sim X0)$  is loaded to timer 1 to start the timer. Description:

The following table shows the bit pattern for this instruction:

OPCODE	Select clock			Presetting value of timer 1					
TMSX X	X8	X7	X6	X5	X4	X3	X2	X1	X0

The clock source selection for timer 1

X8	X7	X6	clock source
0	0	0	PH9
0	0	1	PH3
0	1	0	PH15
0	1	1	Output of frequency generator (FREQ)
1	0	0	PH5
1	0	1	PH7
1	1	0	PH11
1	1	1	PH13

TM2 Rx

Function: Selects timer 2 clock source and preset timer 2.

The content of data memory specified by Rx and AC is loaded to timer 2 to start Description: the timer.

The following table shows the bit pattern for this instruction:

OPCODE	Select	clock		Presetting value of timer 2						
TM2 Rx	AC3	AC2	AC1	AC0	Rx3	Rx2	Rx1	Rx0		

The clock source selection for timer 2

AC3	AC2	clock source
0	0	PH9
0	1	PH3
1	0	PH15
1	1	Output of frequency generator (FREQ)



TM2 @HL

Function: Selects timer 2 clock source and preset timer 2.

Description: The content of Table ROM specified by @HL is loaded to timer 2 to start the

timer.

The following table shows the bit pattern for this instruction:

OPCODE	Select	clock		Presetting value of timer 2						
TM2 @HL	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0		

The clock source selection for timer 2

Bit7	Bit6	clock source
0	0	PH9
0	1	PH3
1	0	PH15
1	1	Output of frequency generator (FREQ)

TM2X X

Function: Selects timer 2 clock source and preset timer 2.

Description: The data specified by  $X(X8 \sim X0)$  is loaded to timer 2 to start the timer.

The following table shows the bit pattern for this instruction:

OPCODE	S	Select clock			Presetting value of timer 2					
TM2X X	X8	X7	X6	X5	X4	X3	X2	X1	X0	

The clock source selection for timer 2

X8	X7	X6	clock source
0	0	0	РН9
0	0	1	PH3
0	1	0	PH15
0	1	1	Output of frequency generator (FREQ)
1	0	0	PH5
1	0	1	PH7
1	1	0	PH11
1	1	1	PH13

SF X

Function: Sets flag

Description: Description of each flag

X0: "1" The CF flag is set to 1.

X1: "1" The chip enters backup mode and BCF flag is set to 1.

X2: "1" The EL panel driver output pin is active.

X3: "1" For X2=1, when the SF instruction is executed at X3=1, the EL panel driver is active and the halt request signal is output, then the program enters halt mode (similar to HALT instruction).

X4: "1" The watchdog timer is initiated and active and WDF flag is to 1.

X7: "1" Enables the re-load function of timer 1.

X6, 5 is reserved



RF X

Function: Resets flag

Description: Description of each flag

X0: "1" The CF flag is reset to 0.

X1: "1" The chip escaped from backup mode and BCF flag is reset to

0.

X2: "1" The EL-light driver is inactive.

X4: "1" The watchdog timer is disabled and WDF flag is reset to 0.

X7: "1" Disables the re-load function of timer 1.

X6, 5, 3 is reserved

SF2 X

Function: Sets flag

Description: Description of each flag

X3: "1" Enable the strong pull-low device on INT pin.

X2: "1" Turn off the LCD display temporarily.

X1: "1" Sets the DED flag. Refer to 2-12-3 for detail.

X0: "1" Enables the re-load function of timer 2.

RF2 X

Function: Resets flag

Description: Description of each flag

X3: "1" Disable the strong pull-low device on INT pin.

X2: "1" Turn on the LCD display.

X1: "1" Resets the DED flag. Refer to 2-12-3 for detail.

X0: "1" Disables the re-load function of timer 2.

**PLC** 

Function: Pulse control

Description: The pulse corresponding to the data specified by X is generated.

X0: "1" Halt release request flag HRF0 caused by the signal at I/O port C is reset.

X1: "1" Halt release request flag HRF1 caused by underflow from the timer 1 is reset and stops the operating of timer 1 (TM1).

X2: "1" Halt or stop release request flag HRF2 caused by the signal change at the INT pin is reset.

X3: "1" Halt release request flag HRF3 caused by overflow from the predivider is reset.

X4: "1" Halt release request flag HRF4 caused by underflow from the timer 2 is reset and stops the operating of timer 2 (TM2).

X5: "1" Halt release request flag HRF5 caused by the signal change to "L" on KI1~4 in scanning interval is reset.

X6: "1" Halt release request flag HRF6 caused by overflow from the RFC counter is reset.

X8: "1" The last 5 bits of the predivider (15 bits) are reset. When executing this instruction, X3 must be set to "1" simultaneously.



## **ORDERING INFORMATION**

The ordering information:

Ordering number	Package
TM8725-COD	Wafer/Dice with code

UM-TM8725\_E 133 Rev 1.3, 2016/12/29



## **Appendix A TM8725 Instruction Table**

Instruction		Machine Code		Function	Flag/Remark
NOP		0000 0000 0000 0000	No Operation		
LCT	Lz,Ry	0000 001Z ZZZZ YYYY	Lz	$\leftarrow$ (7SEG $\leftarrow$ (Ry))	Ry=70H~7FH
LCB	Lz,Ry	0000 010Z ZZZZ YYYY	Lz	$\leftarrow$ (7SEG $\leftarrow$ (Ry))	Blank Zero
LCP	Lz,Ry	0000 011Z ZZZZ YYYY	Lz	← (Ry) & (AC)	
LCD	Lz,@HL	0000 100Z ZZZZ 0000	Lz	← (R@HL)	
LCT	Lz,@HL	0000 100Z ZZZZ 0001	Lz	$\leftarrow$ (7SEG $\leftarrow$ (R@HL))	
CB	Lz,@HL	0000 100Z ZZZZ 0010	Lz	$\leftarrow$ (7SEG $\leftarrow$ (R@HL))	Blank Zero
.CP	Lz,@HL	0000 100Z ZZZZ 0011	Lz	← (R@HL) & (AC)	
LCDX	D	0000 100D 0000 0100	Multi-Lz D=0 D=1	← (R@HL) : Multi-Lz=00H~0FH : Multi-Lz=10H~1FH	
LCTX	D	0000 100D 0000 0101	Multi-Lz	$\leftarrow$ (7SEG $\leftarrow$ (R@HL))	
CBX	D	0000 100D 0000 0110	Multi-Lz	$\leftarrow$ (7SEG $\leftarrow$ (R@HL))	Blank Zero
LCPX	D	0000 100D 0000 0111	Multi-Lz	← (R@HL) & (AC)	
OPA	Rx	0000 1010 0XXX XXXX	IO(A)	← (Rx)	
OPAS	Rx,D	0000 1011 DXXX XXXX	IOA1,2,3,4	← Rx0,Rx1,D,Pulse	
OPB	Rx	0000 1100 0XXX XXXX	IO(B)	← (Rx)	
OPC	Rx	0000 1101 0XXX XXXX	IO(C)	← (Rx)	
OPD	Rx	0000 1110 0XXX XXXX	IO(C)	← (Rx)	
FRQ	D,Rx	0001 00DD 0XXX XXXX	FREQ D=00 D=01 D=10 D=11	← (Rx) & (AC) : 1/4 Duty : 1/3 Duty : 1/2 Duty : 1/1 Duty	
FRQ	D,@HL	0001 01DD 0000 0000	FREQ	←(T@HL)	
FRQX	D,X	0001 10DD XXXX XXXX	FREQ	← X	
MVL	Rx	0001 1100 0XXX XXXX	(@L)	← (Rx)	
MVH	Rx	0001 1101 0XXX XXXX	(@H)	← (Rx)	
MVU	Rx	0001 1110 0XXX XXXX	(@U)	← (Rx)	
ADC	Rx	0010 0000 0XXX XXXX	AC	$\leftarrow$ (Rx) + (AC) + CF	CF
ADC	@HL	0010 0000 1000 0000	AC	$\leftarrow$ (R@HL) + (AC) + CF	CF
ADC#	@HL	0010 0000 1100 0000	AC @HL	← (R@HL) + (AC) + CF ←@HL+1	CF
ADC*	Rx	0010 0001 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) + (AC) + CF	CF
ADC*	@HL	0010 0001 1000 0000	AC,R@HL	$\leftarrow$ (R@HL) + (AC) + CF	CF
ADC*#	@HL	0010 0001 1100 0000	AC,R@HL @HL	$\leftarrow (R@HL) + (AC) + CF$ $\leftarrow @HL+1$	CF
BC	Rx	0010 0010 0XXX XXXX	AC	$\leftarrow$ (Rx) + (AC)B + CF	CF
BC	@HL	0010 0010 1000 0000	AC	$\leftarrow$ (R@HL) + (AC)B + CF	CF
SBC#	@HL	0010 0010 1100 0000	AC @HL	← (R@HL) + (AC)B + CF ←@HL+1	CF
BC*	Rx	0010 0011 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) + (AC)B + CF	CF
SBC*	@HL	0010 0011 1000 0000	AC,R@HL	$\leftarrow$ (R@HL) + (AC)B + CF	CF
SBC*#	@HL	0010 0011 1100 0000	AC,R@HL @HL	← (R@HL) + (AC)B + CF ←@HL+1	CF
ADD	Rx	0010 0100 0XXX XXXX	AC	$\leftarrow$ (Rx) + (AC)	CF
ADD	@HL	0010 0100 1000 0000	AC	← (R@HL) + (AC)	CF
ADD#	@HL	0010 0100 1100 0000	AC @HL	← (R@HL) + (AC) ←@HL+1	CF



Instruction		Machine Code	Function		Flag/Remark
ADD*	Rx	0010 0101 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) + (AC)	CF
ADD*	@HL	0010 0101 1000 0000	AC,R@HL	← (R@HL) + (AC)	CF
ADD*#	@HL	0010 0101 1100 0000	AC,R@HL @HL	← (R@HL) + (AC) ←@HL+1	CF
SUB	Rx	0010 0110 0XXX XXXX	AC	$\leftarrow$ (Rx) + (AC)B + 1	CF
SUB	@HL	0010 0110 1000 0000	AC	$\leftarrow$ (R@HL) + (AC)B + 1	CF
SUB#	@HL	0010 0110 1100 0000	AC @HL	← (R@HL) + (AC)B + 1 ←@HL+1	CF
SUB*	Rx	0010 0111 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) + (AC)B + 1	CF
SUB*	@HL	0010 0111 1000 0000	AC,R@HL	$\leftarrow$ (R@HL) + (AC)B + 1	CF
SUB*#	@HL	0010 0111 1100 0000	AC,R@HL @HL	← (R@HL) + (AC)B + 1 ←@HL+1	CF
ADN	Rx	0010 1000 0XXX XXXX	AC	$\leftarrow$ (Rx) + (AC)	
ADN	@HL	0010 1000 1000 0000	AC	← (R@HL) + (AC)	
ADN#	@HL	0010 1000 1100 0000	AC @HL	← (R@HL) + (AC) ←@HL+1	
ADN*	Rx	0010 1001 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) + (AC)	
ADN*	@HL	0010 1001 1000 0000	AC,R@HL	← (R@HL) + (AC)	
ADN*#	@HL	0010 1001 1100 0000	AC,R@HL @HL	← (R@HL) + (AC) ←@HL+1	
AND	Rx	0010 1010 0XXX XXXX	AC	$\leftarrow$ (Rx) AND (AC)	
AND	@HL	0010 1010 1000 0000	AC	← (R@HL) AND (AC)	
AND#	@HL	0010 1010 1100 0000	AC @HL	← (R@HL) AND (AC) ←@HL+1	
AND*	Rx	0010 1011 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) AND (AC)	
AND*	@HL	0010 1011 1000 0000	AC,R@HL	← (R@HL) AND (AC)	
AND*#	@HL	0010 1011 1100 0000	AC,R@HL @HL	← (R@HL) AND (AC) ←@HL+1	
EOR	Rx	0010 1100 0XXX XXXX	AC	$\leftarrow$ (Rx) EOR (AC)	
EOR	@@HL	0010 1100 1000 0000	AC	← (R@HL) EOR (AC)	
EOR#	@HL	0010 1100 1100 0000	AC @HL	← (R@HL) EOR (AC) ←@HL+1	
EOR*	Rx	0010 1101 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) EOR (AC)	
EOR*	@HL	0010 1101 1000 0000	AC,R@HL	← (R@HL) EOR (AC)	
EOR*#	@HL	0010 1101 1100 0000	AC,R@HL @HL	← (R@HL) EOR (AC) ←@HL+1	
OR	Rx	0010 1110 0XXX XXXX	AC	$\leftarrow$ (Rx) OR (AC)	
OR	@HL	0010 1110 1000 0000	AC	$\leftarrow$ (R@HL) OR (AC)	
OR#	@HL	0010 1110 1100 0000	AC @HL	← (R@HL) OR (AC) ←@HL+1	
OR*	Rx	0010 1111 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) OR (AC)	
OR*	@HL	0010 1111 1000 0000	AC,R@HL	← (R@HL) OR (AC)	
OR*#	@HL	0010 1111 1100 0000	AC,R@HL @HL	← (R@HL) OR (AC) ←@HL+1	
ADCI	Ry,D	0011 0000 DDDD YYYY	AC	$\leftarrow$ (Ry) + D + CF	CF
ADCI*	Ry,D	0011 0001 DDDD YYYY	AC,Ry	$\leftarrow$ (Ry) + D + CF	CF
SBCI	Ry,D	0011 0010 DDDD YYYY	AC	$\leftarrow$ (Ry) + (D)B + CF	CF
SBCI*	Ry,D	0011 0011 DDDD YYYY	AC,Ry	$\leftarrow$ (Ry) + (D)B + CF	CF
ADDI	Ry,D	0011 0100 DDDD YYYY	AC	$\leftarrow$ (Ry) + D	CF
ADDI*	Ry,D	0011 0101 DDDD YYYY	AC,Ry	← (Ry) + D	CF
SUBI	Ry,D	0011 0110 DDDD YYYY	AC	$\leftarrow$ (Ry) + (D)B + 1	CF
SUBI*	Ry,D	0011 0111 DDDD YYYY	AC,Ry	$\leftarrow$ (Ry) + (D)B + 1	CF



Ins	truction	Machine Code		Function	Flag/Remark
ADNI	Ry,D	0011 1000 DDDD YYYY	AC	← (Ry) + D	
ADNI*	Ry,D	0011 1001 DDDD YYYY	AC,Ry	← (Ry) + D	
ANDI	Ry,D	0011 1010 DDDD YYYY	AC	← (Ry) AND D	
ANDI*	Ry,D	0011 1011 DDDD YYYY	AC,Ry	← (Ry) AND D	
EORI	Ry,D	0011 1100 DDDD YYYY	AC	← (Ry) EOR D	
EORI*	Ry,D	0011 1101 DDDD YYYY	AC,Ry	← (Ry) EOR D	
ORI	Ry,D	0011 1110 DDDD YYYY	AC	← (Ry) OR D	
ORI*	Ry,D	0011 1111 DDDD YYYY	AC,Ry	← (Ry) OR D	
NC*	Rx	0100 0000 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) + 1	CF
NC*	@HL	0100 0000 1000 0000	AC,R@HL	← (R@HL) + 1	CF
INC*#	@HL	0100 0000 1100 0000	AC,R@HL @HL	← (R@HL) + 1 ←@HL+1	CF
DEC*	Rx	0100 0001 0XXX XXXX	AC,Rx	$\leftarrow$ (Rx) – 1	CF
DEC*	@HL	0100 0001 1000 0000	AC,R@HL	← (R@HL) - 1	CF
DEC*#	@HL	0100 0001 1100 0000	AC,R@HL @HL	← (R@HL) - 1 ←@HL+1	CF
IPA	Rx	0100 0010 0XXX XXXX	AC,Rx	← IO(A)	
IPB	Rx	0100 0100 0XXX XXXX	AC,Rx	← IO(B)	
РС	Rx	0100 0111 0XXX XXXX	AC,Rx	← IO(C)	
IPD	Rx	0100 1000 0XXX XXXX	AC,Rx	← IO(D)	
MAF	Rx	0100 1010 0XXX XXXX	AC,Rx	← (STS1)	B3 : CF B2 : ZERO B1 : (No use) B0 : (No use) B3 : SCF3(DPT)
MSB	Rx	0100 1011 0XXX XXXX	AC,Rx	← (STS2)	B2 : SCF2(HRx) B1 : SCF1(CPT) B0 : BCF
MSC	Rx	0100 1100 0XXX XXXX	AC,Rx	← (STS3)	B3 : SCF7(PDV) B2 : PH15 B1 : SCF5(TM1) B0 : SCF4(INT)
MCX	Rx	0100 1101 0XXX XXXX	AC,Rx	← (STS3X)	B3 : SCF9(RFC) B2 : (No use) B1 : SCF6(TM2) B0 : SCF8(SKI)
MSD	Rx	0100 1110 0XXX XXXX	AC,Rx	← (STS4)	B3 : (No use) B2 : RFOVF B1 : WDF B0 : CSF
SR0	Rx	0101 0000 0XXX XXXX	ACn, Rxn AC3, Rx3	$\leftarrow Rx(n+1) \\ \leftarrow 0$	
SR1	Rx	0101 0001 0XXX XXXX	ACn, Rxn AC3, Rx3	$\leftarrow Rx(n+1)$ $\leftarrow 1$	
SL0	Rx	0101 0010 0XXX XXXX	ACn, Rxn AC0, Rx0	$\leftarrow Rx(n-1)$ $\leftarrow 0$	
SL1	Rx	0101 0011 0XXX XXXX	ACn, Rxn AC0, Rx0	$\leftarrow Rx(n-1)$ $\leftarrow 1$	
DAA	D.	0101 0100 0000 0000	AC	← BCD(AC)	
DAA*	Rx	0101 0101 0XXX XXXX	AC,Rx	← BCD(AC)	
DAA* DAA*#	@HL	0101 0101 1000 0000	AC,R@HL AC,R@HL	← BCD(AC) ← BCD(AC)	
	102111		@HL	←@HL+1	
DAS		0101 0110 0000 0000	AC	← BCD(AC)	



Instruction		Machine Code	Function		Flag/Remark
DAS*	Rx	0101 0111 0XXX XXXX	AC,Rx	← BCD(AC)	
DAS*	@HL	0101 0111 1000 0000	AC,R@HL	← BCD(AC)	
DAS*#	@HL	0101 0111 1100 0000	AC,R@HL @HL	← BCD(AC) ←@HL+1	
LDS	Rx,D	0101 1DDD DXXX XXXX	AC,Rx	← D	
LDH	Rx,@HL	0110 0000 0XXX XXXX	AC,Rx	← H(T@HL)	
LDH*	Rx,@HL	0110 0001 0XXX XXXX	AC,Rx @HL	← H(T@HL) ← @HL + 1	
DL	Rx,@HL	0110 0010 0XXX XXXX	AC,Rx	← L(T@HL)	
LDL*	Rx,@HL	0110 0011 0XXX XXXX	AC,Rx @HL	← L(T@HL) ← @HL + 1	
MRF1	Rx	0110 0100 0XXX XXXX	AC,Rx	← RFC3-0	
MRF2	Rx	0110 0101 0XXX XXXX	AC,Rx	← RFC7-4	
MRF3	Rx	0110 0110 0XXX XXXX	AC,Rx	← RFC11-8	
MRF4	Rx	0110 0111 0XXX XXXX	AC,Rx	← RFC15-12	
STA	Rx	0110 1000 0XXX XXXX	Rx	← (AC)	
STA	@HL	0110 1000 1000 0000	R@HL	← (AC)	
STA#	@HL	0110 1000 1100 0000	R@HL	← (AC)	
			@HL	←@HL+1	
LDA	Rx	0110 1100 0XXX XXXX	AC	← (Rx)	
LDA	@HL	0110 1100 1000 0000	AC	← (R@HL)	
.DA#	@HL	0110 1100 1100 0000	AC @HL	← (R@HL) ←@HL+1	
ИRA	Rx	0110 1101 0XXX XXXX	CF	← Rx3	
MRW	@HL,Rx	0110 1110 0XXX XXXX	AC,R@HL	$\leftarrow$ (Rx)	
MRW#	@HL,Rx	0110 1110 1XXX XXXX	AC,R@HL @HL	← (Rx) ←@HL+1	
MWR	Rx,@HL	0110 1111 0XXX XXXX	AC,Rx	← (R@HL)	
MWR#	Rx,@HL	0110 1111 1XXX XXXX	AC,Rx @HL	← (R@HL) ←@HL+1	
MRW	Ry,Rx	0111 0YYY YXXX XXXX	AC,Ry	$\leftarrow$ (Rx)	
MWR	Rx,Ry	0111 1YYY YXXX XXXX	AC,Rx	← (Ry)	
В0	X	1000 0XXX XXXX XXXX	PC	← X	if AC0 = 1
В1	X	1000 1XXX XXXX XXXX	PC	← X	if AC1 = 1
В2	X	1001 0XXX XXXX XXXX		← X	if AC2 = 1
В3	X	1001 1XXX XXXX XXXX		← X	if AC3 = 1
NZ	X	1010 0XXX XXXX XXXX		← X	if $(AC) \neq 0$
NC	X	1010 1XXX XXXX XXXX		← X	if $CF = 0$
Z	X	1011 0XXX XXXX XXXX		← X	if(AC) = 0
C	X	1011 1XXX XXXX XXXX		← X	if CF = 1
CALL	P,X	1100 PXXX XXXX XXXX	STACK PC P=0 P=1	← PC + 1 ← X : PC => 000h~7FFh : PC => 800h~BFFh	
MP	P,X	1101 PXXX XXXX XXXX	PC P=0	← X : PC => 000h~7FFh	



Ins	truction	Machine Code		Function	Flag/Remark
			P=1	: PC => 800h~BFFh	
			AC3,2 = 11	: Ctm = FREQ	
			AC3,2 = 10	: Ctm = PH15	
MS	Rx	1110 0000 0XXX XXXX	AC3,2 = 01	: Ctm = PH3	
			AC3,2 = 00	: Ctm = PH9	
			AC1,0,Rx3~0	: Set Timer1 Value	
			TR7,6 = 11	: Ctm = FREQ	
			TR7,6 = 10	: Ctm = PH15	
MS	@HL	1110 0001 0000 0000	TR7.6 = 01	: Ctm = PH3	
			TR7,6 = 00	: Ctm = PH9	
			TR5~0	: Set Timer1 Value	
			X8,7,6=111	: Ctm = PH13	
			X8,7,6=110	: Ctm = PH11	
			X8,7,6=101	: Ctm = PH7	
			X8,7,6=100	: Ctm = PH5	
MSX	X	1110 001X XXXX XXXX	X8,7,6=011	: Ctm = FREQ	
			X8,7,6=010	: Ctm = PH15	
			X8,7,6=001	: Ctm = PH3	
			X8,7,6=000	: Ctm = PH9	
			X5~0	: Set Timer1 Value	
TM2	Rx	1110 0100 0XXX XXXX	Timer2	← (Rx) & (AC)	
TM2	@HL		+	1 1 1 1	
IVIZ	@HL	1110 0101 0000 0000	Timer2	← (T@HL)	
			X8,7,6=111	: Ctm = PH13	
			X8,7,6=110	: Ctm = PH11	
			X8,7,6=101	: Ctm = PH7	
		1110 011X XXXX XXXX	X8,7,6=100	: Ctm = PH5	
M2X	X		X8,7,6=011	: Ctm = FREQ	
			X8,7,6=010	: Ctm = PH15	
			X8,7,6=001	: Ctm = PH3	
			X8,7,6=000	: Ctm = PH9	
			X5~0	: Set Timer2 Value	220
			X6	: Enable HEF6	RFC
			X5	: Enable HEF5	KEY_S
SHE	X	1110 1000 0XXX XXX0	X4	: Enable HEF4	TMR2
			X3	: Enable HEF3	PDV
			X2	: Enable HEF2	INT
			X1	: Enable HEF1	TMR1
			X6	: Enable IEF6	RFC
			X5	: Enable IEF5	KEY_S
			X4	: Enable IEF4	TMR2
IE*	X	1110 1001 0XXX XXXX	X3	: Enable IEF3	PDV
			X2	: Enable IEF2	INT
			X1	: Enable IEF1	TMR1
	-		X0	: Enable IEF0	C,DPT
LC	X	1110 101X 0XXX XXXX	X8	: Reset PH15~11	
			X6-0	: Reset HRF6-0	
			X5	: Enable Cx Control	
			X4	: Enable TM2 Control	
SRF	X	1110 1100 00XX XXXX	X3	: Enable Counter	ENX
		1110 1100 001111111111	X2	: Enable RH Output	EHM
			X1	: Enable RT Output	ETP
	1		X0	: Enable RR Output	ERR
			X7	: Enable SRF7	SRF7(KEY_S)
RE	X	1110 1101 X0XX X000	X5	: Enable SRF5	SRF5 (INT)
·XL		1110 1101 A0AA A000	X4	: Enable SRF4	SRF4 (C Port)
			X3	: Enable SRF3	SRF3 (D port)
FAST		1110 1110 0000 0000	SCLK	: High Speed Clock	
SLOW		1110 1110 1000 0000	SCLK	: Low Speed Clock	
	37			_	CVE O IDDEE :
PHL	X	1110 1111 XXXX XXXX	(PC+1)	← force "NOP"	if X7~0=IDBF7~0



Instruction		Machine Code	Function		Flag/Remark
SPK	Rx	1111 0000 0XXX XXXX	KO1~16	$\leftarrow$ (Rx) & (AC)	
SPK	@HL	1111 0001 0000 0000	KO1~16	← T @HL	
SPKX	X	1111 0010 XXXX XXXX	X6=1 X6=0 X7,5,4=000 X7,5,4=001 X7,5,4=010 X7,5,4=10X X7,5,4=110	: KEY_S release by scanning cycle : KEY_S release by normal key scanning : Set one of KO1~16 =1 by X3~0 : Set all = 1 : Set all Hi-z : Set eight of KO1~16 =1 by X3 X3=0 => KO1~8 X3=1 => KO9~16 : Set four of KO1~16 =1 by X3,2 X3,2=00 => KO1~4 X3,2=01 => KO5~8 X3,2=10 => KO9~12 X3,2=11 => KO9~16 : Set two of KO1~16 =1 by X3,2 X3,2=01 => KO5~8 X3,2=10 => KO5~8 X3,2=10 => KO9~12 X3,2=11 => KO13~16 : Set two of KO1~16 =1 by X3,2,1 X3~1=000=>KO1,2 X3~1=010=>KO5,6 X3~1=011=>KO5,6 X3~1=010=>KO5,6 X3~1=010=>KO9,10 X3~1=101=>KO11,12 X3~1=100=>KO13,14	
RTS		1111 0100 0000 0000	PC	X3~1=111=>KO15,16 ← STACK	CALL Return
SCC	X	1111 0100 0000 0000 1111 0100 1X0X XXXX	X6 = 1 X6 = 0 X4=1 X3=1 X2,1,0=001 X2,1,0=010 X2,1,0=100	: Cfq = BCLK : Cfq = PH0 Set P(C) Cch Set P(D) Cch : Cch = PH10 : Cch = PH8 : Cch = PH6	
SCA	X	1111 0101 000X X000	X4 X3	: Enable SEF4 : Enable SEF3	C1-4 D1-4
SPA	X	1111 0101 100X XXXX	X4 X3~0	: Set A4-1 Pull-Low : Set A4-1 I/O	
SPB	X	1111 0101 101X XXXX	X4 X3~0	: Set B4-1 Pull-Low : Set B4-1 I/O	
SPC	X	1111 0101 110X XXXX	X4 X3-0	: Set C4-1 Pull-Low / Low-Level-Hold : Set C4-1 I/O	
SPD	X	1111 0101 111X XXXX	X4 X3-0	: Set D4-1 Pull-Low : Set D4-1 I/O	
SF	X	1111 0110 X00X XXXX	X7 X4 X3 X2 X1 X00	: Reload 1 Set : WDT Enable : HALT after EL : EL LIGHT On : BCF Set : CF Set	RL1 WDF BCF CF
RF	X	1111 0111 X00X 0XXX	X7 X4 X2	:Reload 1 Reset : WDT Reset : EL LIGHT Off	RL1 WDF



Instruction		Machine Code	Function		Flag/Remark
			X1	: BCF Reset	BCF
			X0	: CF Reset	CF
			X8=1	BCLKX	
			X8=0	PH0	ELD CLIV
			X7,6=11	BCLK/8	ELP - CLK
			X7,6=10	BCLK/4	DCI IVV
			X7,6=01	BCLK/2	BCLKX
			X7,6=00	BCLK	
			X9,5,4=101	2/3	
			X9,5,4=100	3/4	ELD DIAM
			X9,5,4=x11	1/1	ELP - DUTY
EL C	37	1111 1033 3333 3333	X9,5,4=x10	1/2	
ELC	X	1111 10XX XXXX XXXX	X9,5,4=001	1/3	
			X9,5,4=000	1/4	
			X3,2=11	PH5	
			X3,2=10	PH6	ELC CLY
			X3,2=01	PH7	ELC - CLK
			X3,2=00	PH8	
			X1,0=11	1/1	
			X1,0=10	1/2	ELC DIMI
			X1,0=01	1/3	ELC - DUTY
			X1,0=00	1/4	
			X8,7,6=111	: FREQ	
			X8,7,6=100	: DC1	
			X8,7,6=011	: PH3	
ALM	X	1111 110X XXXX XXXX	X8,7,6=010	: PH4	
			X8,7,6=001	: PH5	
			X8,7,6=000	: DC0	
			X5~0	← PH15~10	
			X3	: Enable INT powerful Pull-	INTPL
		1111 1110 0000 XXXX		low	
SF2	X		X2	: Close all Segments	RSOFF
			X1	: Dis-ENX Set	DED
			X0	: Reload 2 Set	RL2
RF2			X3	: Disable INT powerful Pull-	INTPL
				low	
	X	1111 1110 1000 XXXX	X2	: Release Segments	RSOFF
			X1	: Dis-ENX Reset	DED
			X0	: Reload 2 Reset	RL2
HALT		1111 1111 0000 0000	Halt Operation		
STOP		1111 1111 1000 0000	Stop Operation	1	



# Appendix B Symbol Description

Symbol	Description	Symbol	Description
()	Content of Register	D	Immediate Data
AC	Accumulator	(D)B	Complement of Immediate Data
ACn	Content of Accumulator (bit n)	PC	Program Counter
(AC)B	Complement of content of Accumulator	CF	Carry Flag
X	Address of program or control data	ZERO	Zero Flag
Rx	Address X of data RAM	WDF	Watch-Dog Timer Enable Flag
Rxn	Bit n content of Rx	7SEG	7 segment decoder for LCD
Ry	Address Y of working register	BCLK	System clock for instruction
R@HL	Address of data RAM specified by @HL	IEFn	Interrupt Enable Flag
BCF	Back-up Flag	HRFn	HALT Release Flag
@HL	Generic Index address register	HEFn	HALT Release Enable Flag
(@HL)	Content of generic Index address register	Lz	Address of LCD PLA Latch
(@L)	Content of lowest nibble Index register	SRFn	STOP Release Enable Flag
(@H)	Content of middle nibble Index register	SCFn	Start Condition Flag
(@U)	Content of highest nibble Index register	Cch	Clock Source of Chattering prevention ckt.
T@HL	Address of Table ROM	Cfq	Clock Source of Frequency Generator
H(T@HL)	High Nibble content of Table ROM	SEFn	Switch Enable Flag
L(T@HL)	Low Nibble content of Table ROM	FREQ	Frequency Generator setting Value
TMR	Timer Overflow Release Flag	CSF	Clock Source Flag
Ctm	Clock Source of Timer	P	Program Page
PDV	Pre-Divider	RFOVF	RFC Overflow Flag
STACK	Content of stack	RFC	Resistor to Frequency counter
TM1	Timer 1	RFCn	Bit data of Resistor to Frequency counter
TM2	Timer 2	TRn	Bit content of Table ROM specified by @HL